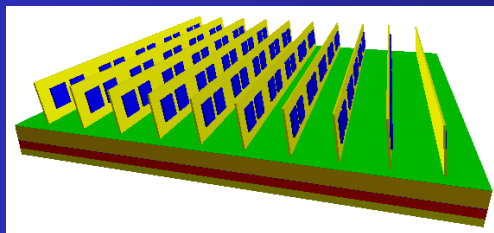


Summary of TRD pad plane, front-end boards and readout chain

David Emschermann
GSI Darmstadt

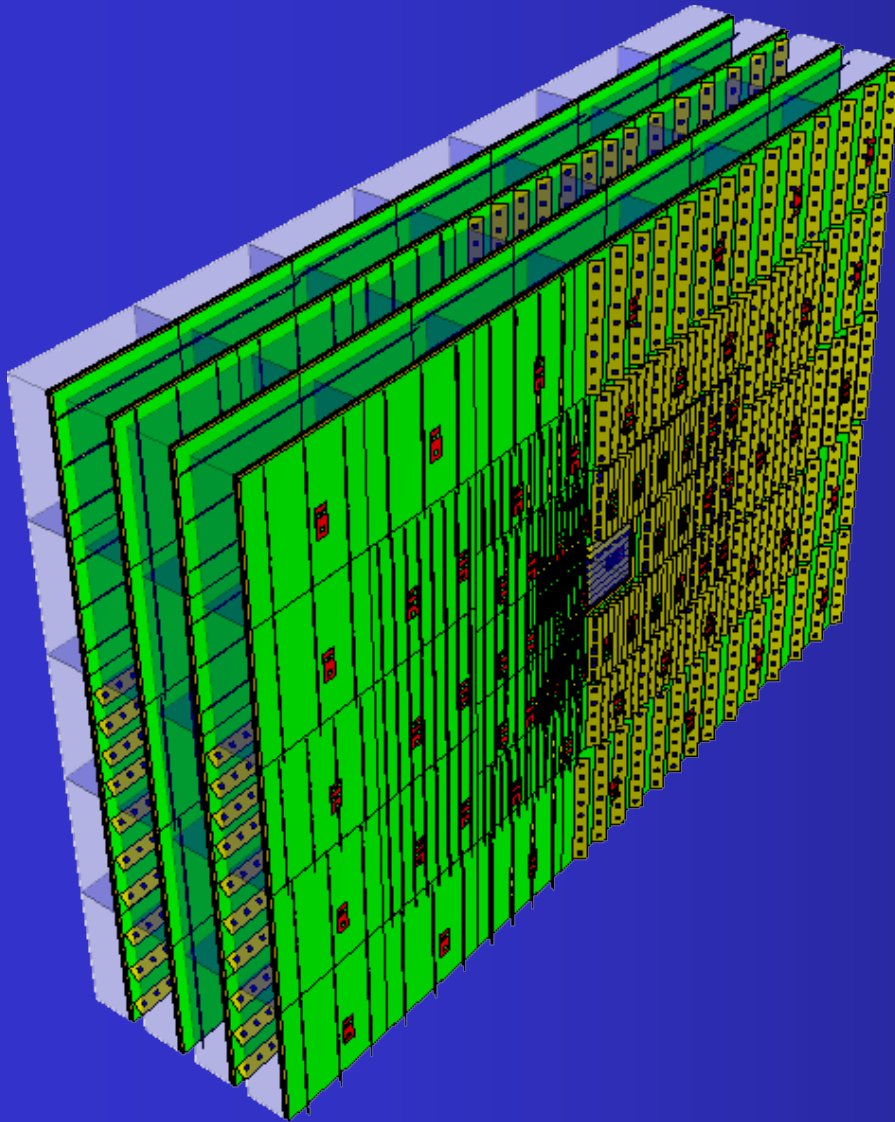
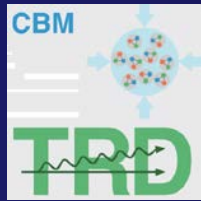


Outline



- TRD requirements
- MWPC geometry
- pad plane constraints
- 6 module types
- FEB types
- optimisation beyond TDR
- readout chain

TRD geometry v16b



The TRD geometry v16b
described in the TDR:

SIS 100

1	station
4	layers
200	modules
280	ROBs
1384	GBTx
1112	FEBs
8992	32ch ASICs
287744	channels

TRD requirements



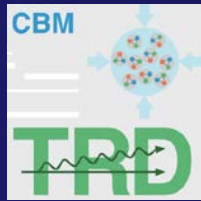
- pion suppression factor $10-20 > 6 \text{ GeV}/c$ (@ 90% e-efficiency)
- position resolution of $200 - 300 \text{ } \mu\text{m}$
- rate capability up to $100 \text{ kHz}/\text{cm}^2$
- capability to deal with high multiplicity

TRD layout

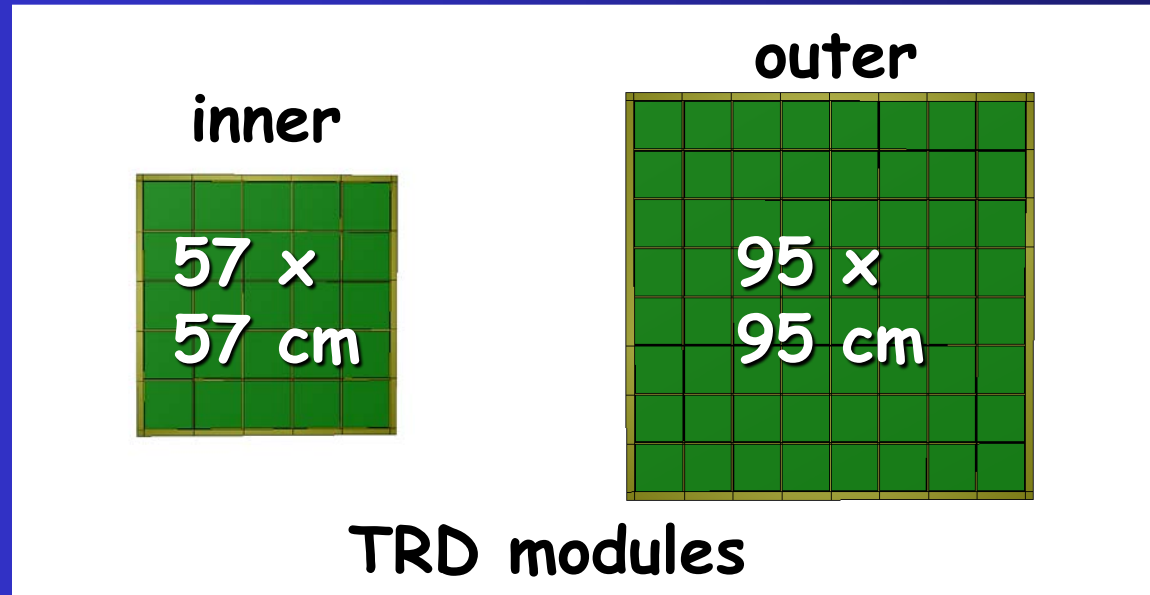


- rectangular pads
- MWPC modules of squared shape
- modules rotated between neighboring layers
- all services connected through the backside
- 2 module sizes, 6 module types
- 4 layers

2 TRD module sizes



2 different TRD module sizes



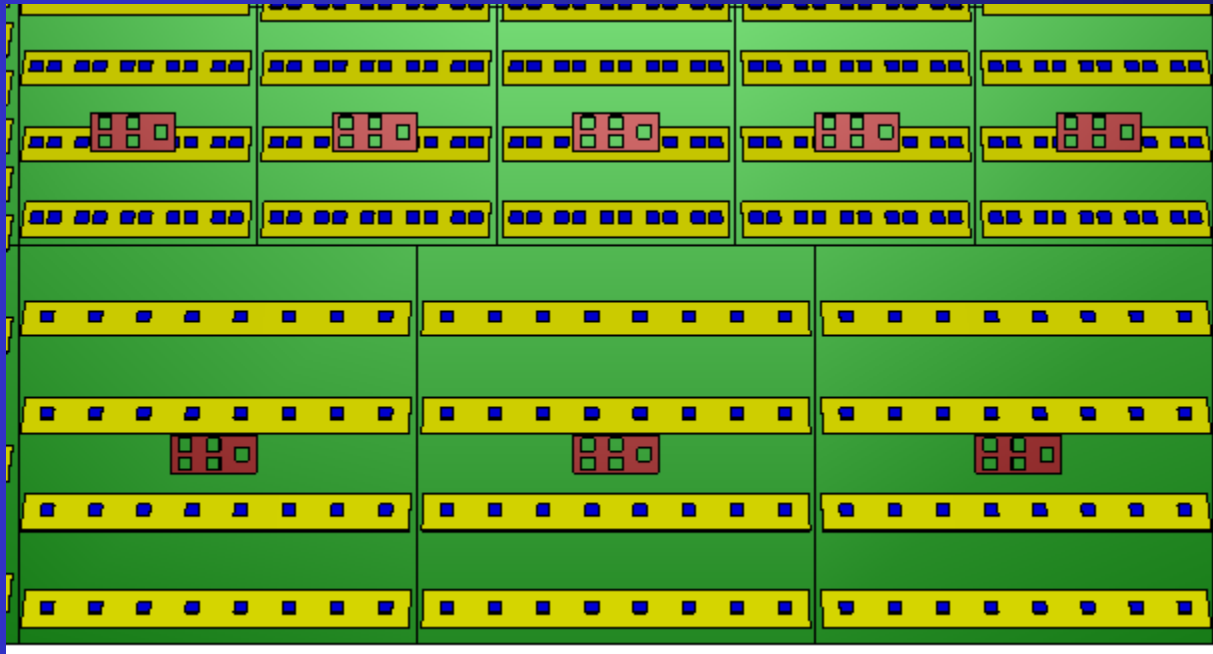
The small module is built from a single pad plane PCB.
The maximum width the PCB manufacturer can handle is: 590 mm.

We build pad planes of 580 mm x 580 mm size.

The resulting small module size is 570 mm x 570 mm.

The large module can be built from 2 PCB pieces.

Module size ratio

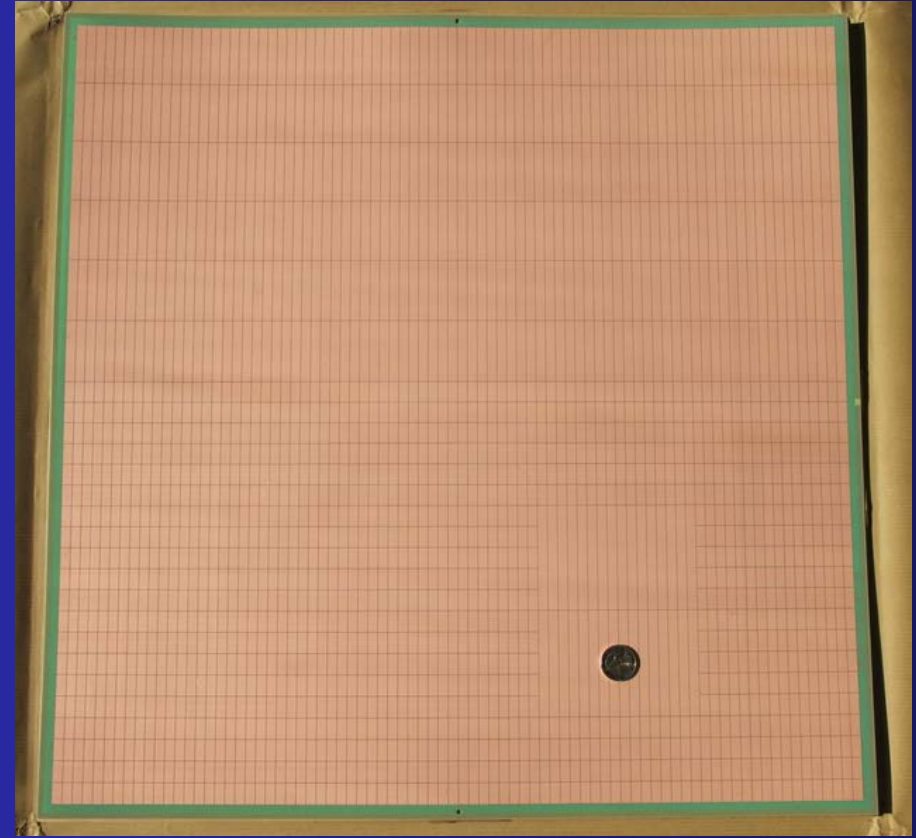
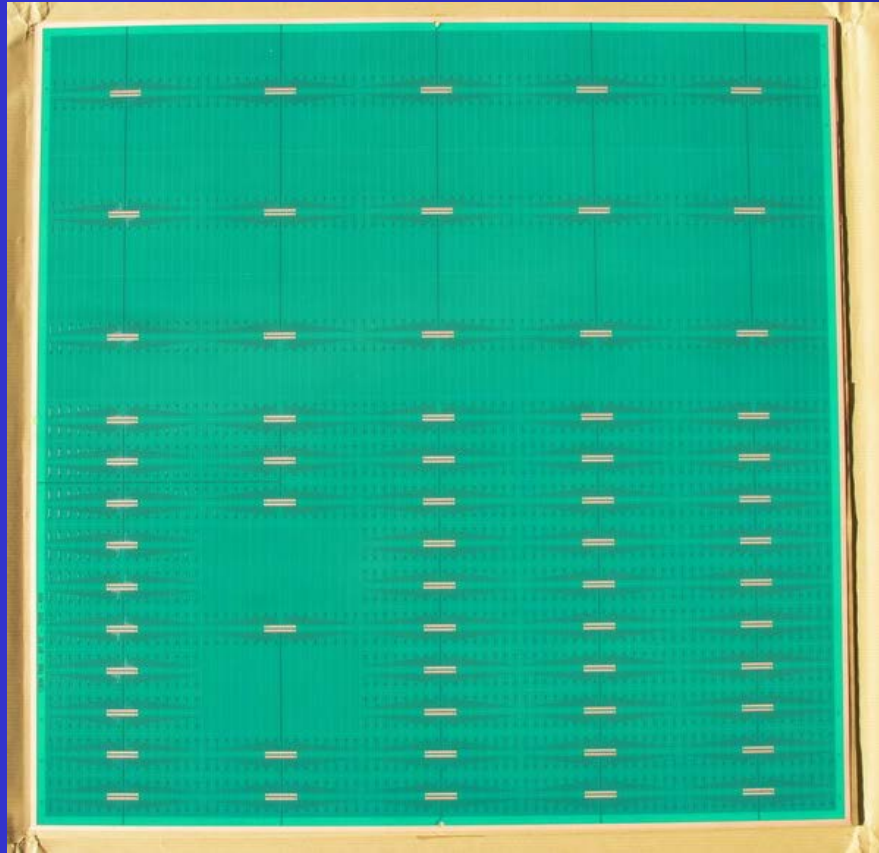


The large module size is given by the layer design:

$$5 \times \text{small module} = 3 \times \text{large module}$$

$$5 \times 570 \text{ mm} = 3 \times 950 \text{ mm}$$

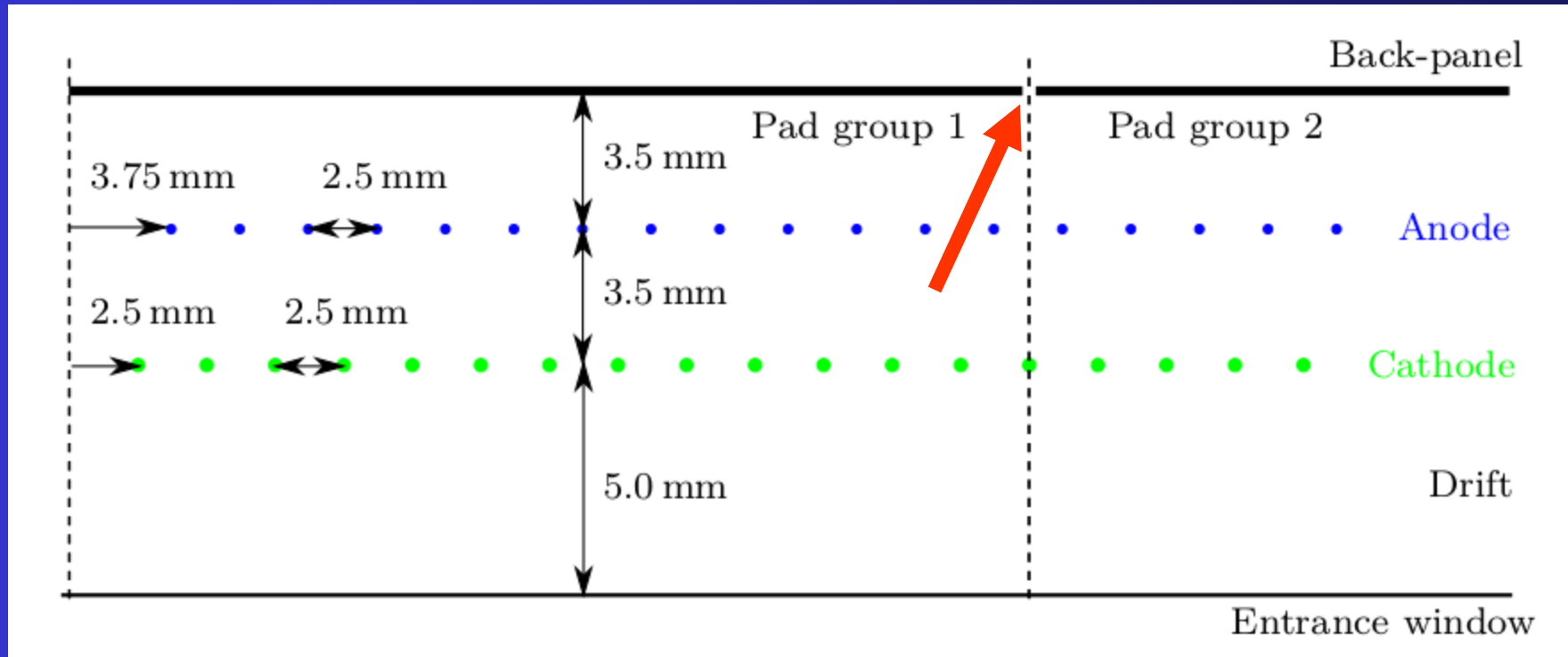
Pad plane material



The TRD is a 360 μm thick 2-layer PCB with 25 μm thick Cu layers. PCBs are ordered from the same company as for the ALICE TRD production.

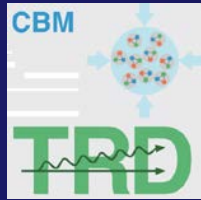
Pad size and orientation

Pad length



The pad length is an integer multiple of the anode wire pitch. The edge of a pad ends between 2 anode wires. This allows for minimal charge sharing between pad rows.

TRD modules - 90° rotated

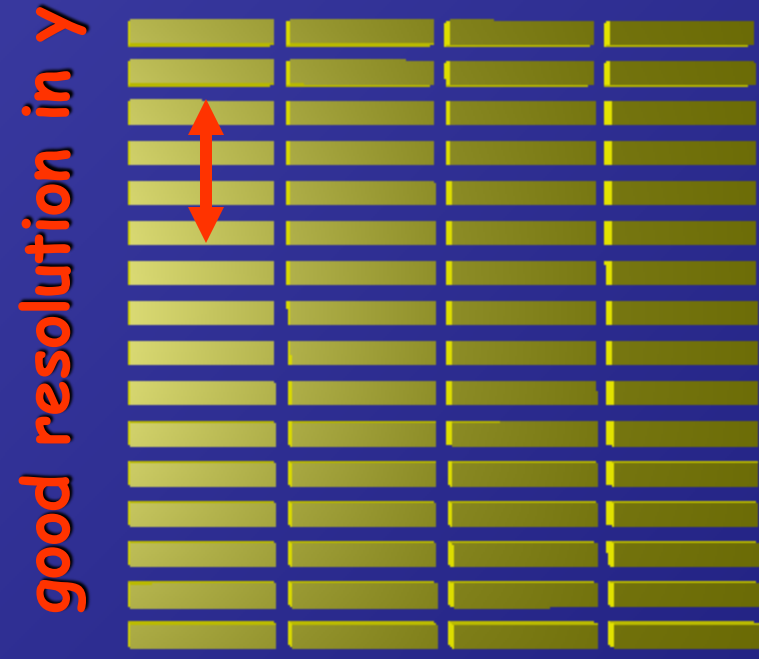
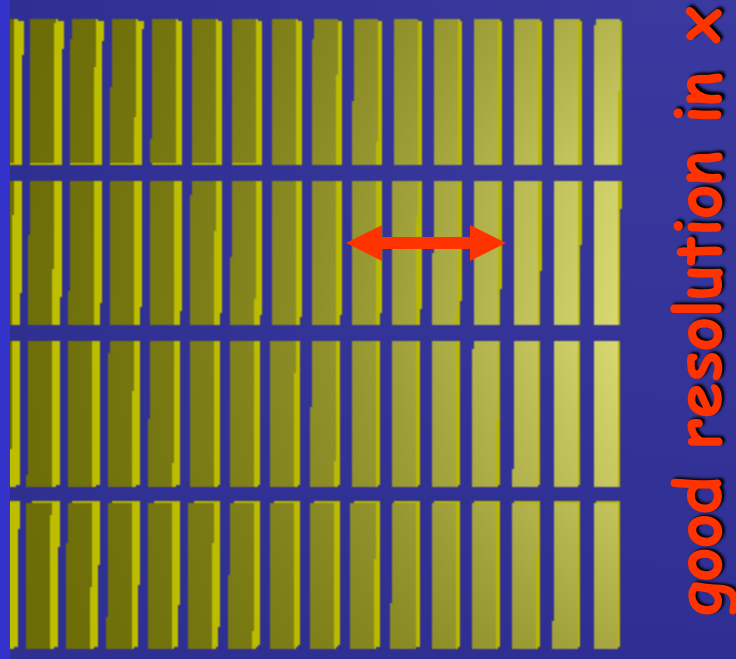


odd layers (1,3)

even layers (2,4)

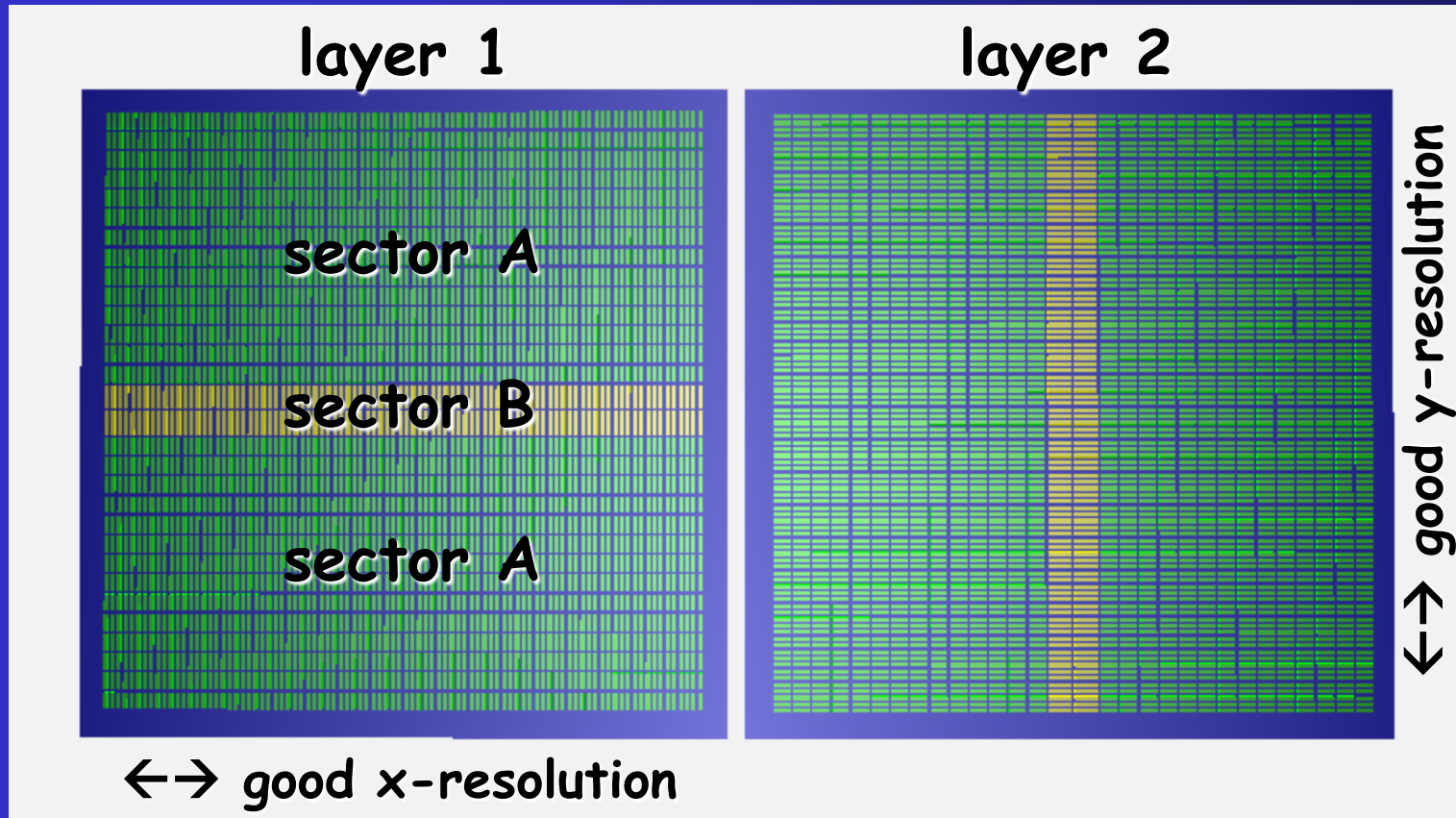
vertical pads

horizontal pads



here: 7.5mm x 30mm pad size

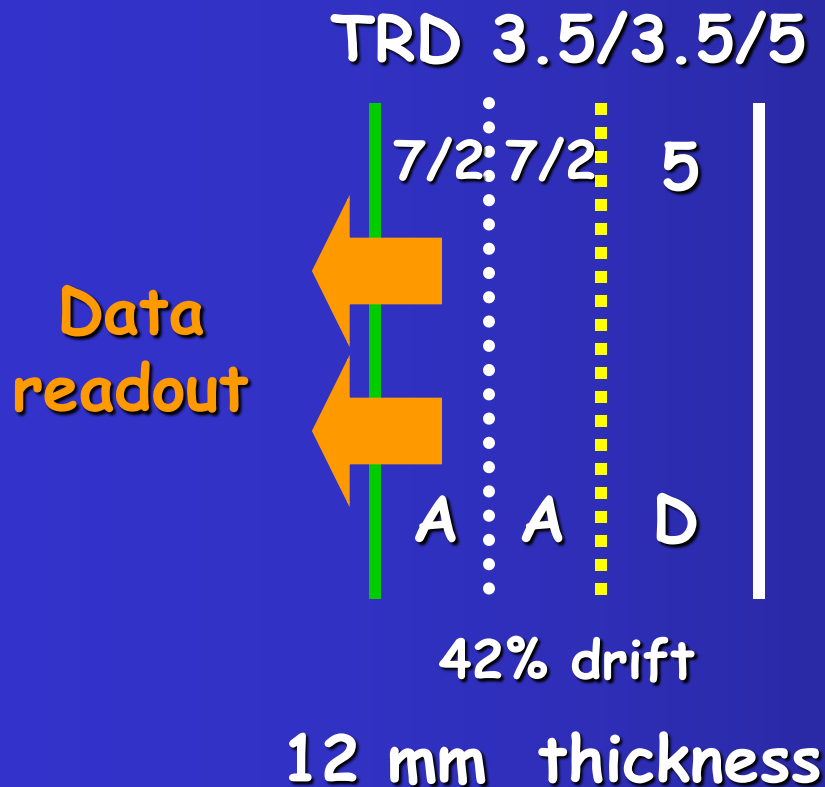
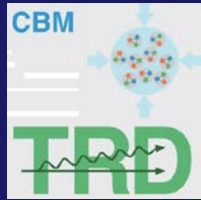
Pad sectors in TRD modules



A module can contain pads of different size, they have a fixed width (6.75mm for small modules, 7.12mm for large modules) but may differ in height.

MWPC geometries

TRD wire geometry

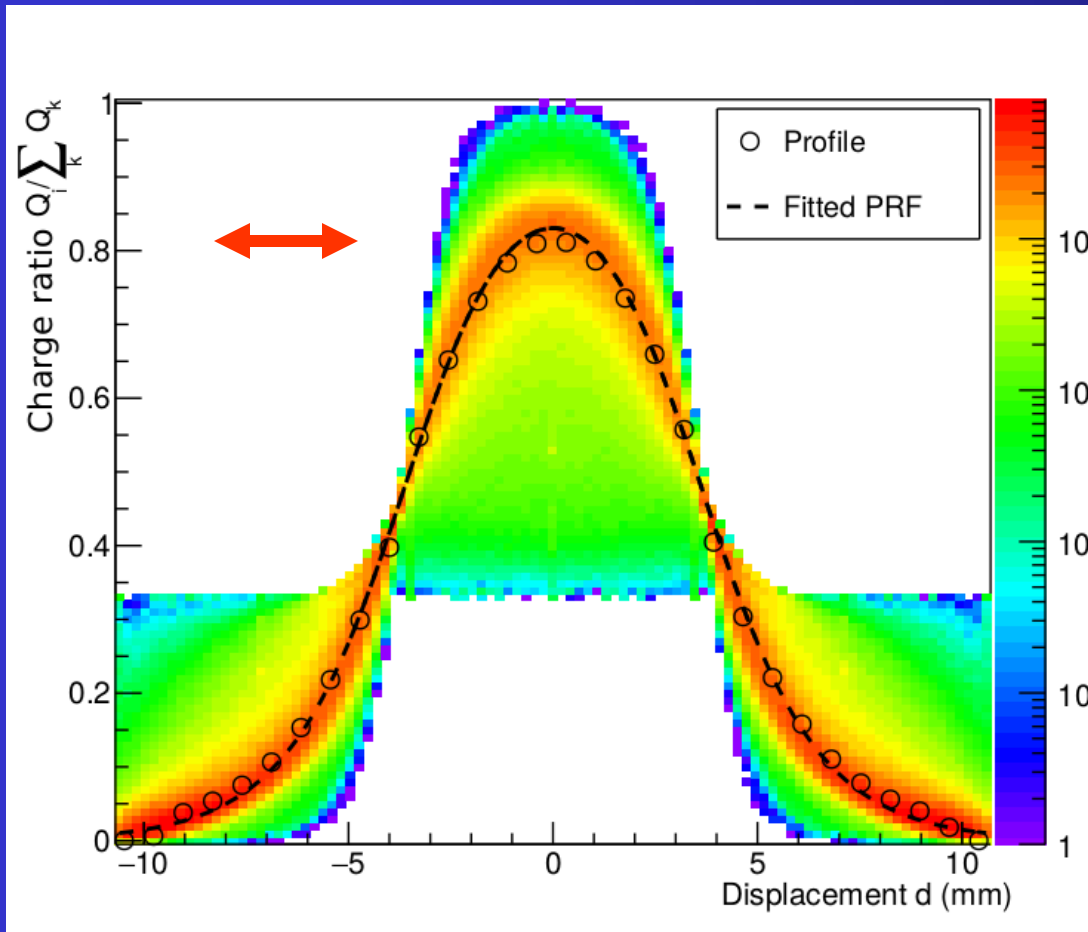
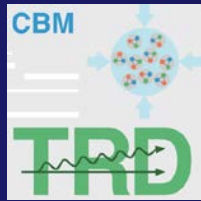


signal collection time

255 ns	TRD 3/3/6
230 ns	TRD 3.5/3.5/5
210 ns	TRD 4/4/4

signal collection in Xe/CO₂ (80/20), @ 100V/mm drift

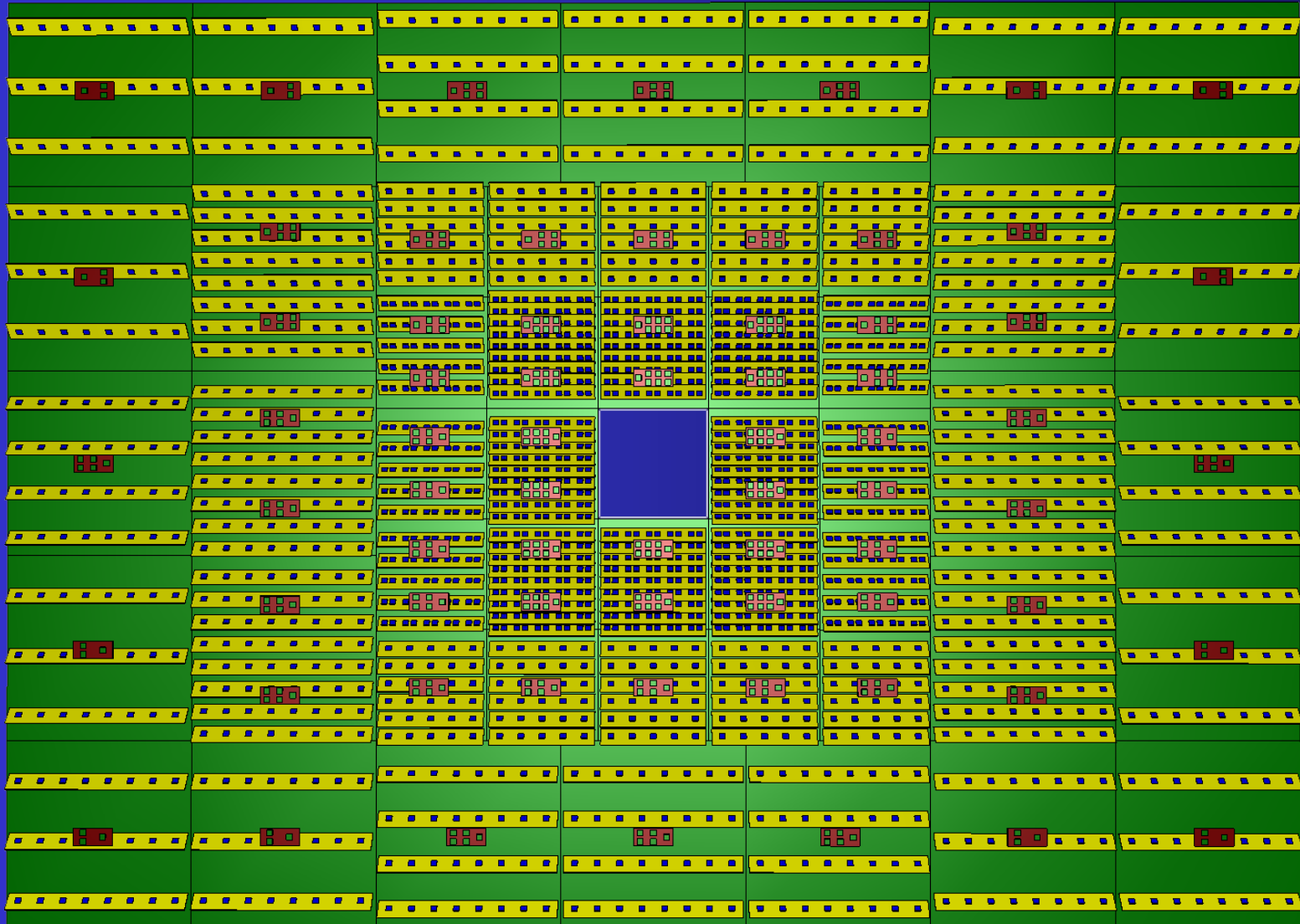
Pad response function



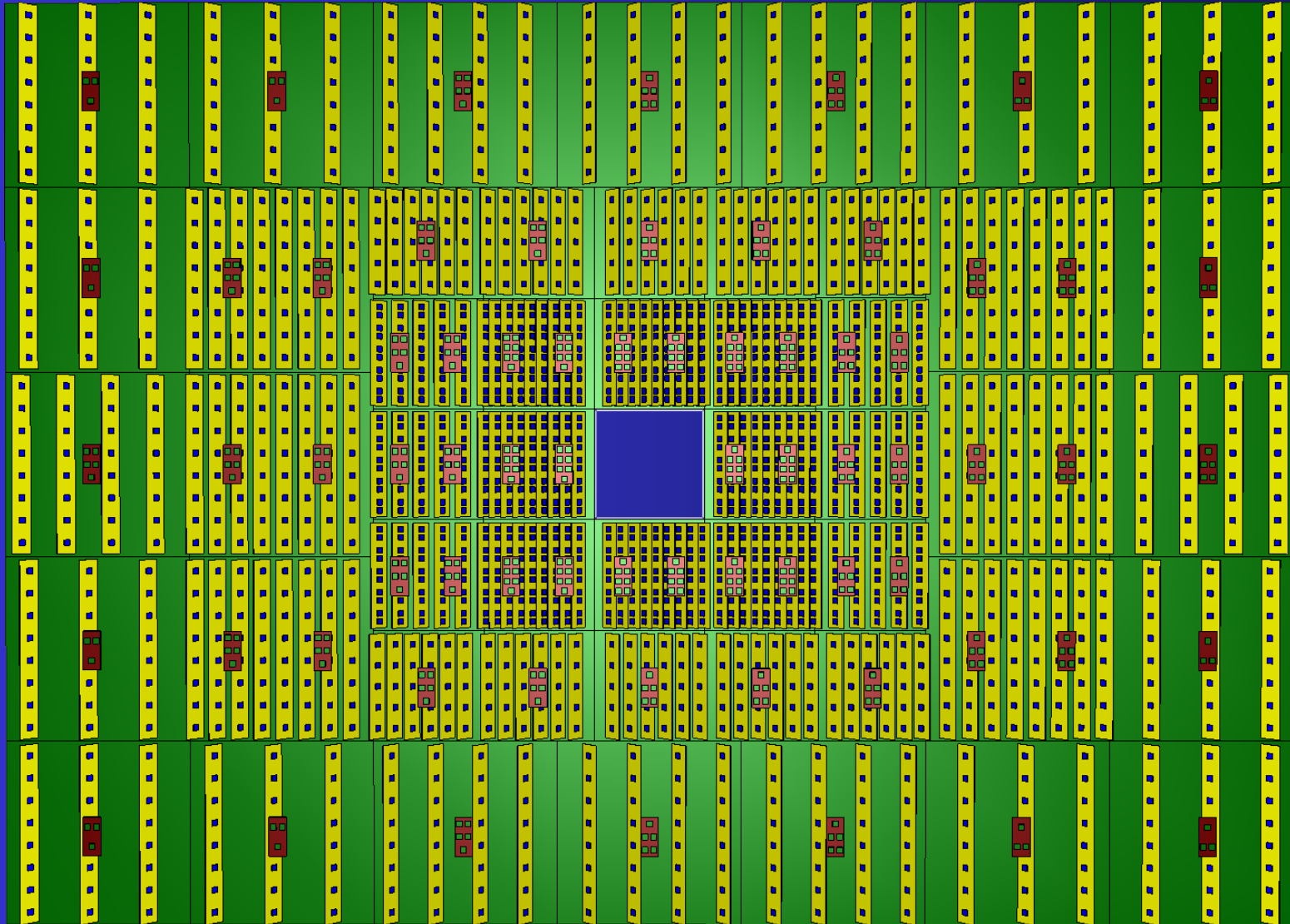
We have aimed at a signal distribution of 10-80-10% between the central and neighboring pads, which is achieved according to beam test data from 2015, see PRF function on the left side.

Pad plane layout

TRD v16b layer 1

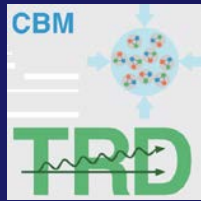


TRD v16b layer 2

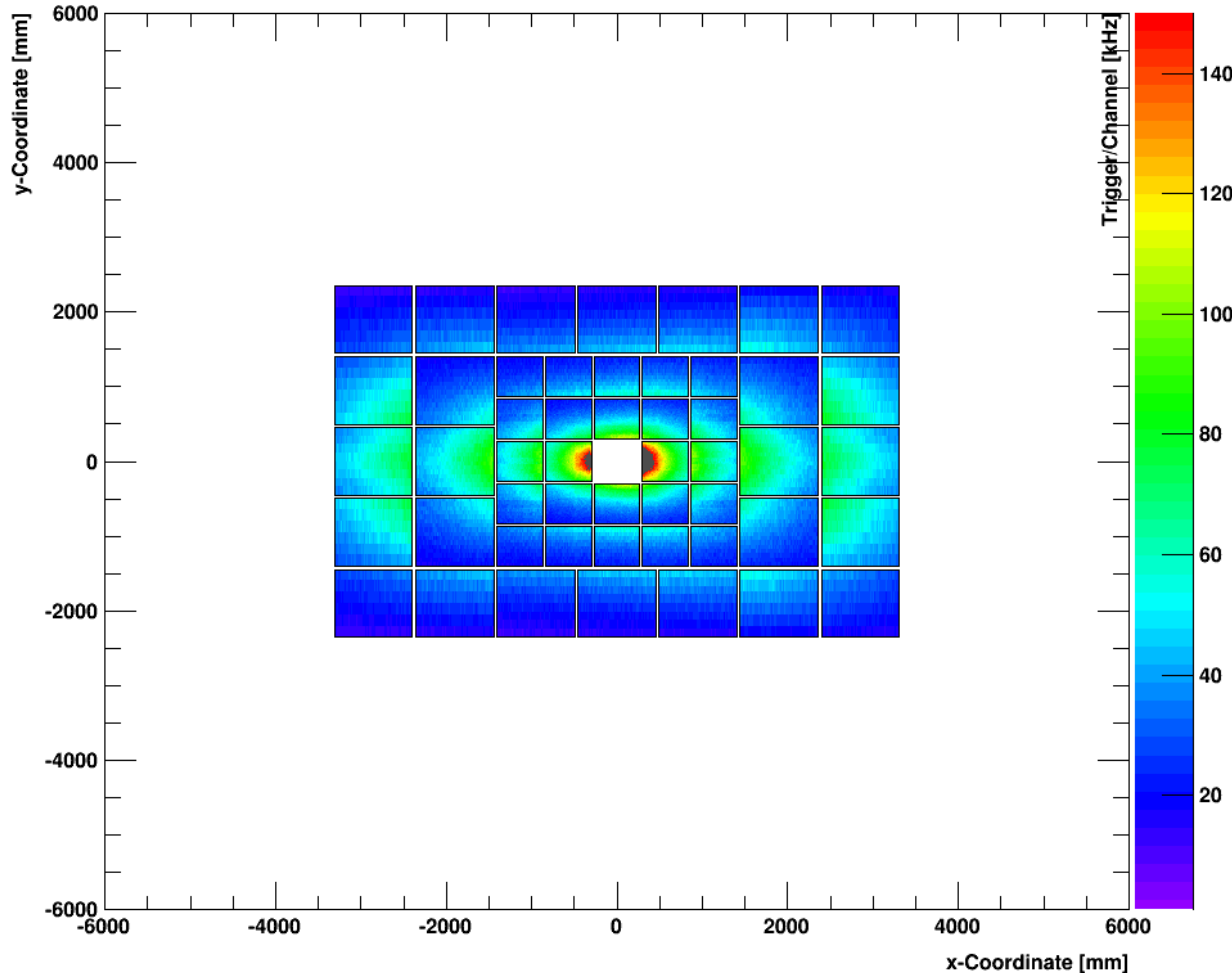


Trigger rate distribution

TRD hit rates RICH v08a

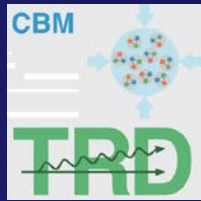


hdH Station 1, Layer 1

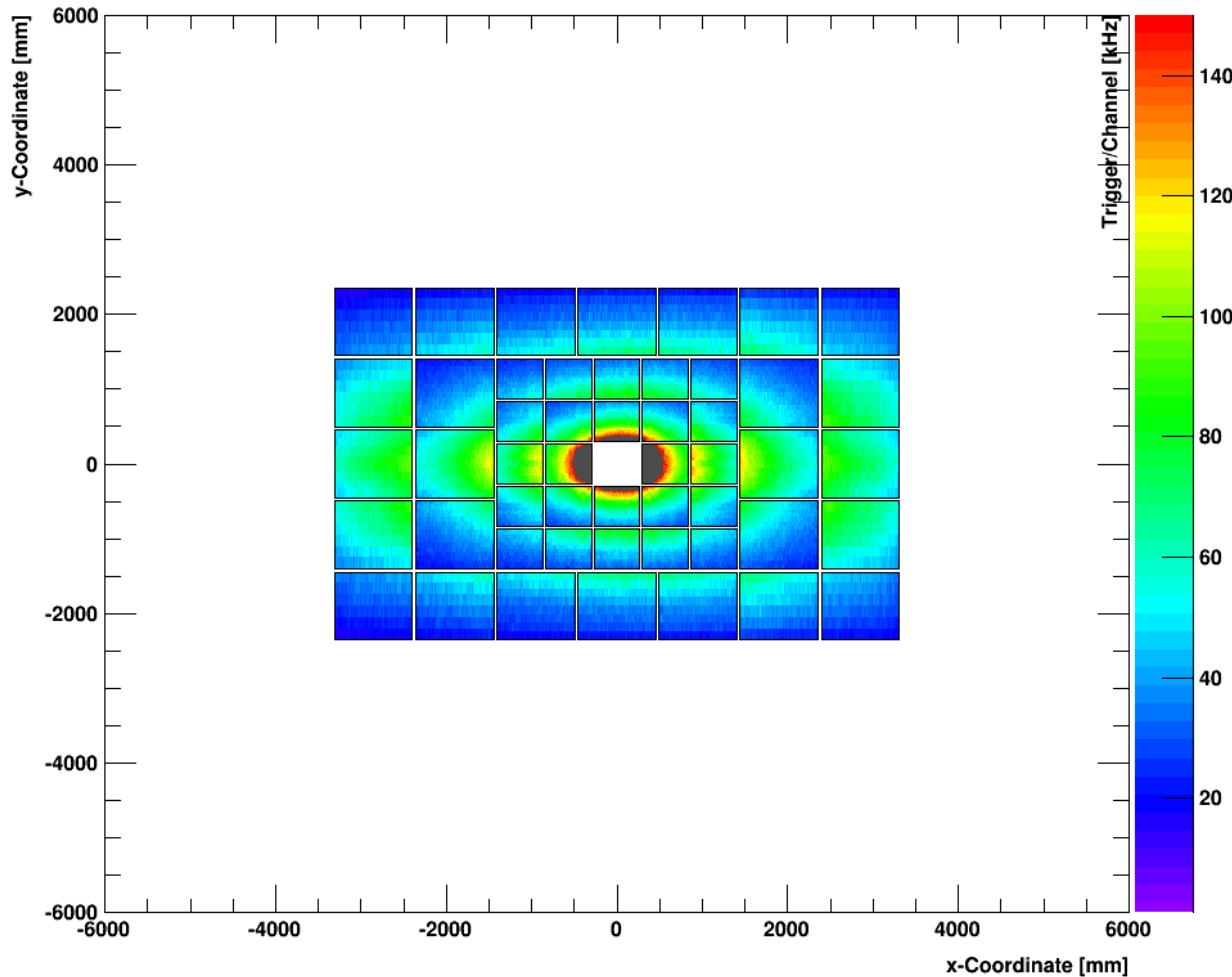


TRD trigger rates
with legacy
RICH v08a
(small amount of
material upstream)

TRD hit rates RICH v14a

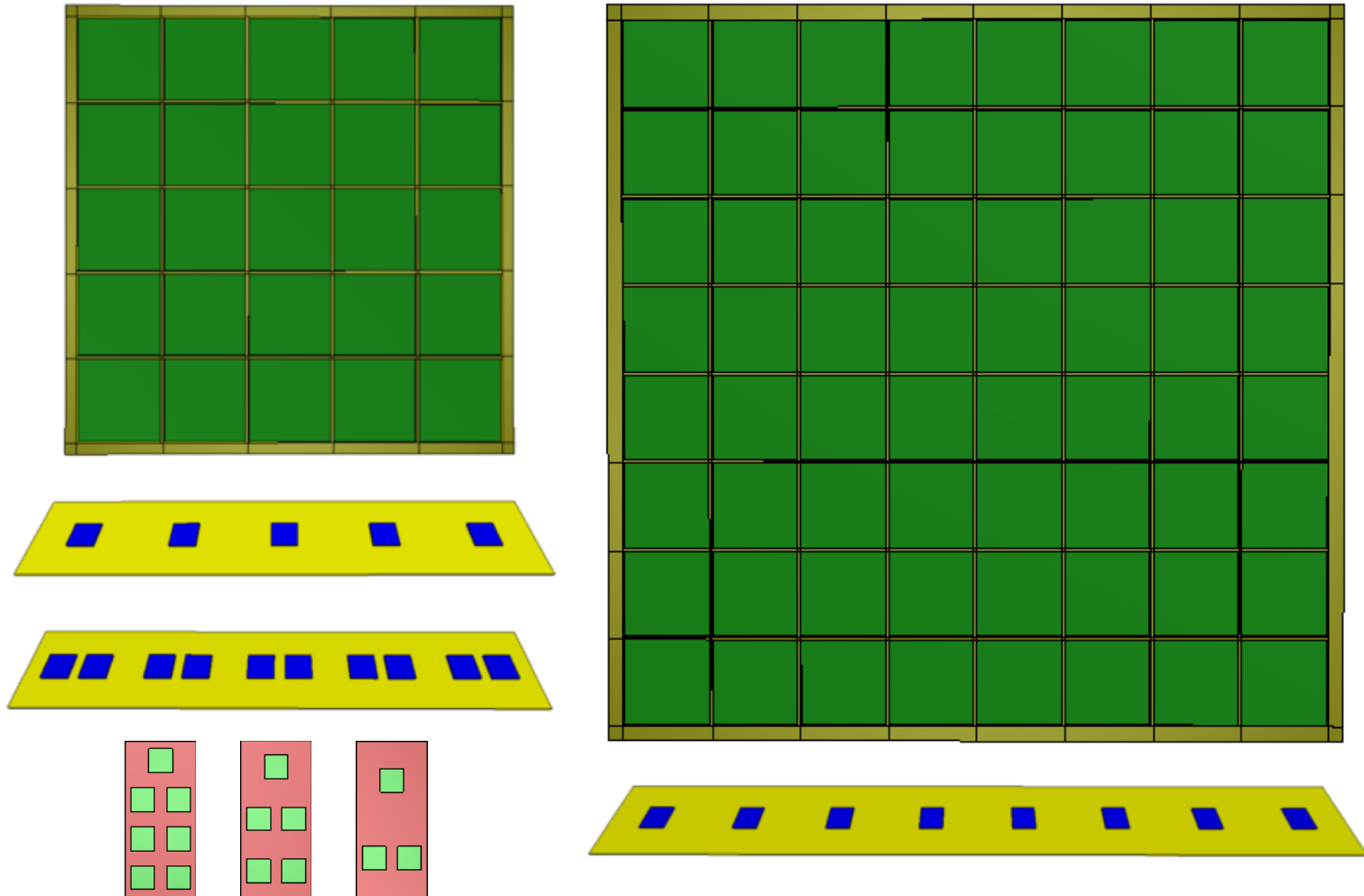


hdH Station 1, Layer 1

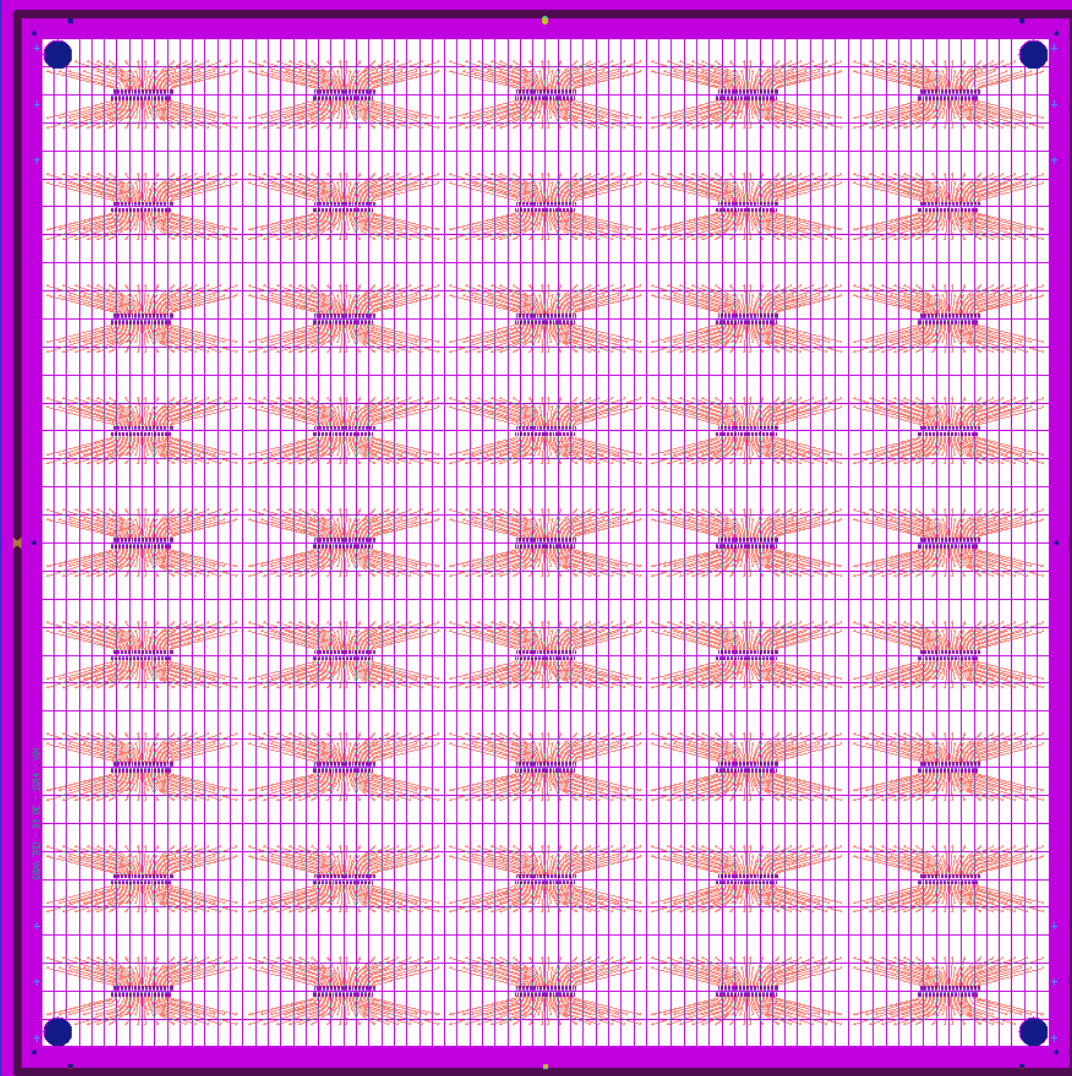


TRD trigger rates
with
RICH v14a
(larger amount of
material due to
modified support
structure)

TRD v16b components

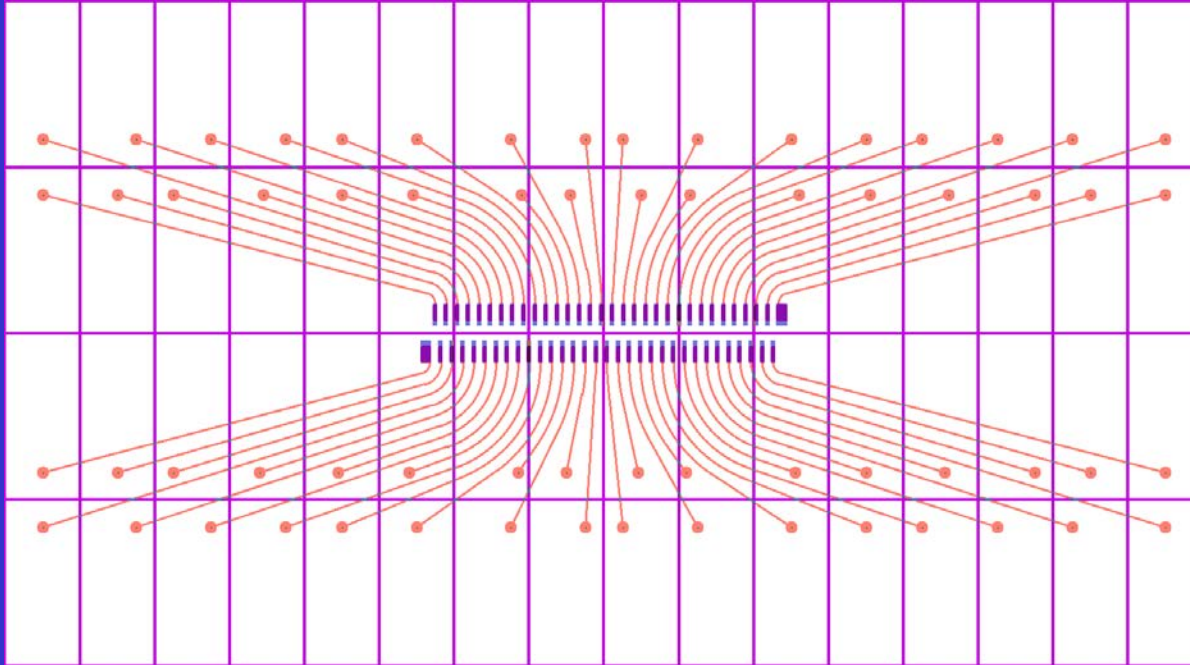
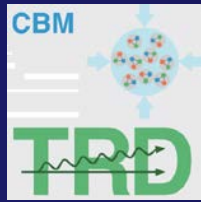


Type 1 pad plane v16b



- 36 rows, 80 columns
- 2880 pads
- 1.01 cm² pad size
- 45x 64-pin connectors
- 5 connectors per row
- 4 rows per connector

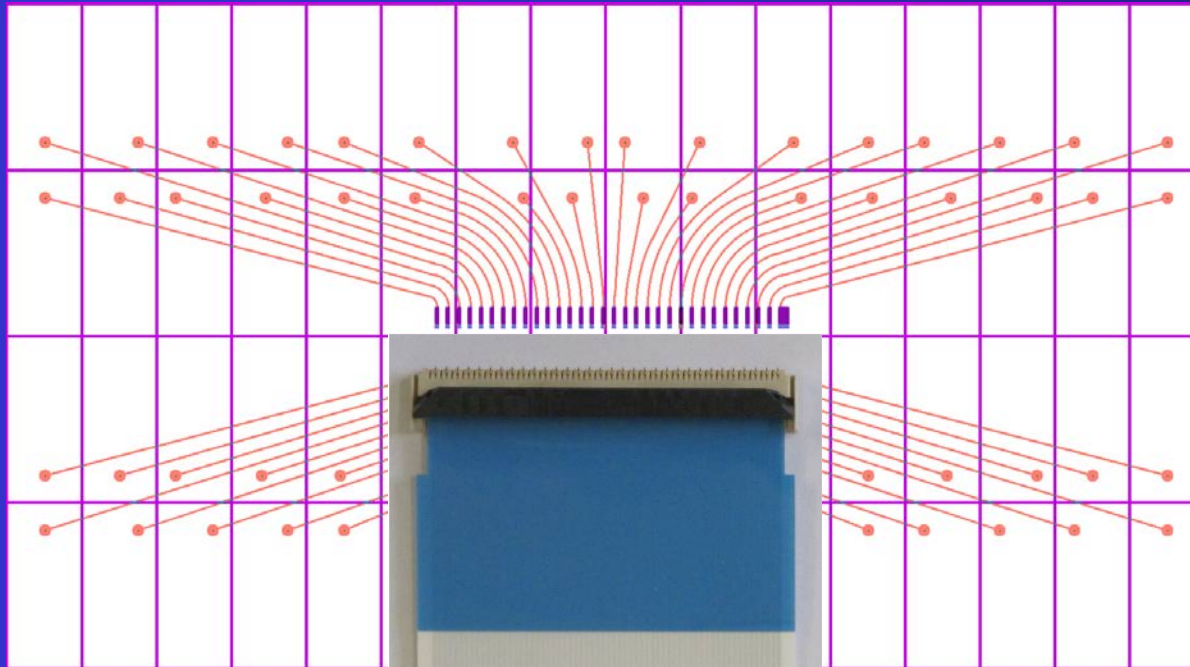
Type 1 pad block v16b



- 16 pads block width
- 4 rows a 16 pads = 64 pads

- channel sequence determined by angular pad order
- identical pattern for all footprints of a given module type
- all vias within a pad row are along a straight line (simpler to seal with glue for gas tightness)

64ch signal cable connection

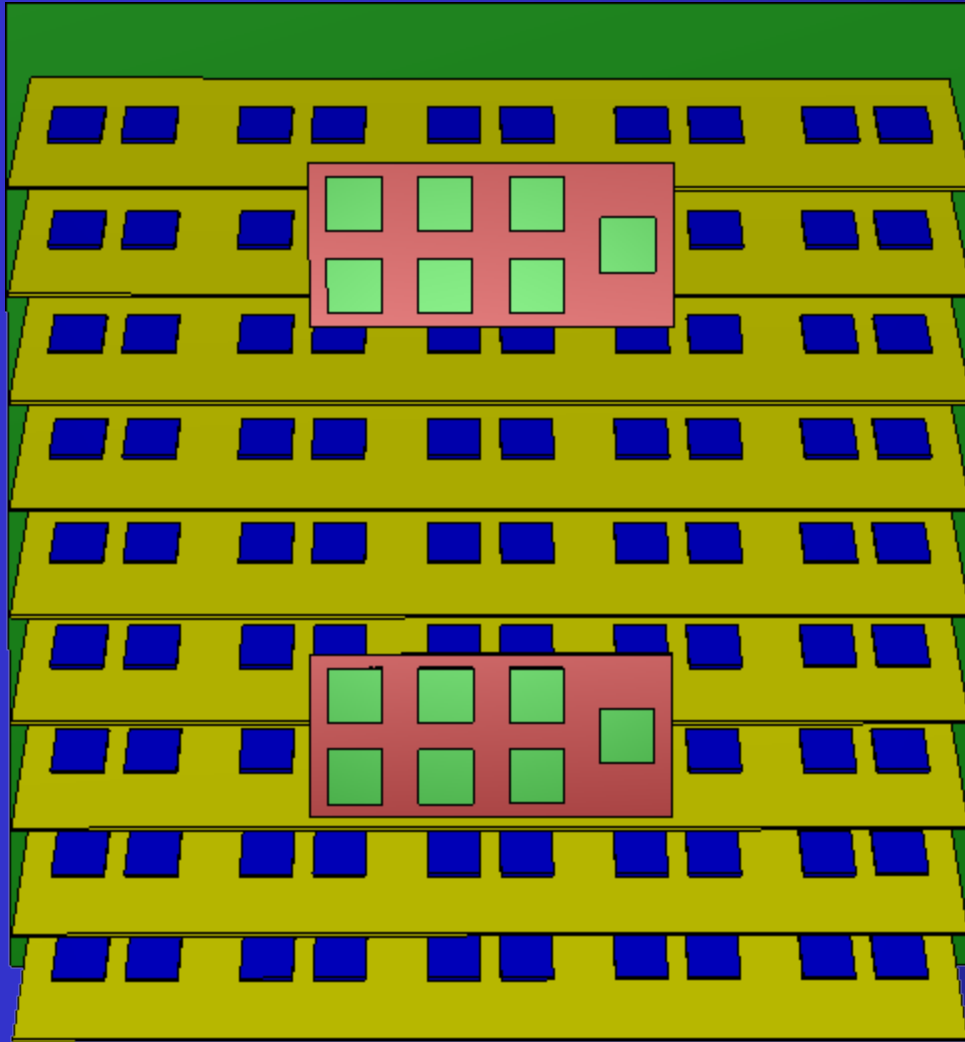


64 pin cable
0.5 mm pitch

AXON FFC 0.50 A 64 / 0150 S
3,5-3,5-08,0-08,0 F AJJ / N

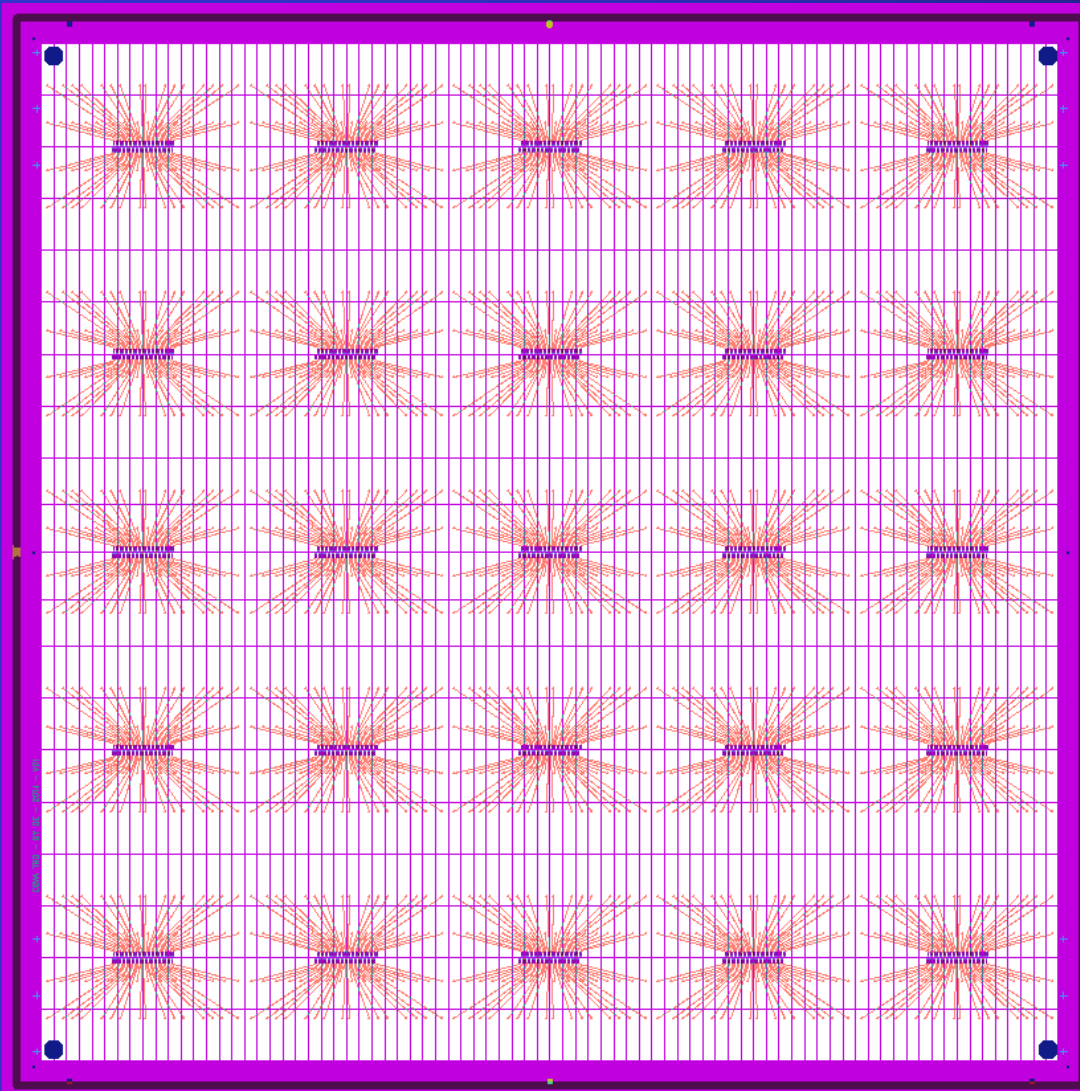
- 64-pin connectors are soldered to the pad plane
- flat cables are used to connect to the electronics
- 64-pin cables interface to 2x 32ch-SPADICs

Module type 1 FEBs



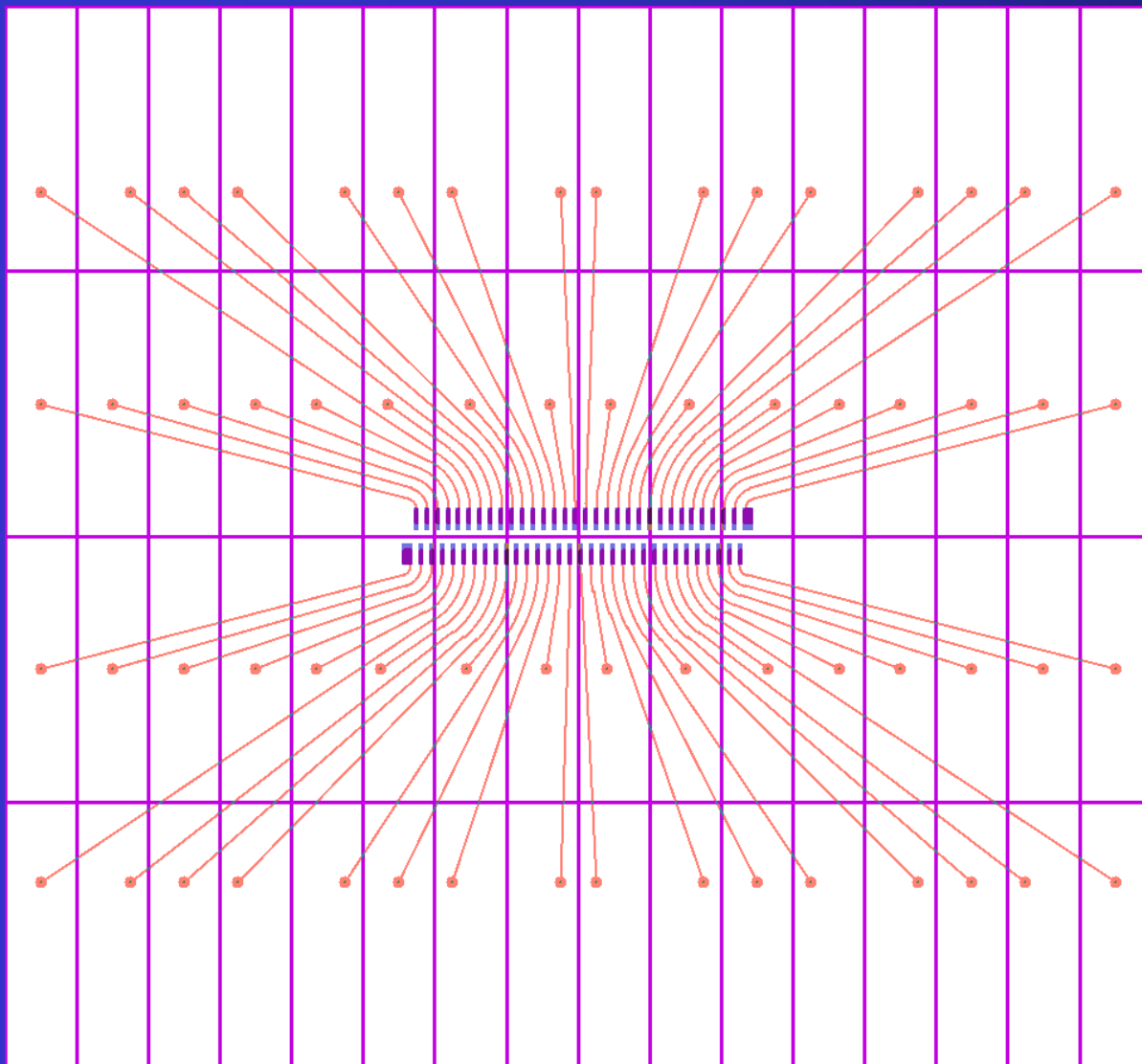
- 2880 channels
- 45x cable connections
- 9 FEBs a 5x2 ASICs
- 2x GBTx ROB-7
- 16 optical links
2x down- 14x uplink
- 180/196 e-links used
- 92% uplink efficiency

Type 2 pad plane v16b

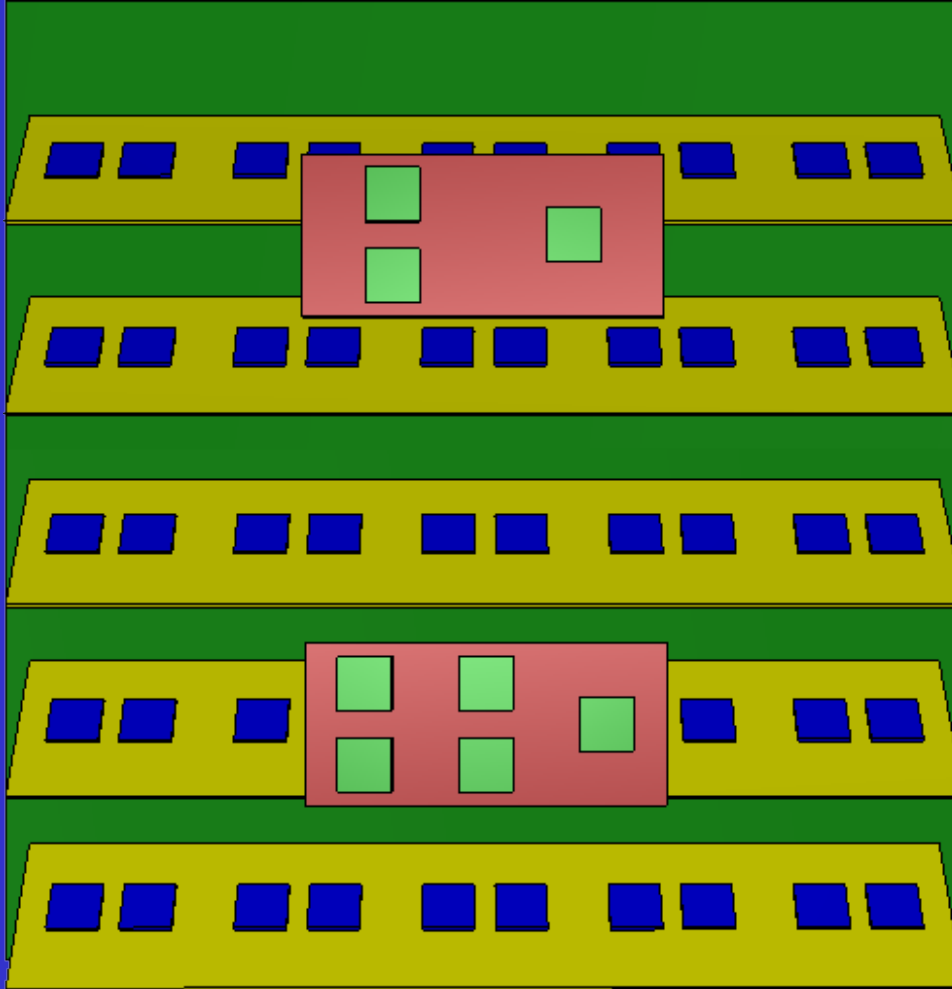


- 20 rows, 80 columns
- 1600 pads
- 1.69 cm² pad size
- 25x 64-pin connectors
- 5 connectors per row
- 4 rows per connector

Type 2 pad block v16b

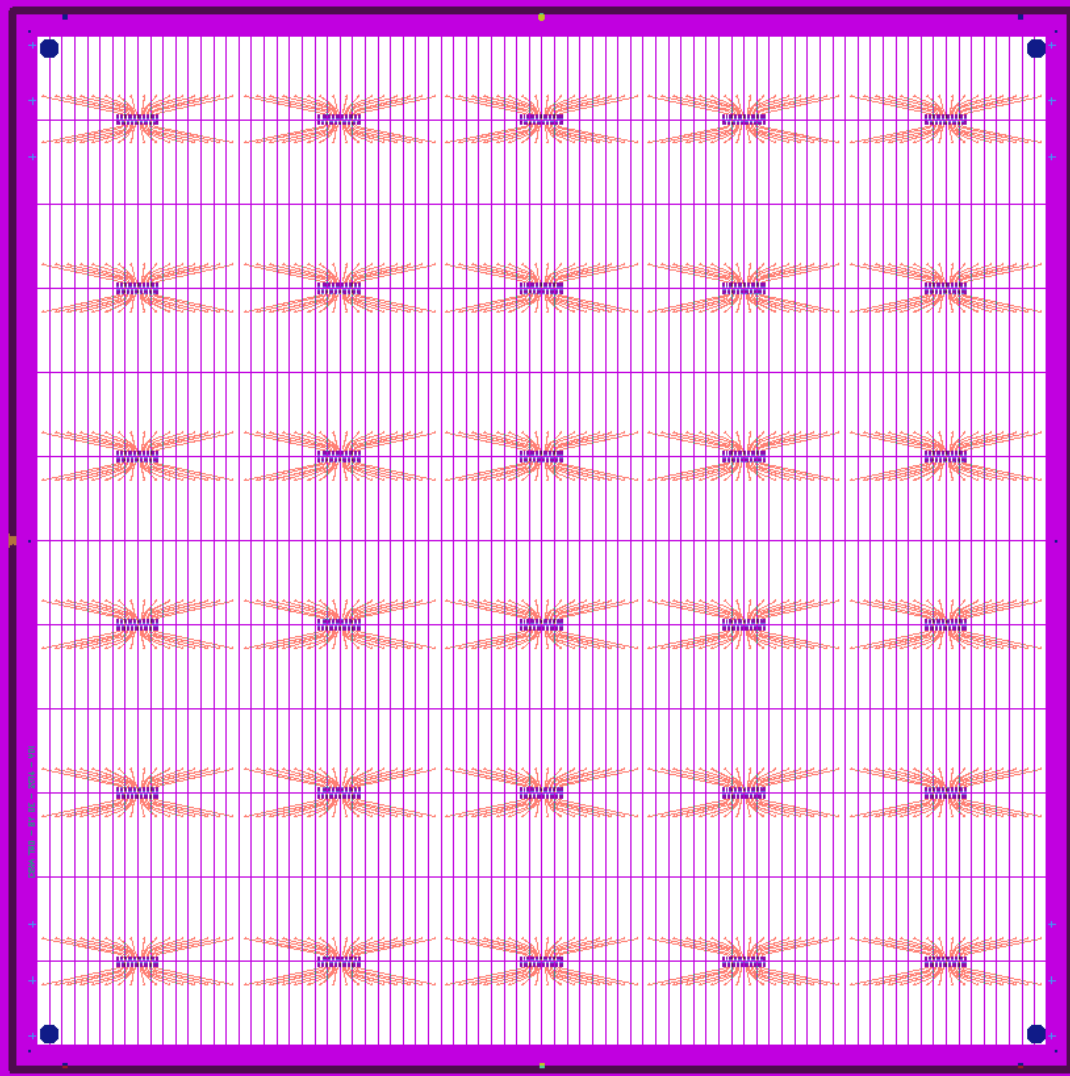


Module type 2 FEBs



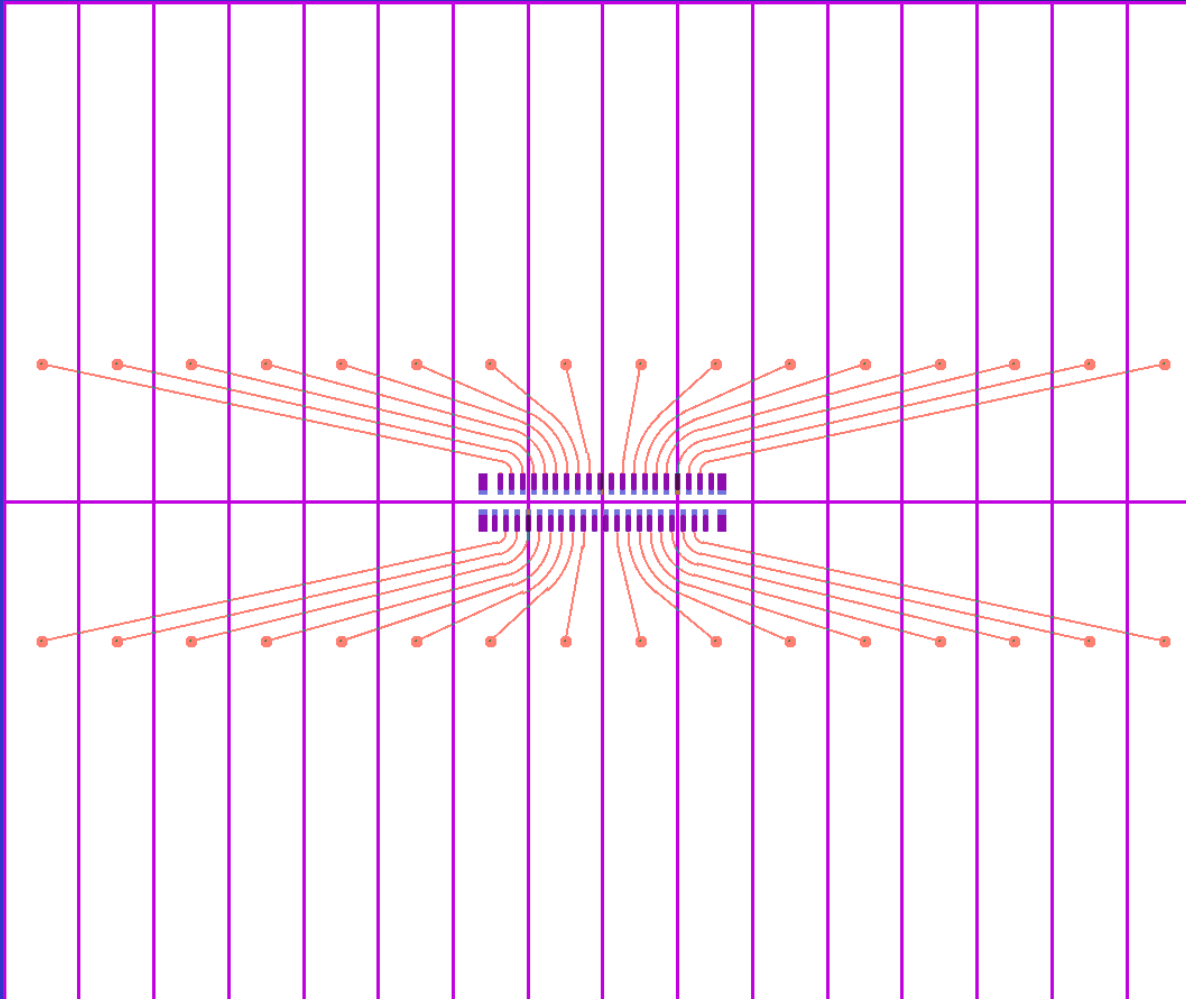
- 1600 channels
- 25x cable connections
- 5 FEBs a 5x2 ASICs
- 1x GBTx ROB-3
- 1x GBTx ROB-5
- 10 optical links
2x down- 8x uplink
- 100/112 e-links used
- 89% uplink efficiency

Type 3 pad plane v16b



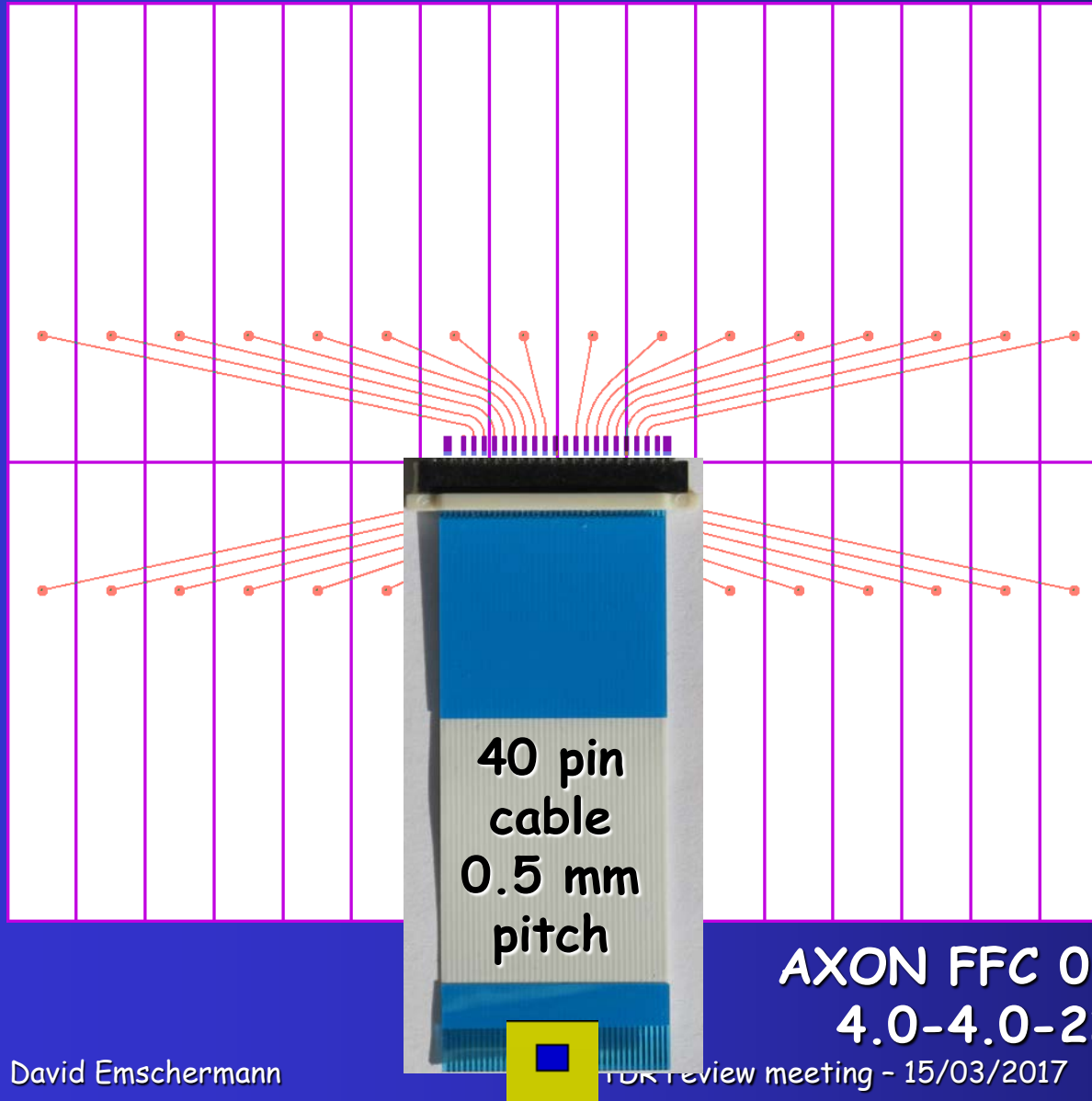
- 12 rows, 80 columns
- 960 pads
- 3.04 cm² pad size
- 30x 32-pin connectors
- 5 connectors per row
- 2 rows per connector

Type 3 pad block v16b



This type of connector layout is also used on all large detectors, module types 6,7,8

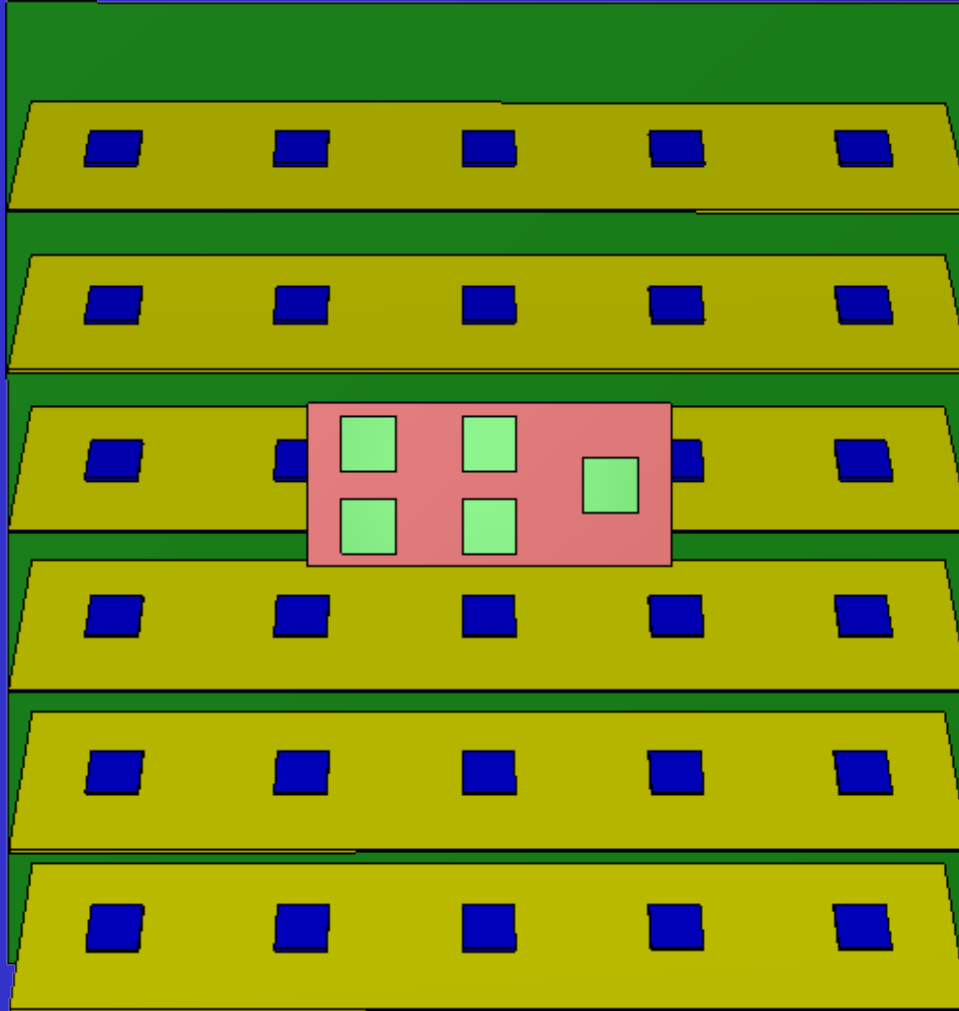
32ch signal cable connection



- 40-pin connectors (for historical reasons) are soldered to the pad plane
- flat cables are used to connect to the electronics
- 40-pin cables interface to 1x 32ch-SPADIC

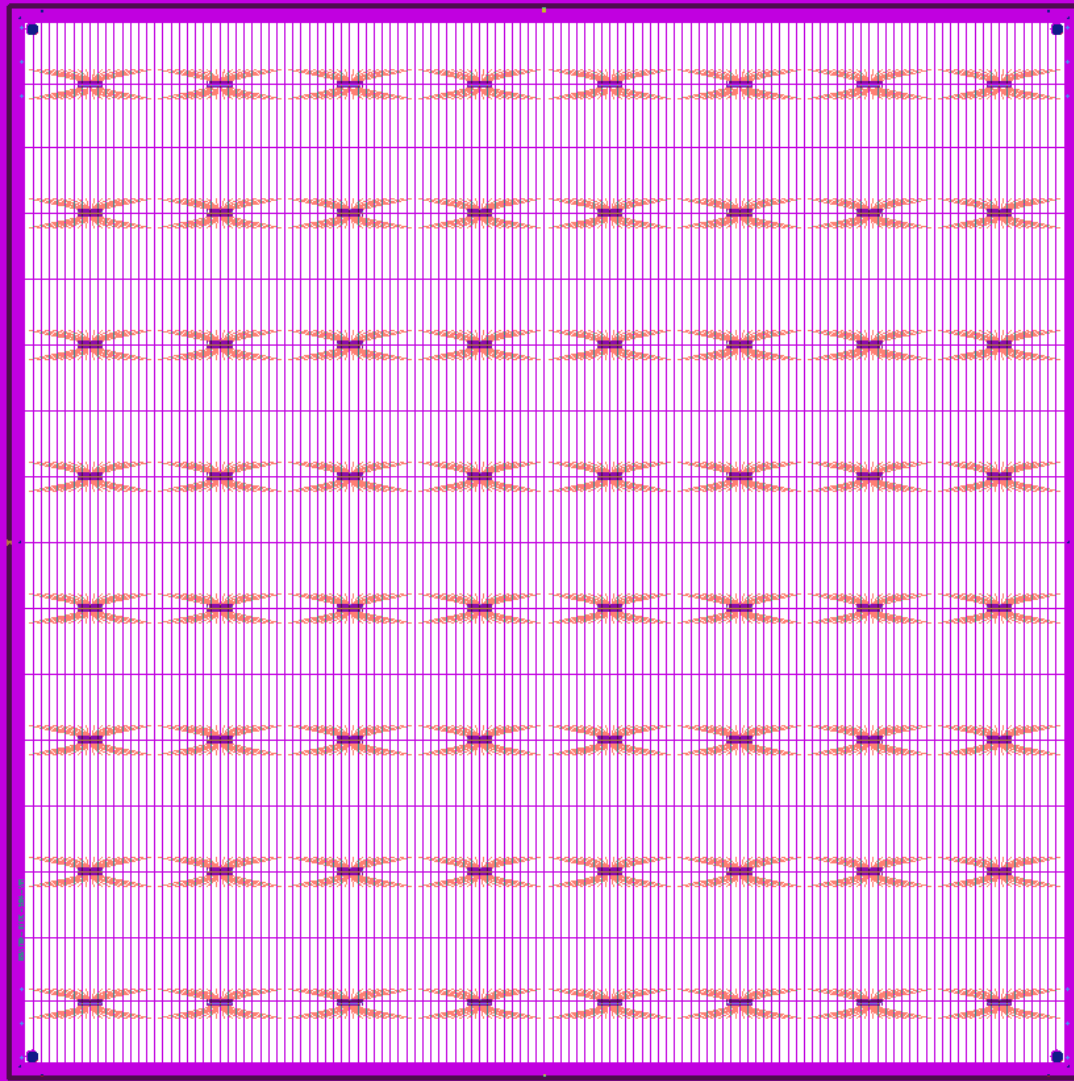
AXON FFC 0.50 A 40 / 0046 L
4.0-4.0-22.0-08.0 S ABB

Module type 3 FEBs



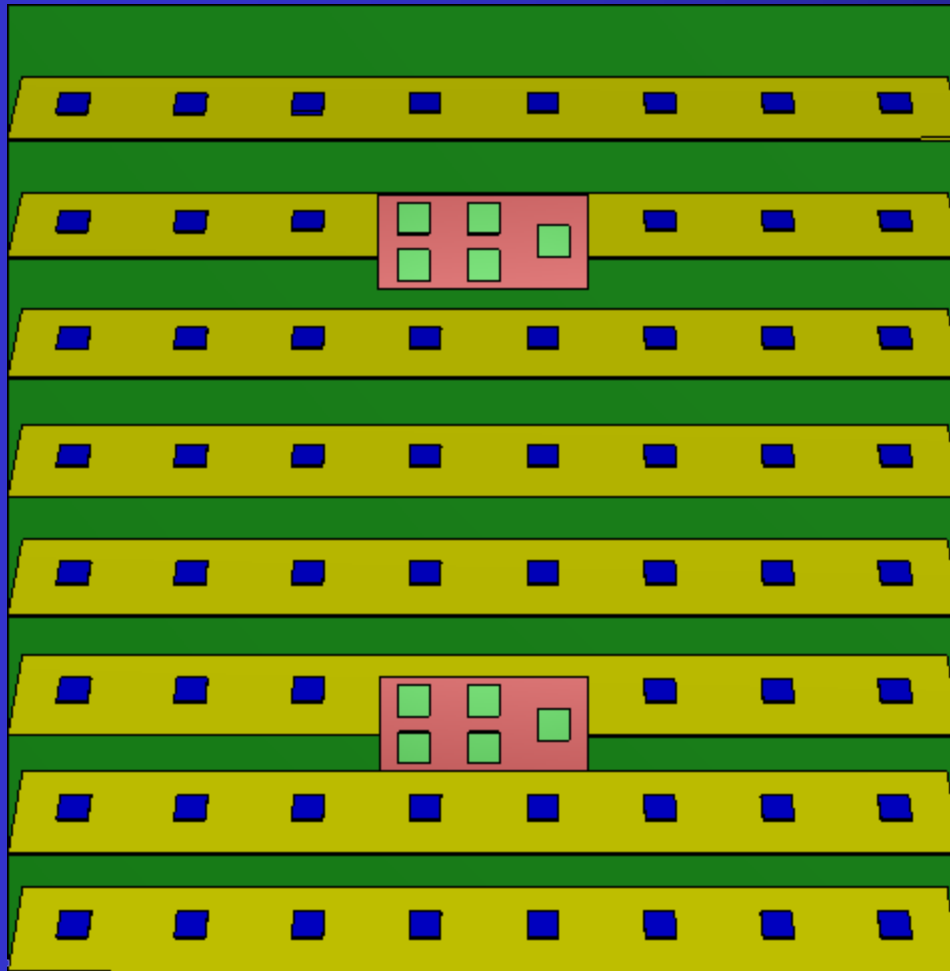
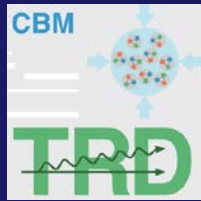
- 960 channels
- 30x cable connections
- 6 FEBs a 5x1 ASICs
- 1x GBTx ROB-5
- 6 optical links
1x down- 5x uplink
- 60/70 e-links used
- 86% uplink efficiency

Type 6 pad plane v16b



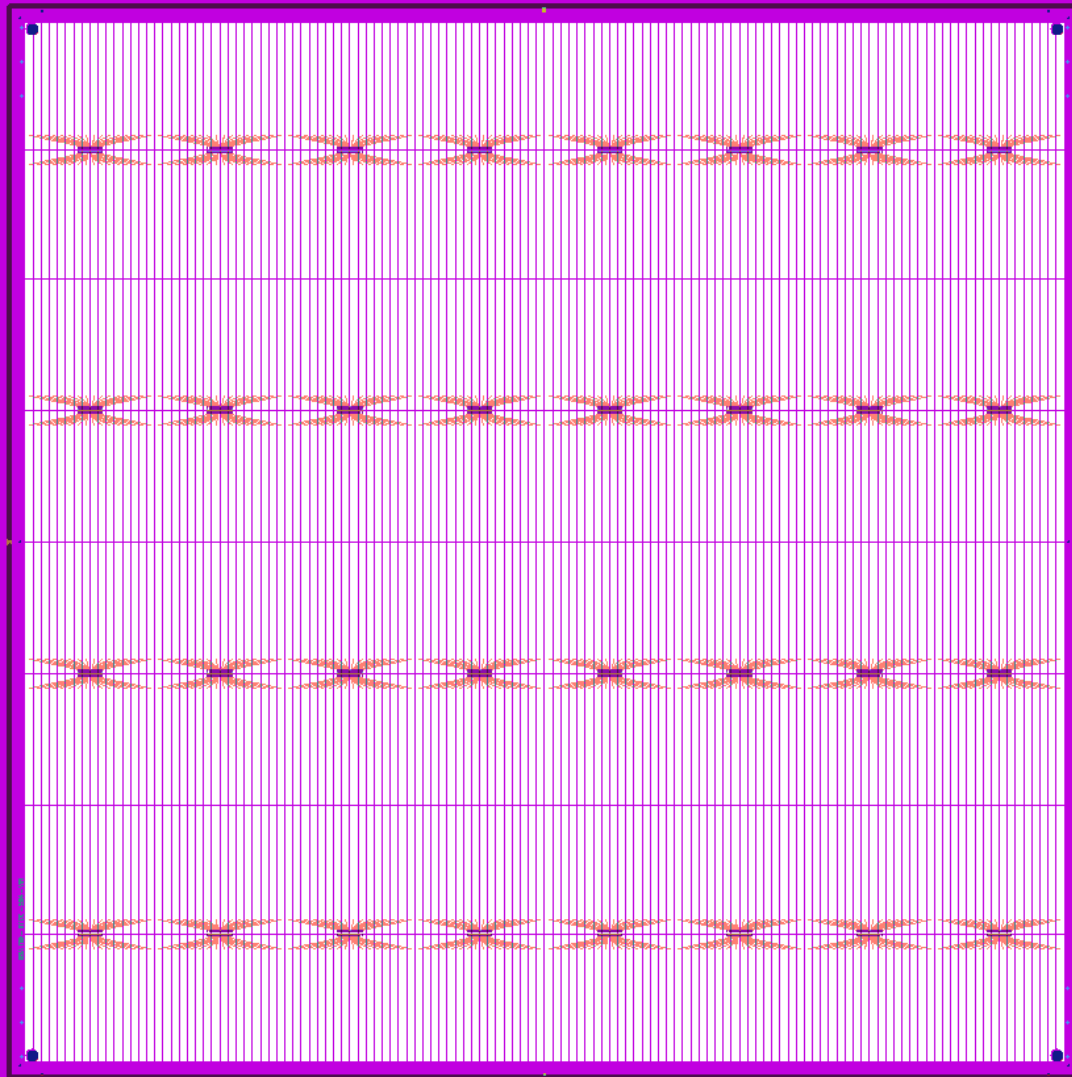
- 16 rows, 128 columns
- 2048 pads
- 4.13 cm² pad size
- 64x 32-pin connectors
- 8 connectors per row
- 2 rows per connector

Module type 6 FEBs



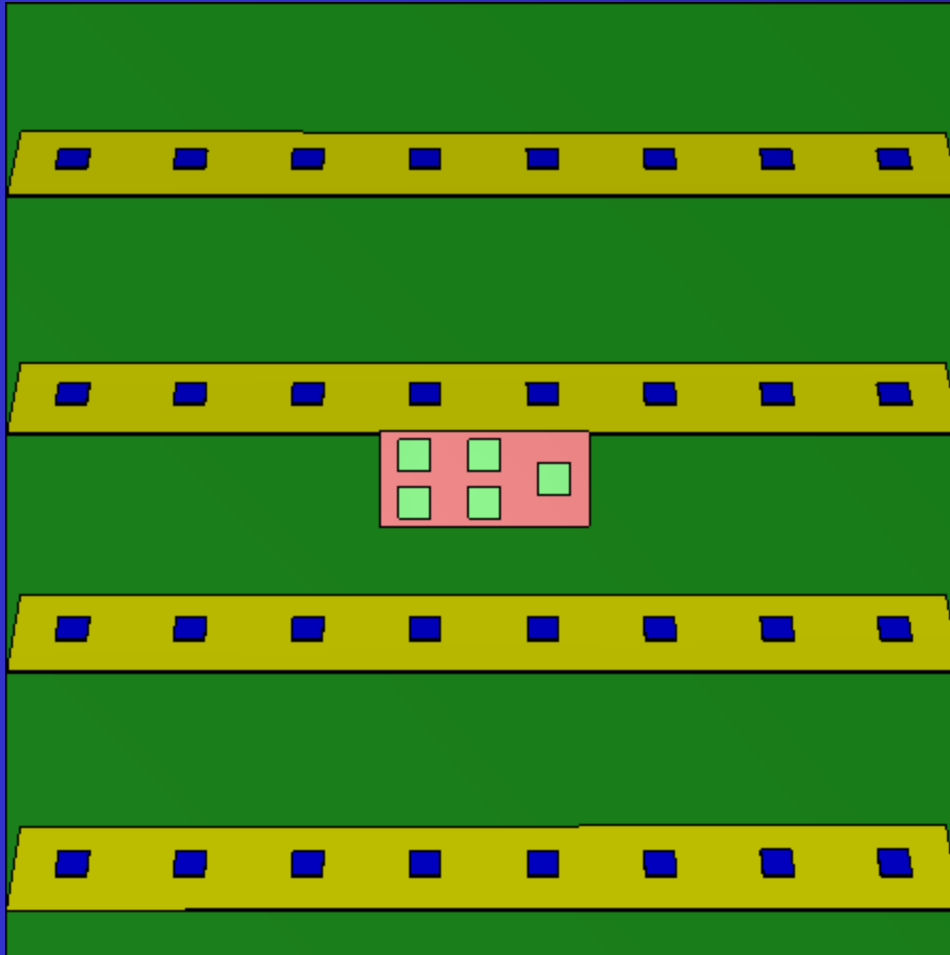
- 2048 channels
- 64x cable connections
- 8 FEBs a 8x1 ASICs
- 2x GBTx ROB-5
- 12 optical links
2x down- 10x uplink
- 128/140 e-links used
- 91% uplink efficiency

Type 7 pad plane v16b



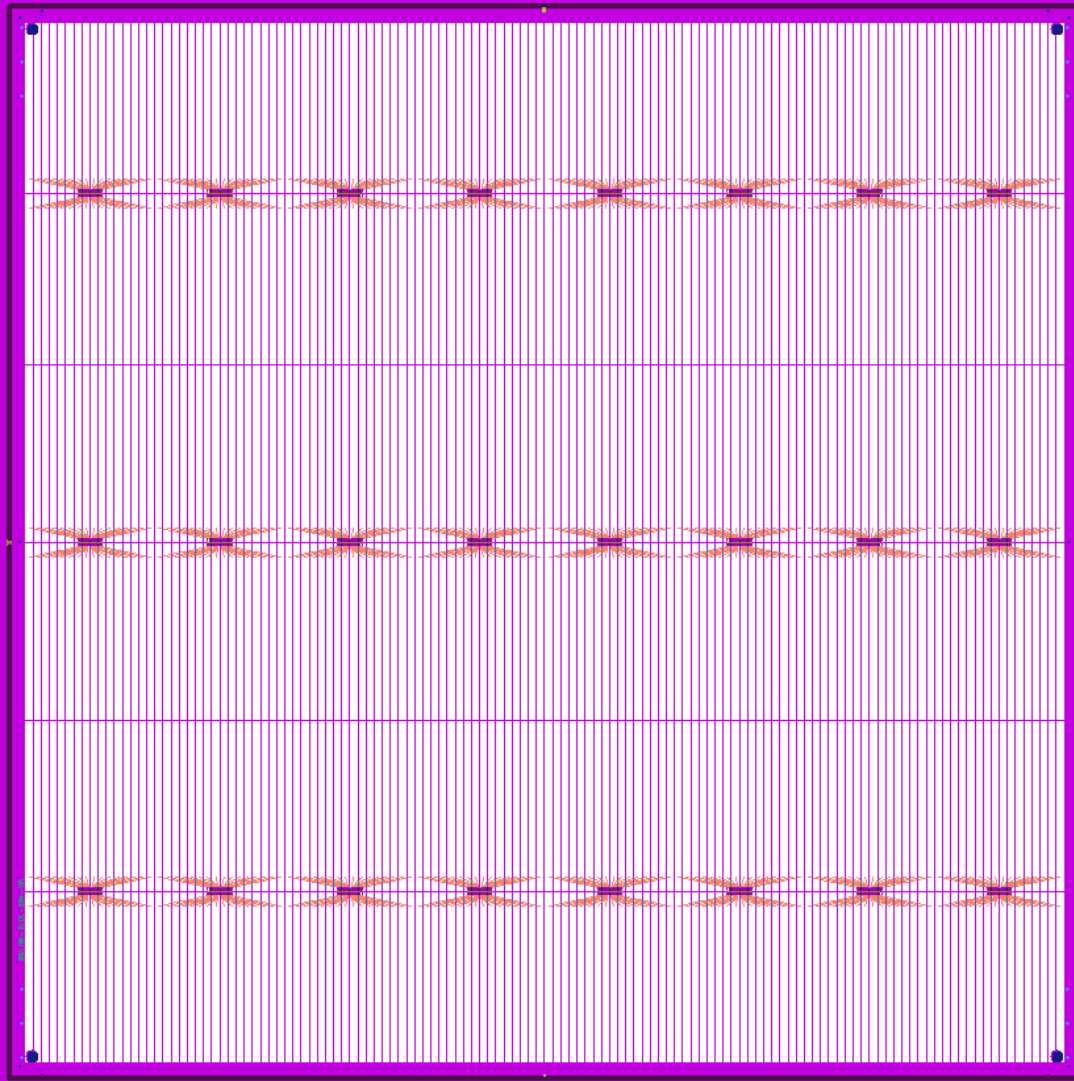
- 8 rows, 128 columns
- 1024 pads
- 8.27 cm² pad size
- 32x 32-pin connectors
- 8 connectors per row
- 2 rows per connector

Module type 7 FEBs



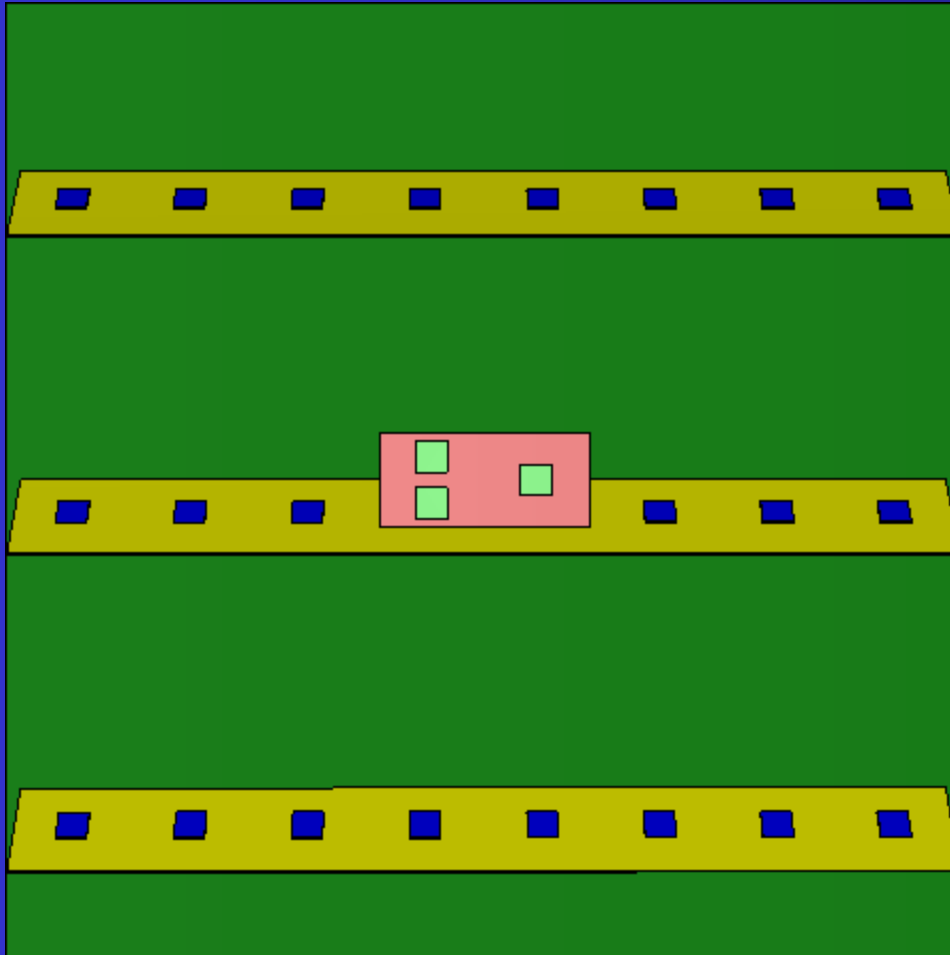
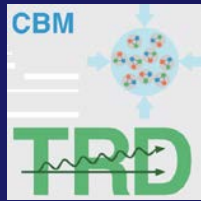
- 1024 channels
- 32x cable connections
- 4 FEBs a 8x1 ASICs
- 1x GBTx ROB-5
- 6 optical links
1x down- 5x uplink
- 64/70 e-links used
- 91% uplink efficiency

Type 8 pad plane v16b



- 6 rows, 128 columns
- 768 pads
- 10.96 cm² pad size
- 24x 32-pin connectors
- 8 connectors per row
- 2 rows per connector

Module type 8 FEBs

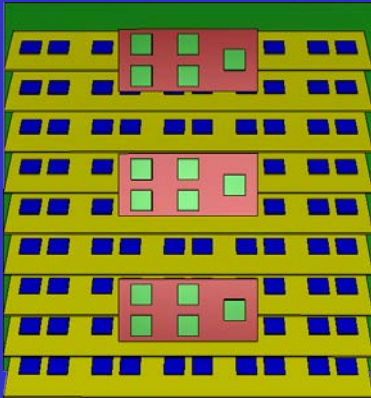


- 768 channels
- 24x cable connections
- 3 FEBs a 8x1 ASICs
- 1x GBTx ROB-3
- 4 optical links
1x down- 3x uplink
- 24/42 e-links used
(only 1 e-link per Spadic)
cannot be done with
Spadic v2.0
- 57% uplink efficiency

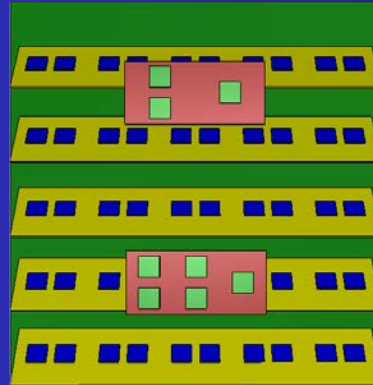
TRD geometry v16b



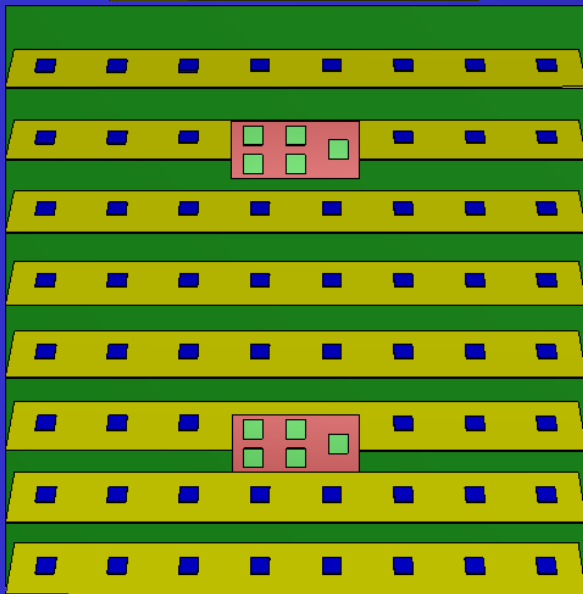
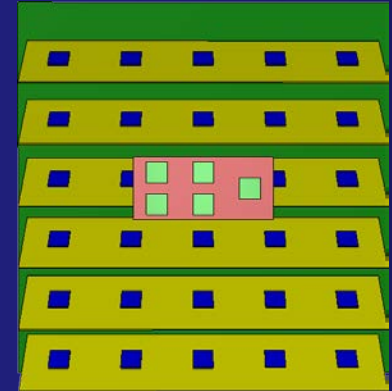
90/9/15/3



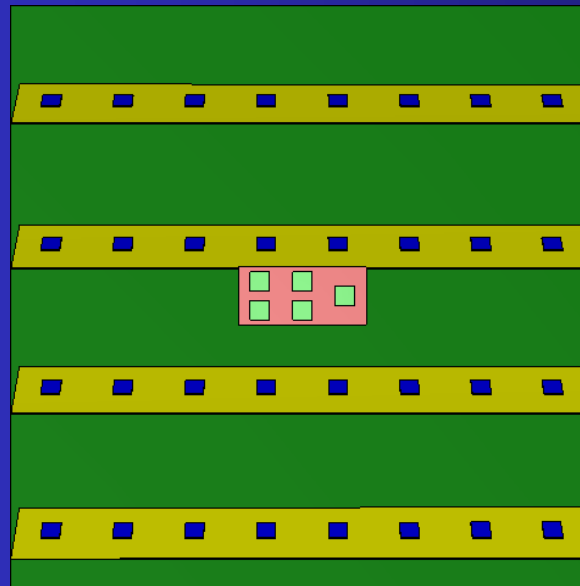
50/5/8/2



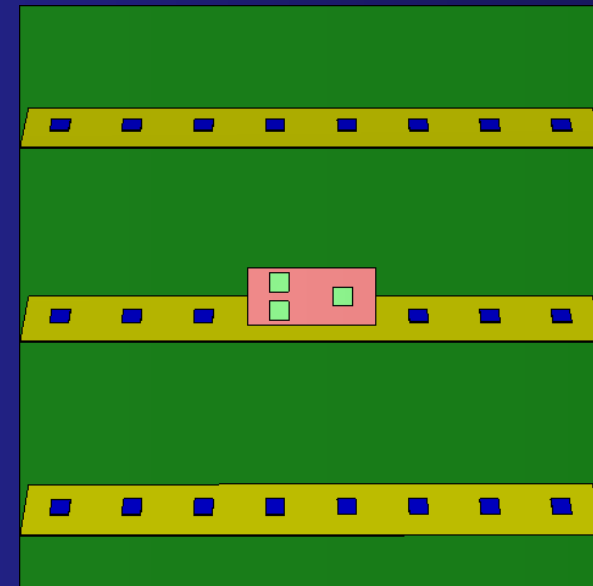
30/6/5/1



64/8/10/2



32/4/5/1



24/3/3/1

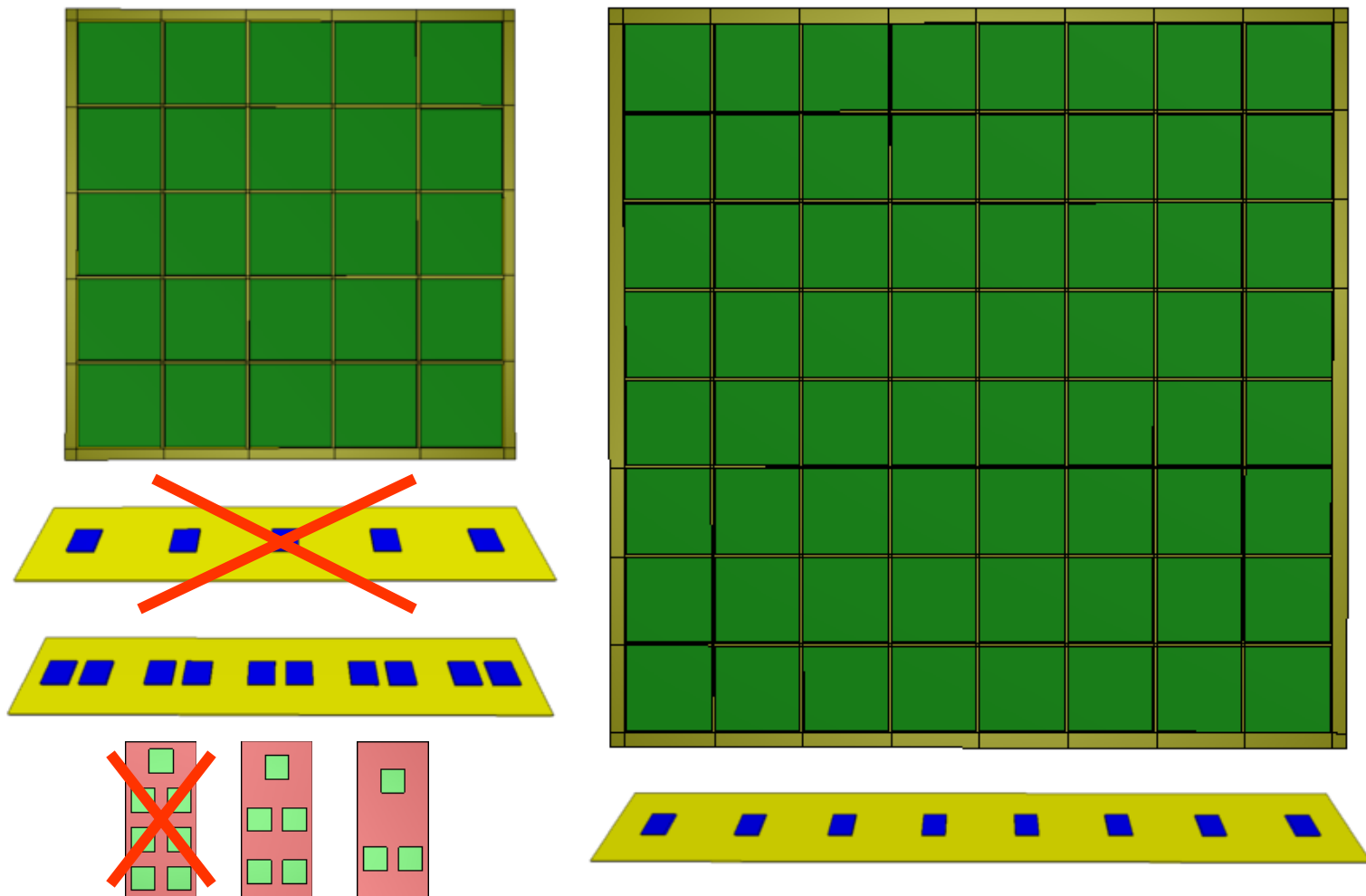
Next steps

TRD v17a

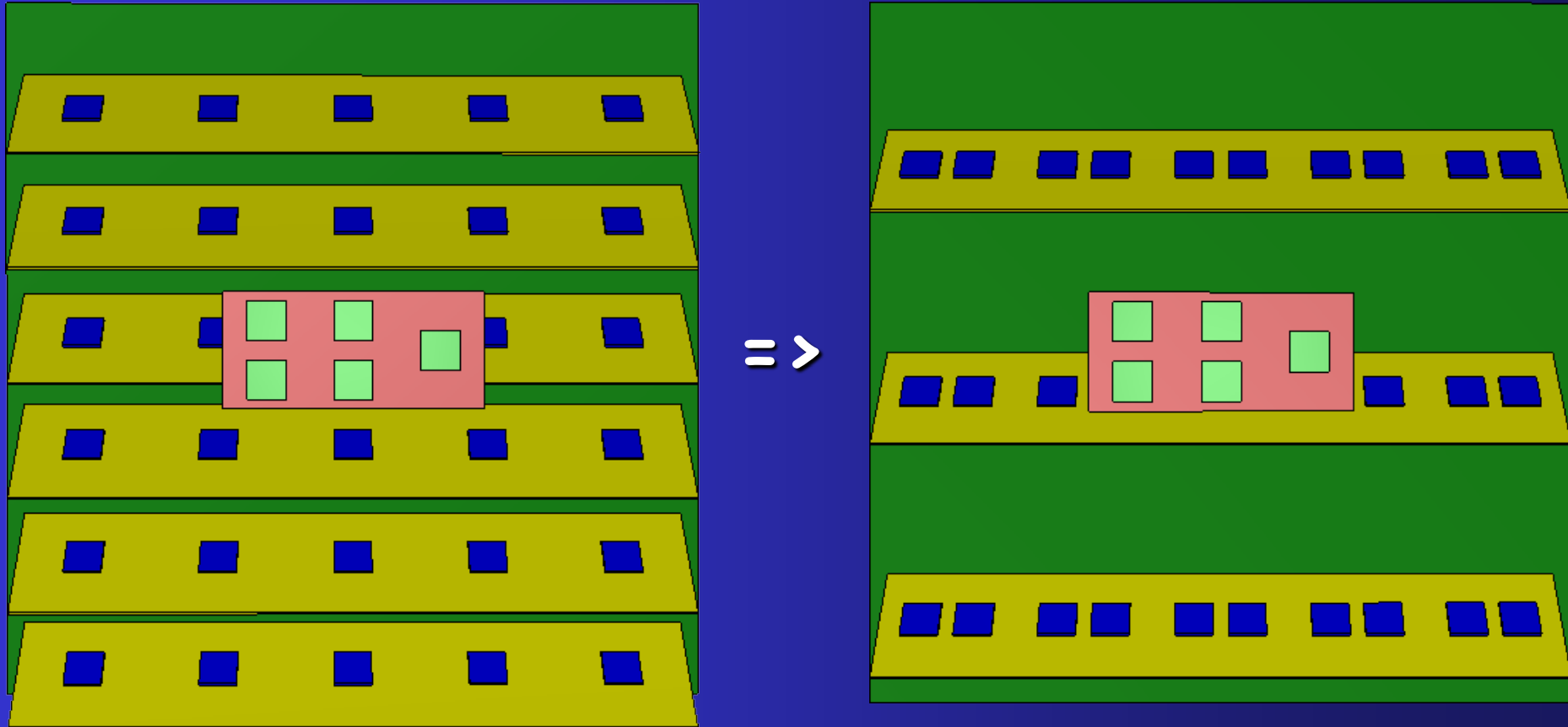
-

Reduction of FEB types

TRD v17a components

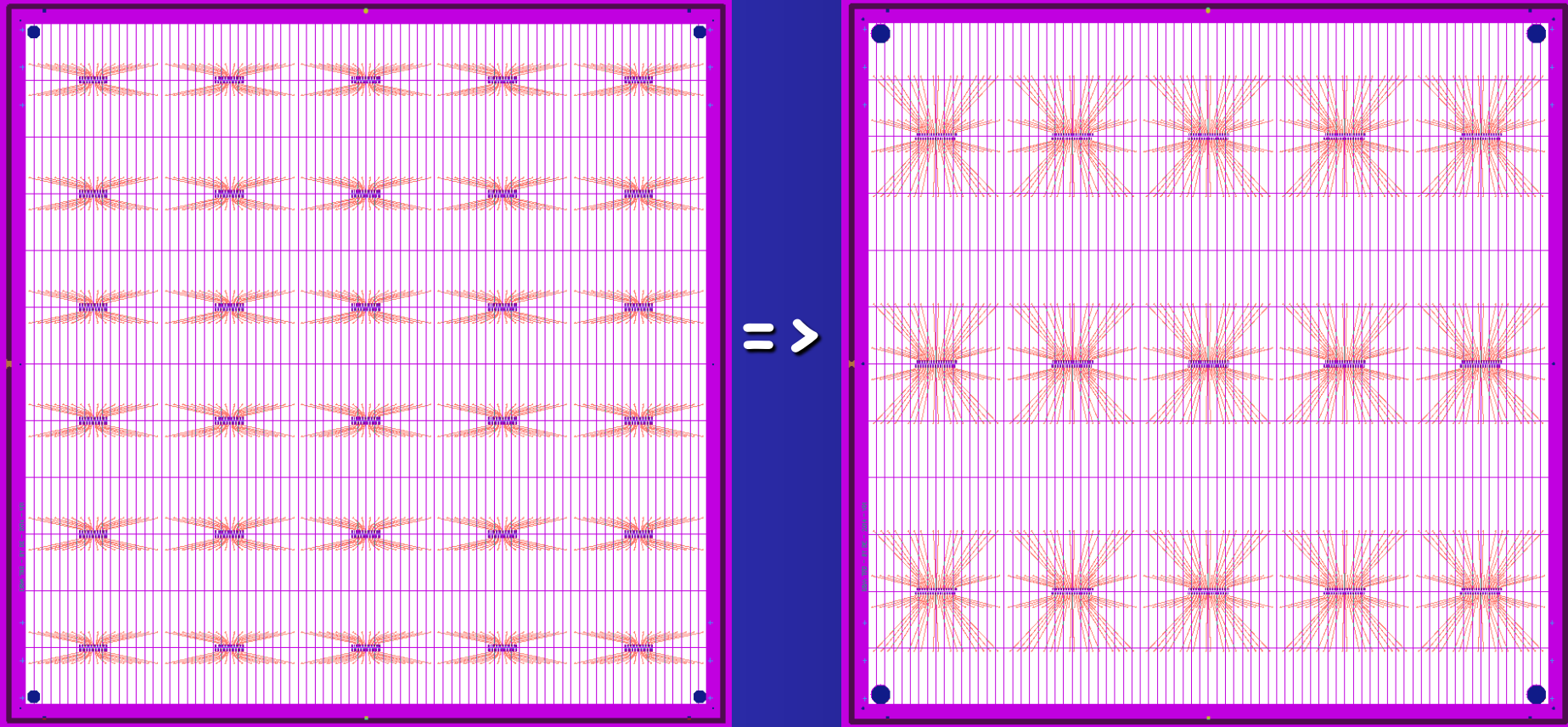


Type 3 v17a modification



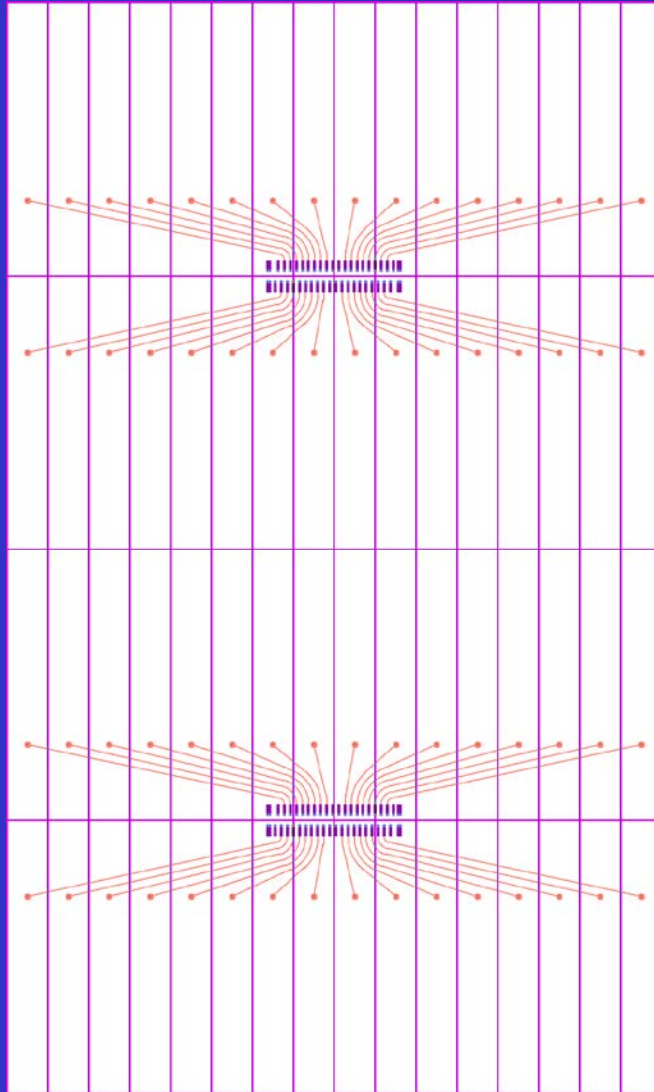
Replace FEB 5x1 which only occurs on module type 3 by FEB 5x2
To reduce FEB diversity.

Pad plane type 3 v17a

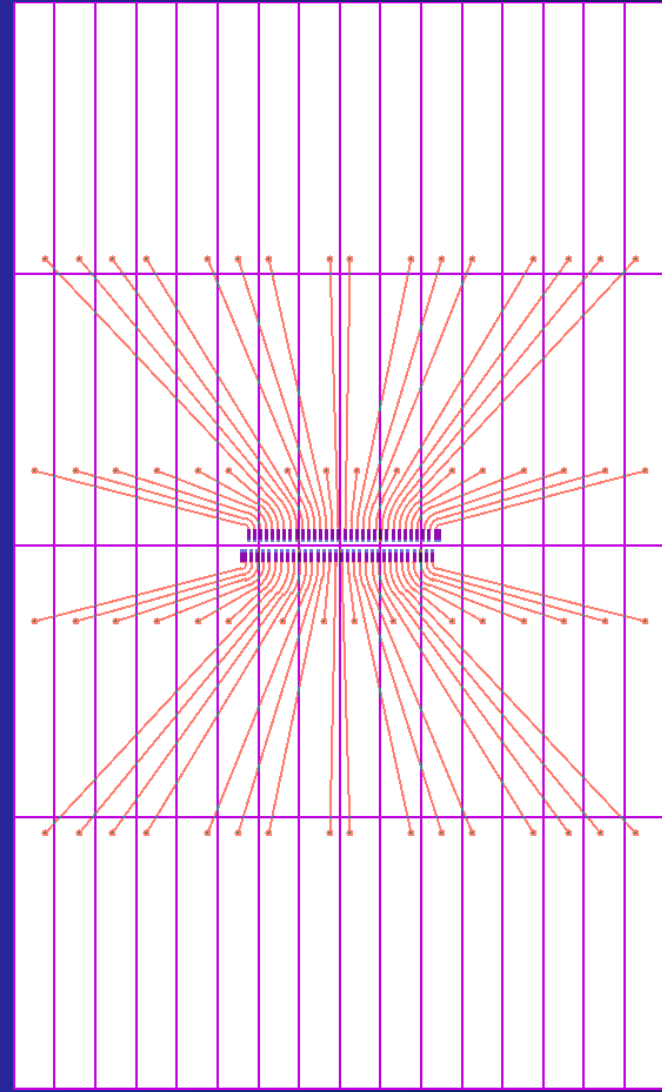


Instead of 2, read 4 rows per connector. This leads to longer wire traces on the pad plane, larger capacity and slight noise increase.
It saves 1 FEB type.

Type 3 v17a pad block



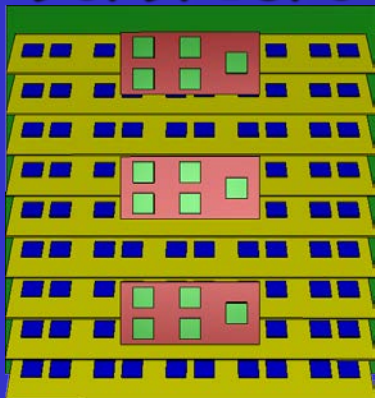
=>



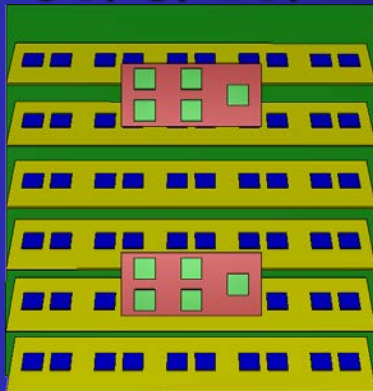
TRD geometry v17a



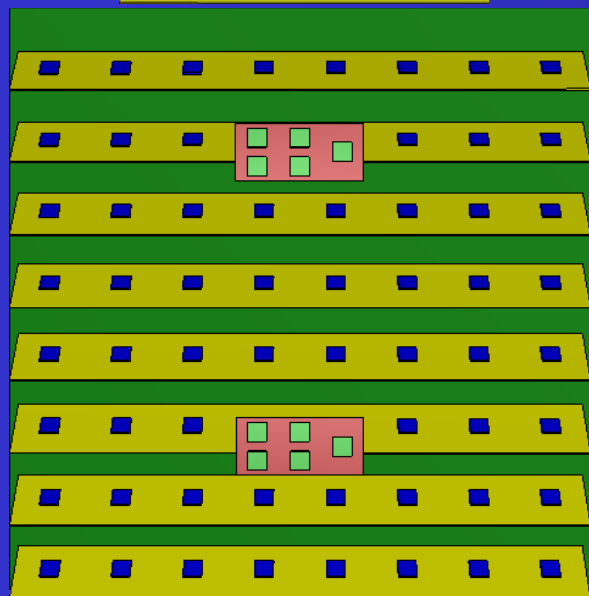
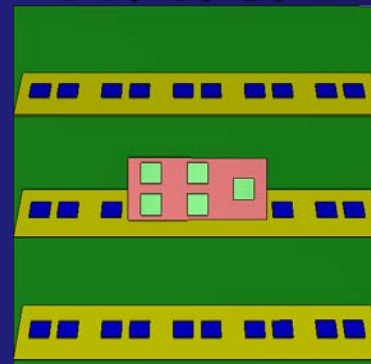
90/9/15/3



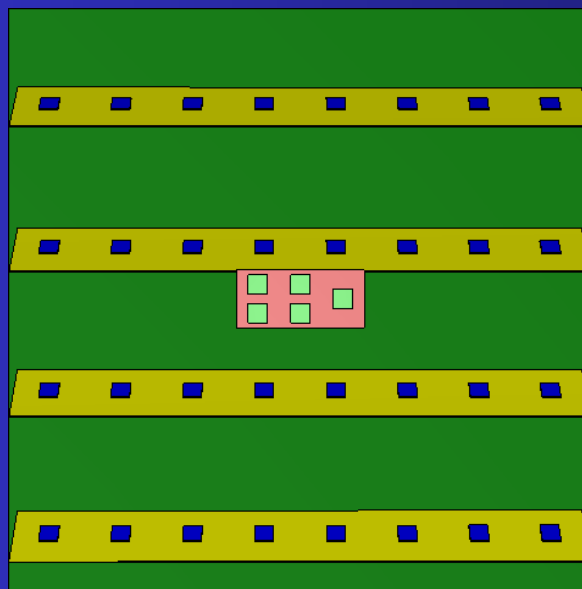
60/6/10/2



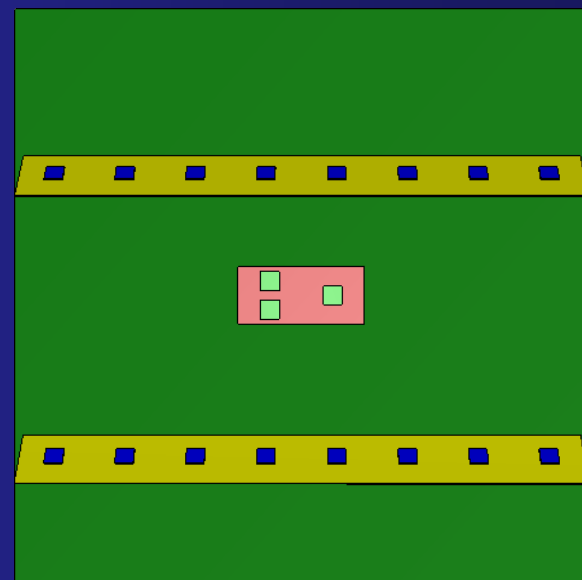
30/3/5/1



64/8/10/2



32/4/5/1



16/2/3/1

GBTx readout

GBTx ROBs for TRD



**FrontEnd
Board (FEB)**
8 STS-XYTER
ASICs

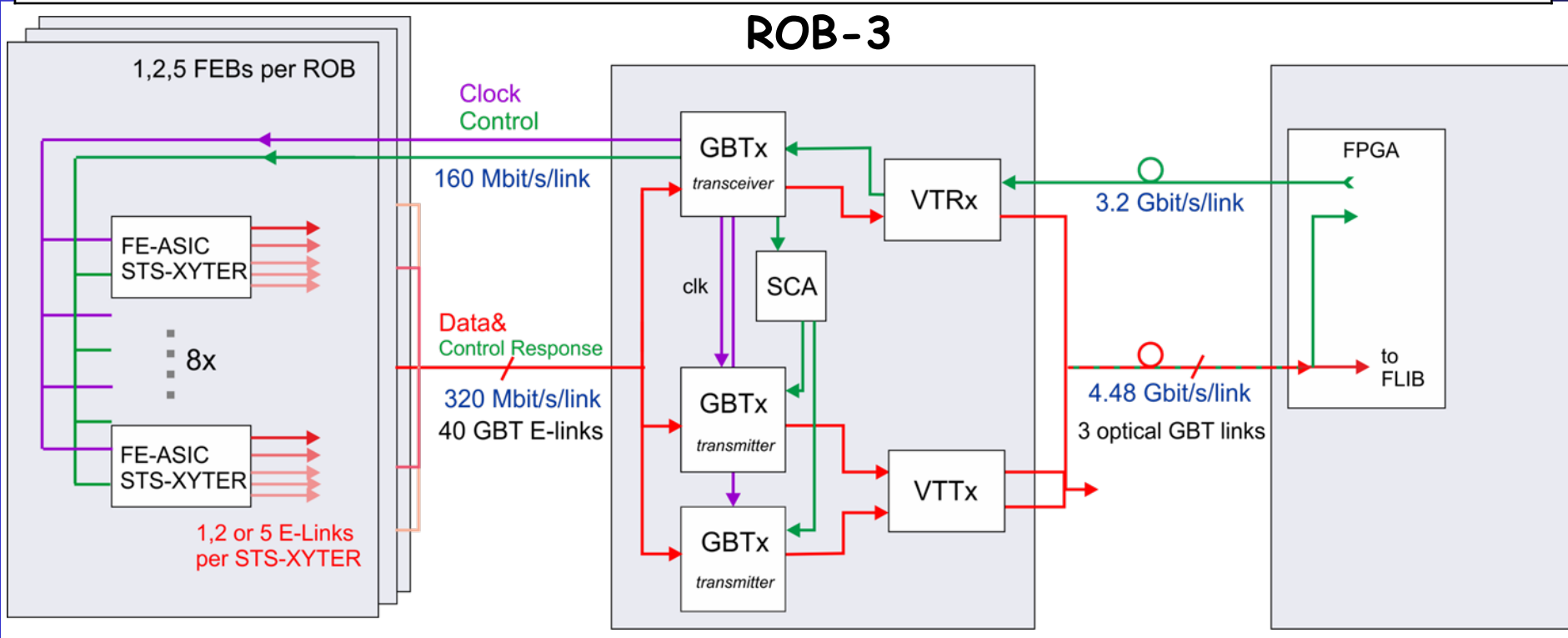
Electrical
Interface
10-42 SLVS
pairs/FEB

**ReadOut Board
(ROB)**
CERN GBTx &
Versatile Link

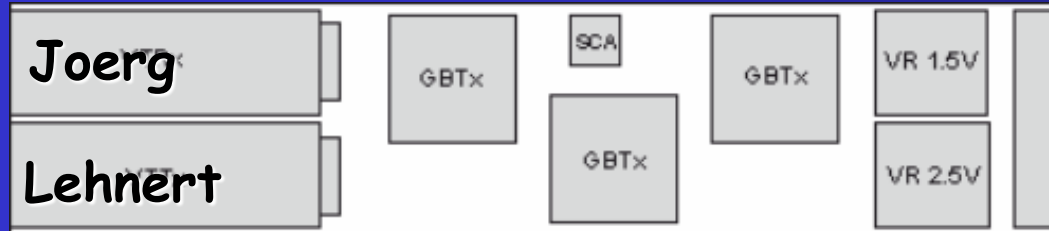
Optical
Interface
4 MM fibers per
ROB

**Data
Processing
Board
(DPB)**

ROB-3

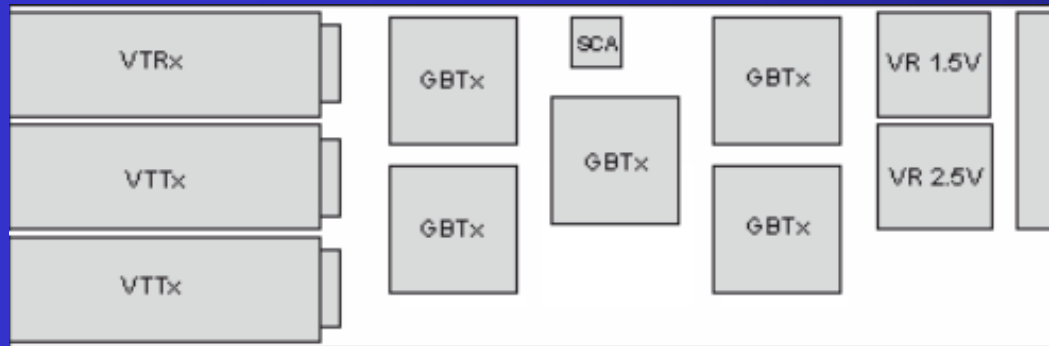


GBTx ROBs for TRD



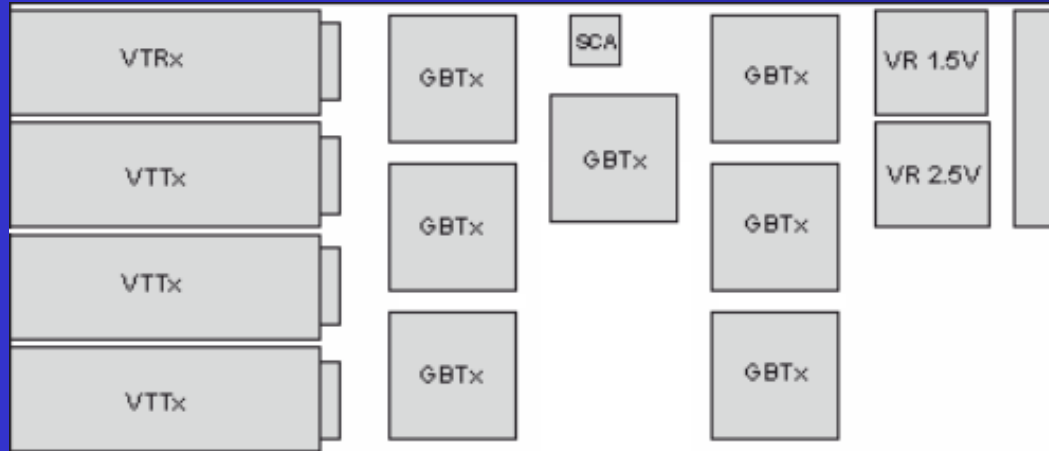
GBTx ROB-3
42 e-ports

550
CHF
183/ch



GBTx ROB-5
70 e-ports

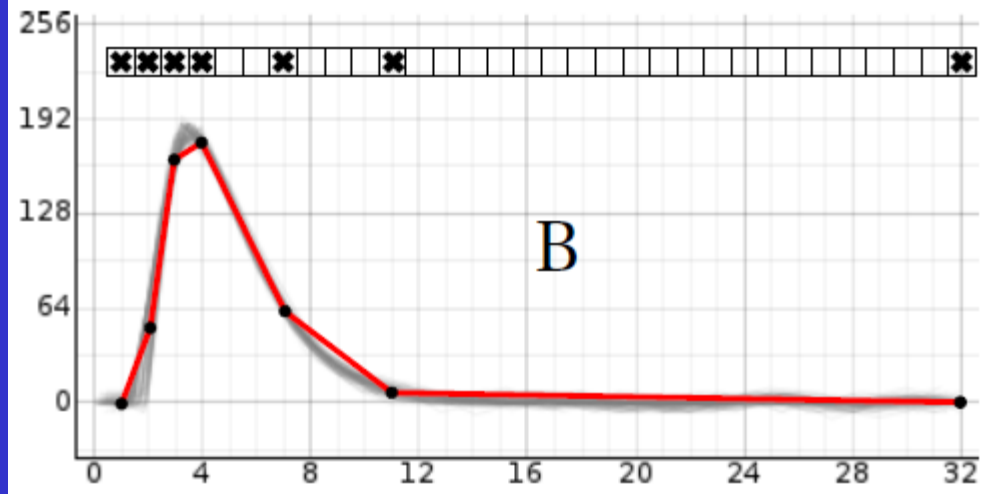
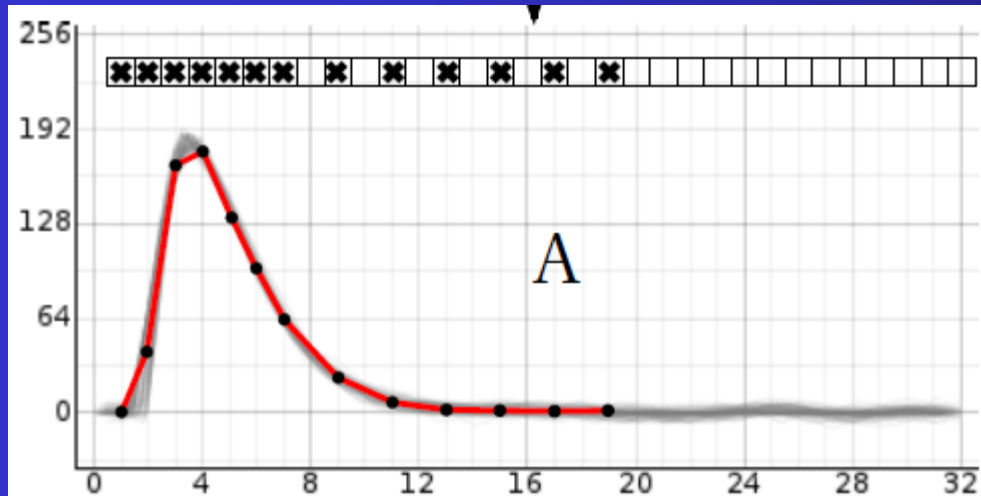
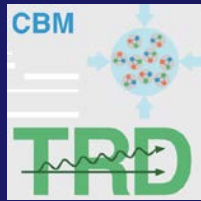
840
CHF
168/ch



GBTx ROB-7
98 e-ports

1130
CHF
161/ch

Spadic sample selection



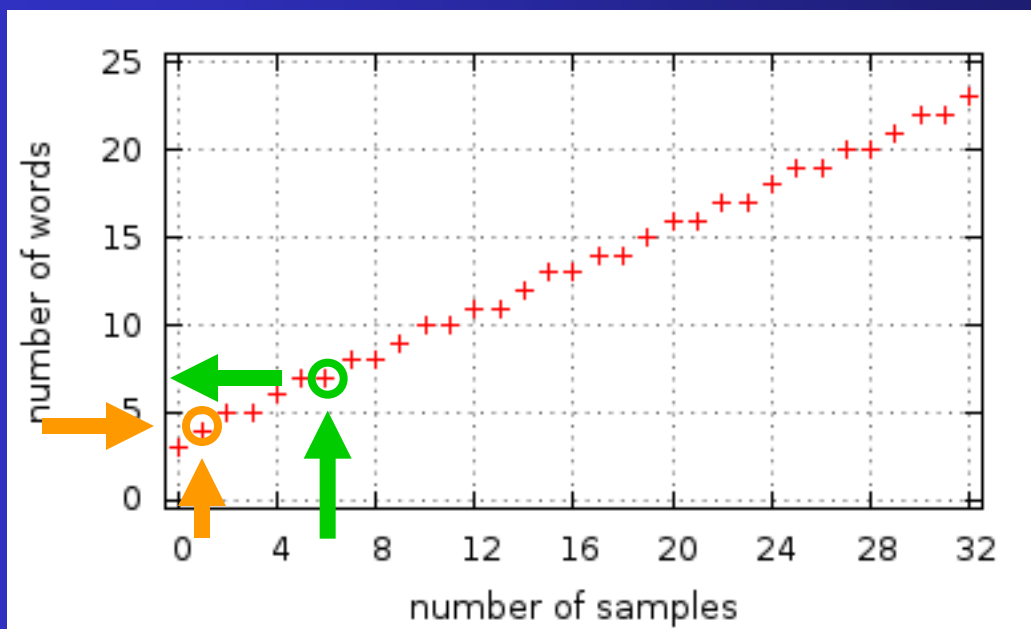
Current baseline:
select 6 samples
per hit:

- 2x pre-samples
- 2x max amplitude
- 2x late baseline

Extreme case:
Select only 1 sample

- 1x max amplitude

Spadic message size



6 time samples per hit
=> 7 words per hit
=> 112 bit per message

@ 100k hits/s/ch

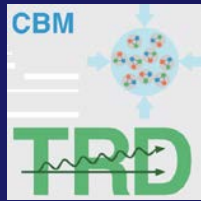
=> 11,2 Mbps/ch

=> 358,4 Mbps/32 ch ASIC

1 time sample per hit
=> 4 words per hit
=> 64 bit per message

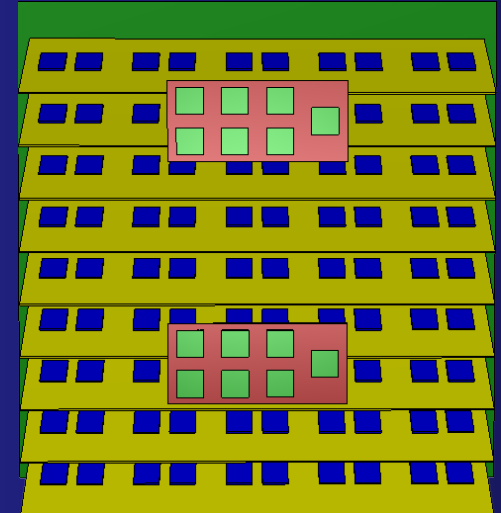
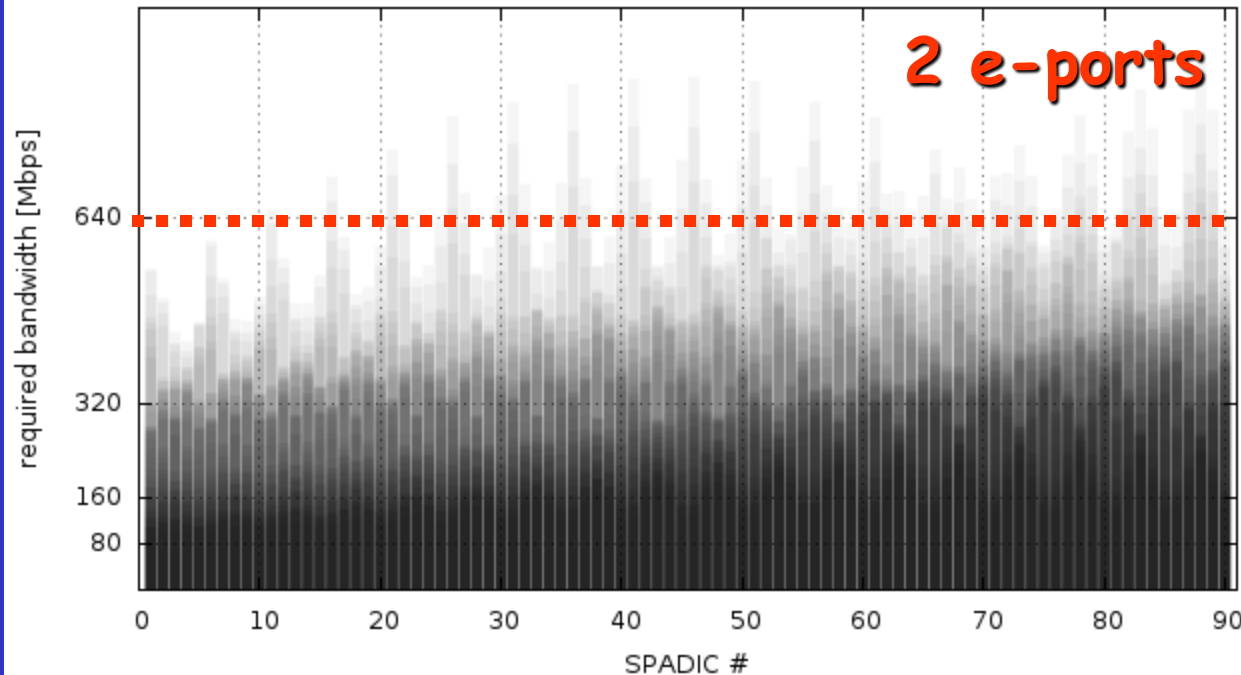
ignoring 83% (5/6) of bins
saves 43% (4/7) bandwidth

Module type 1 data rate



Michael Krieger

S1 (48)



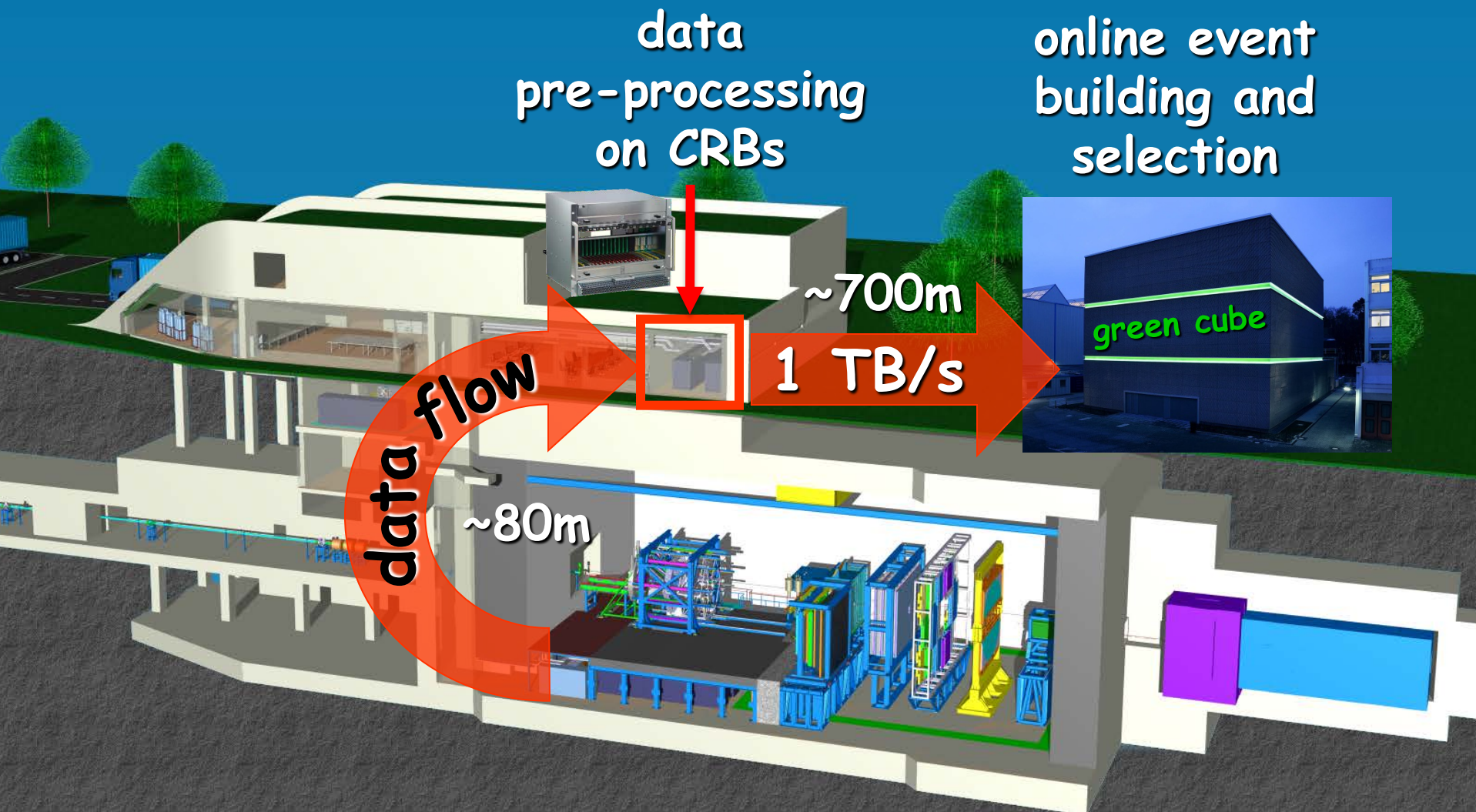
90 Spadics a 2 e-ports = 180 e-ports

2x GBTx ROB 7 = 2x 7x 14 = 196 e-ports

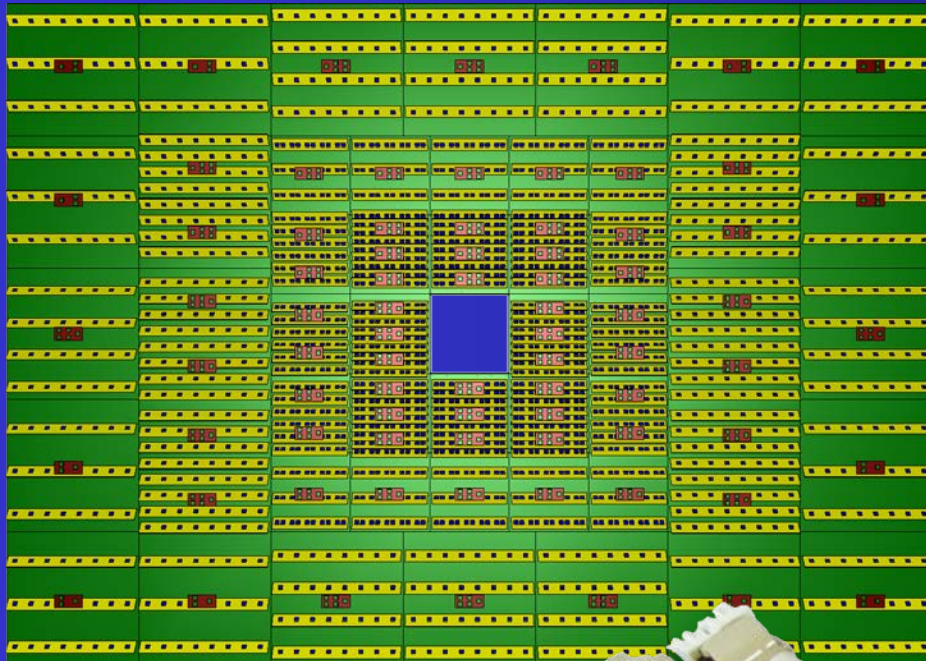
usage
92%

Readout

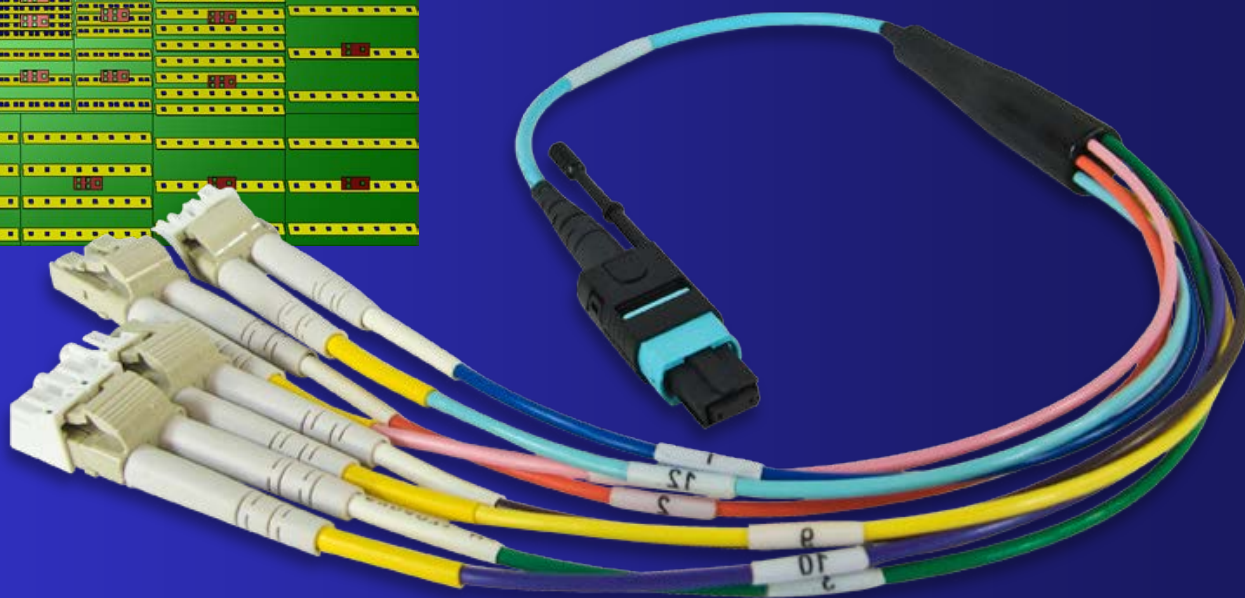
CBM DAQ System



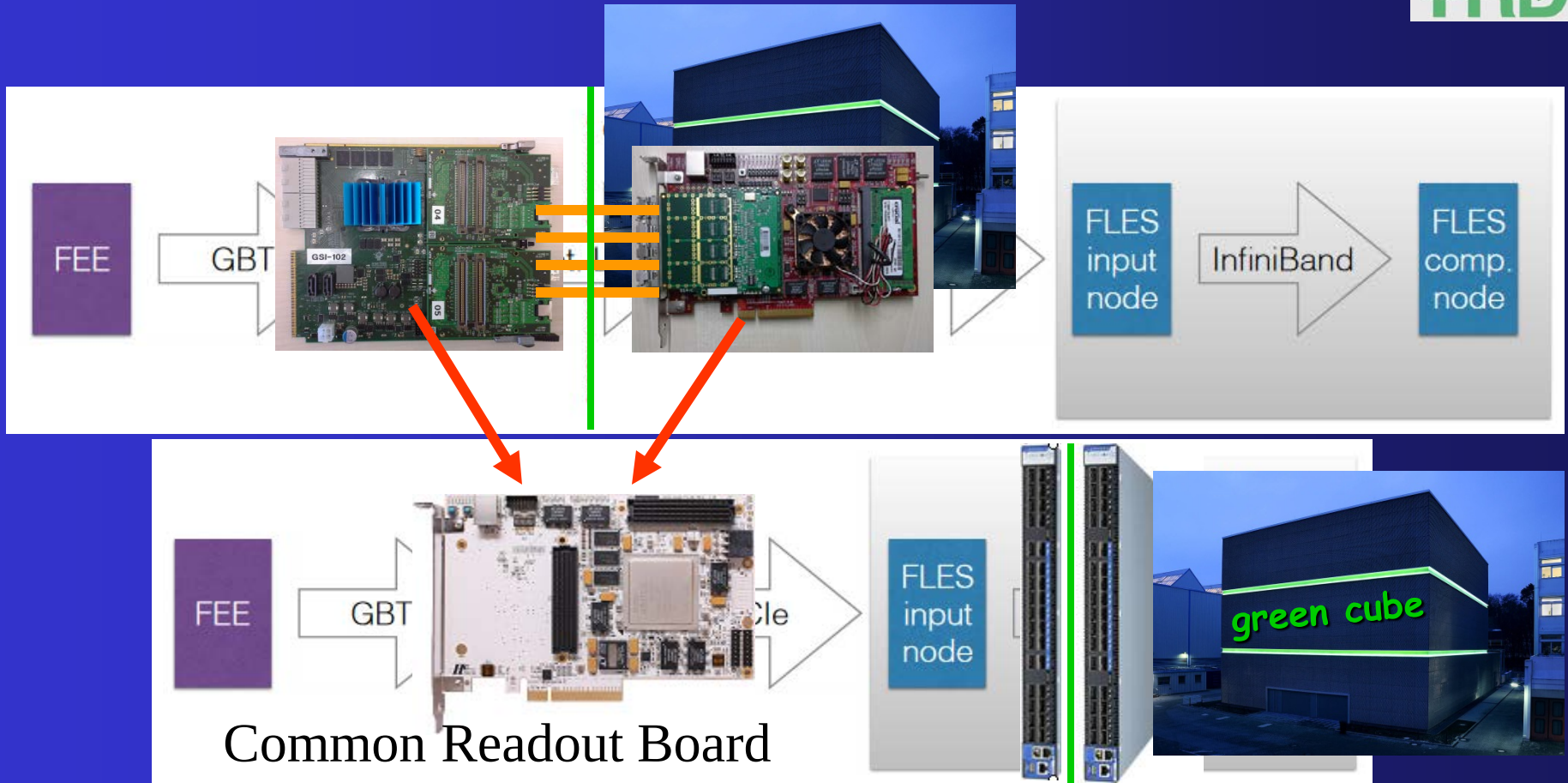
Detector - DAQ interface



For subsystems with GBTx readout the DAQ system begins where the optical readout fibres are plugged into the ROBs



CRB readout chain



FW blocks developed for the DPB and FLIB layer could end up in a single CRB. This setup would offer extra benefits, e.g. COTS components, local CBM FLES cluster for standalone commissioning

Readout Boards

VTR_x  

VTT_x  

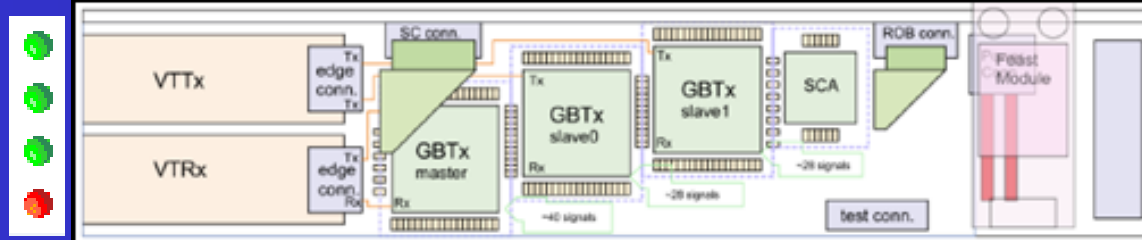
ROB-3    

(STS)

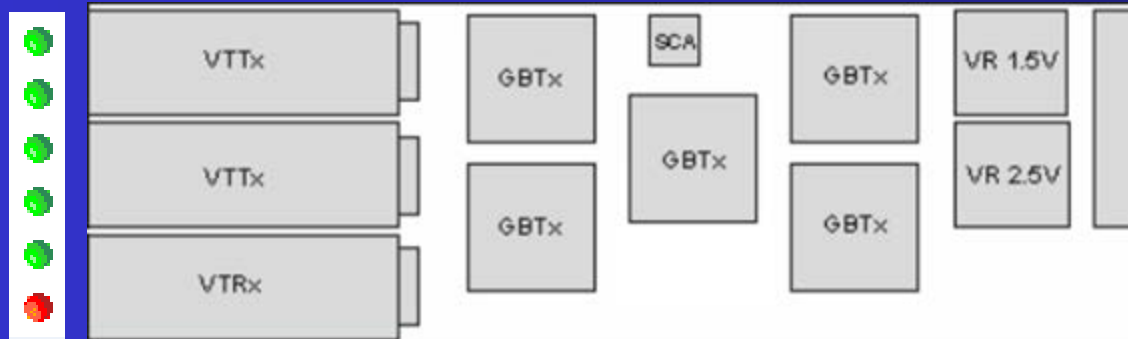
ROB-5      

(TRD)

A ROB-3 will interface to 3 MGTs on the DPB.

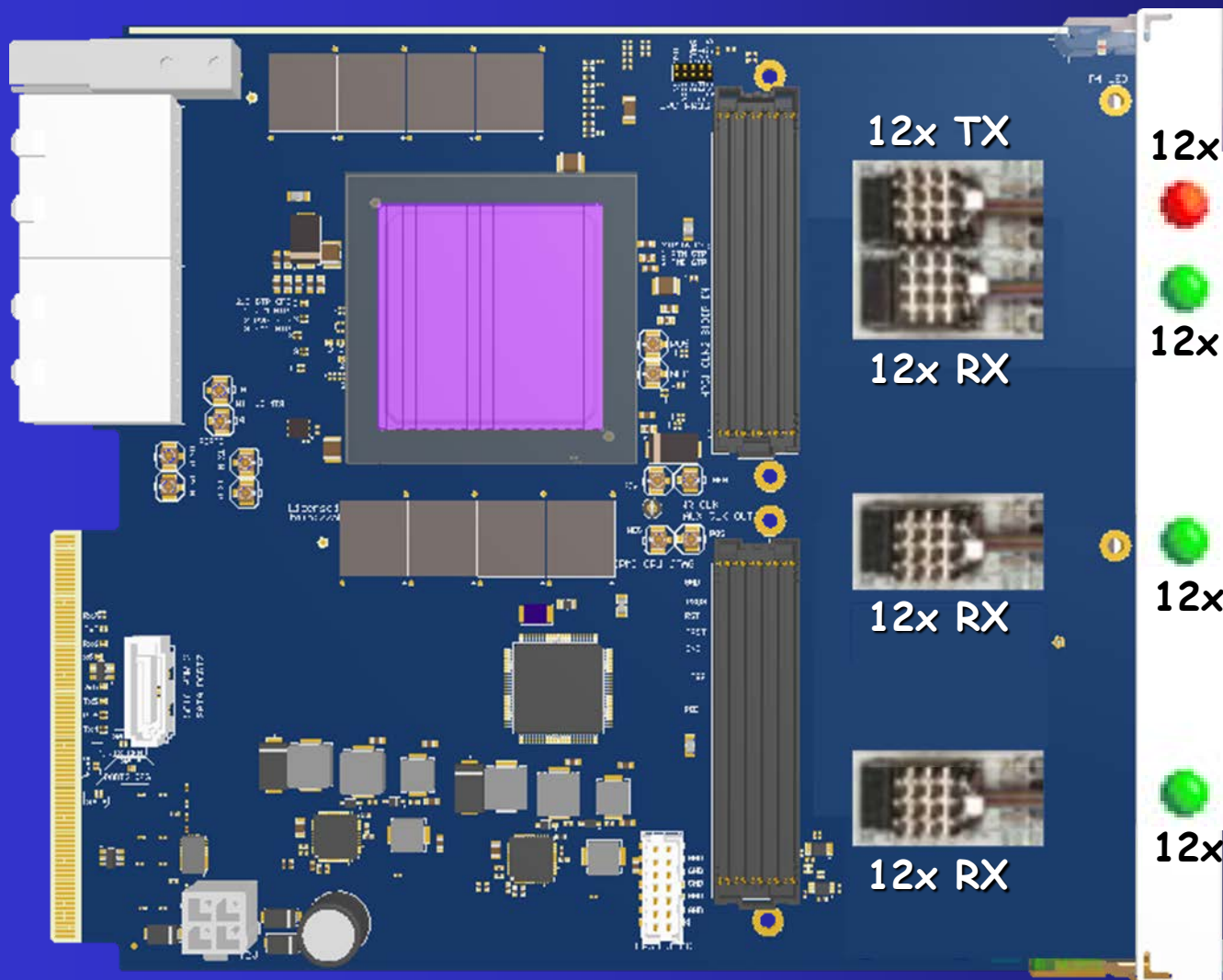


GBTx ROB-3
42 e-ports



GBTx ROB-5
70 e-ports

A possible DPB successor



prototype DPB successor

A possible DPB successor PCIe

12x TX

12x RX

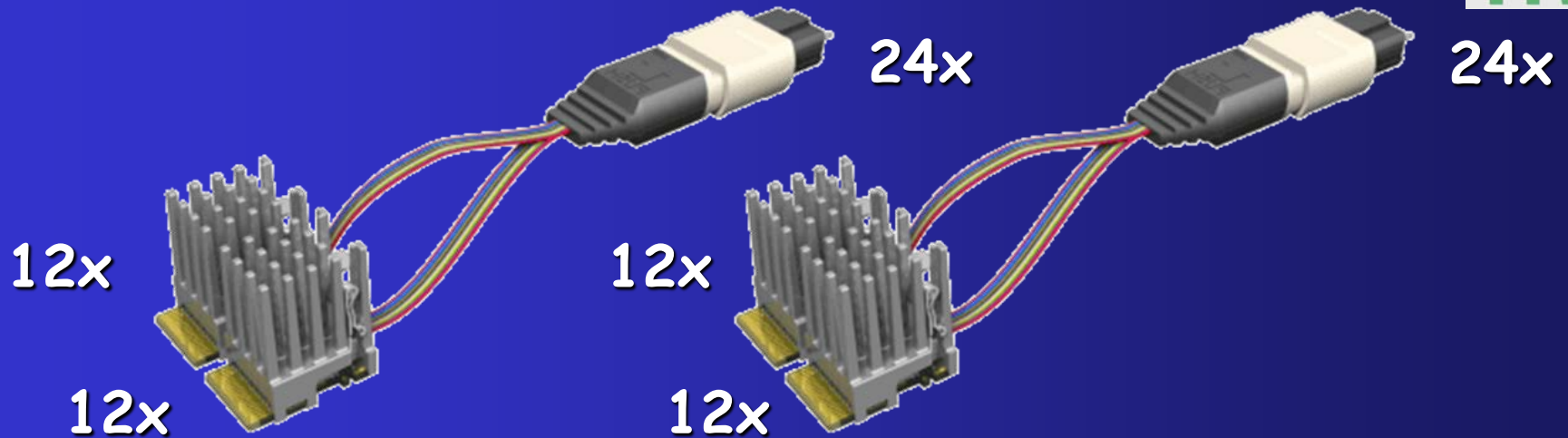
12x RX

12x RX

HTG K816 with ZRAY FireFly adapter
And Kintex Ultrascale FPGA
commercially available



Distribution of links to DPB

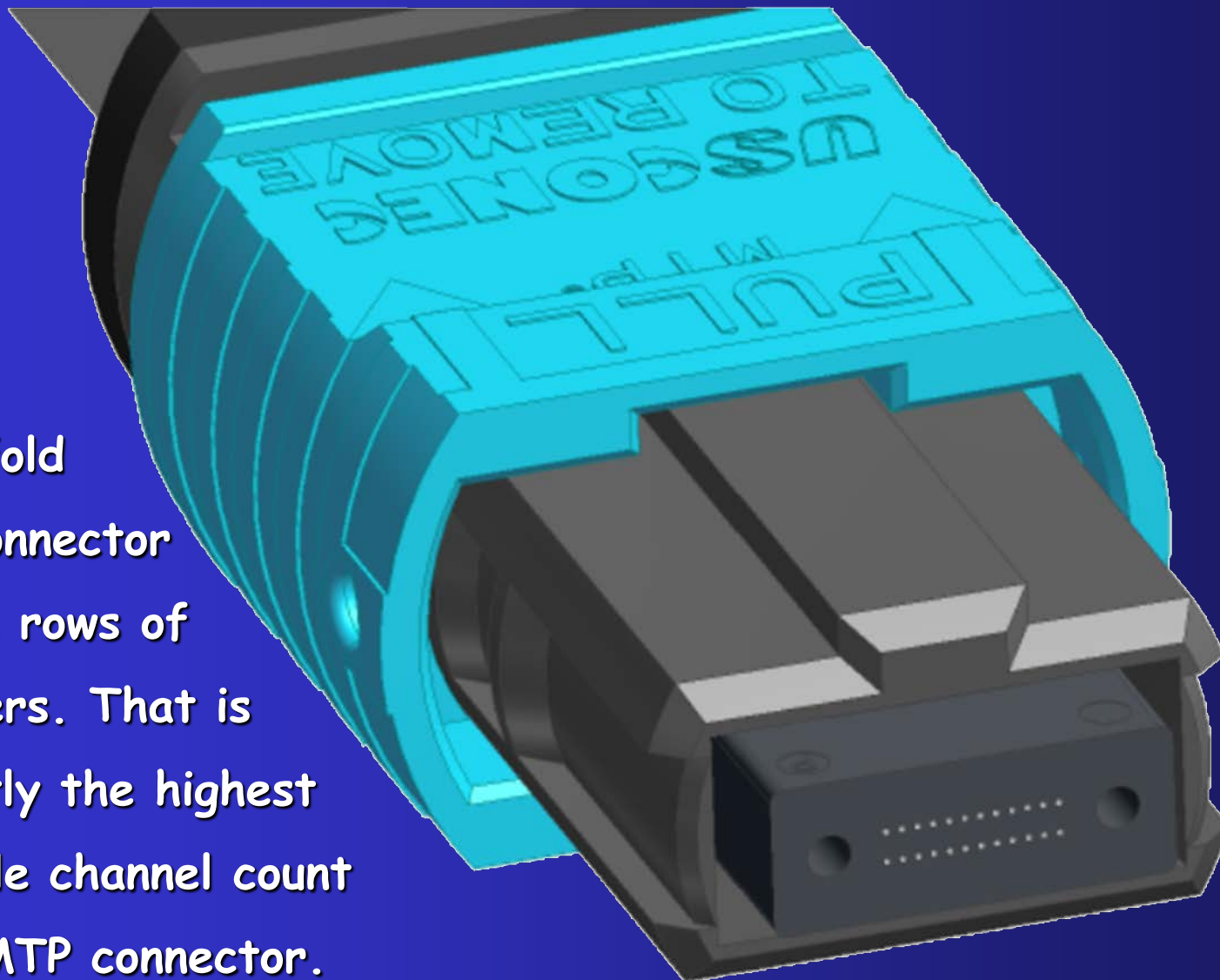


TX												
RX												
RX												
RX												

On the AFCK+ the optical connections will be grouped in 12x down- and 3x 12x uplinks.

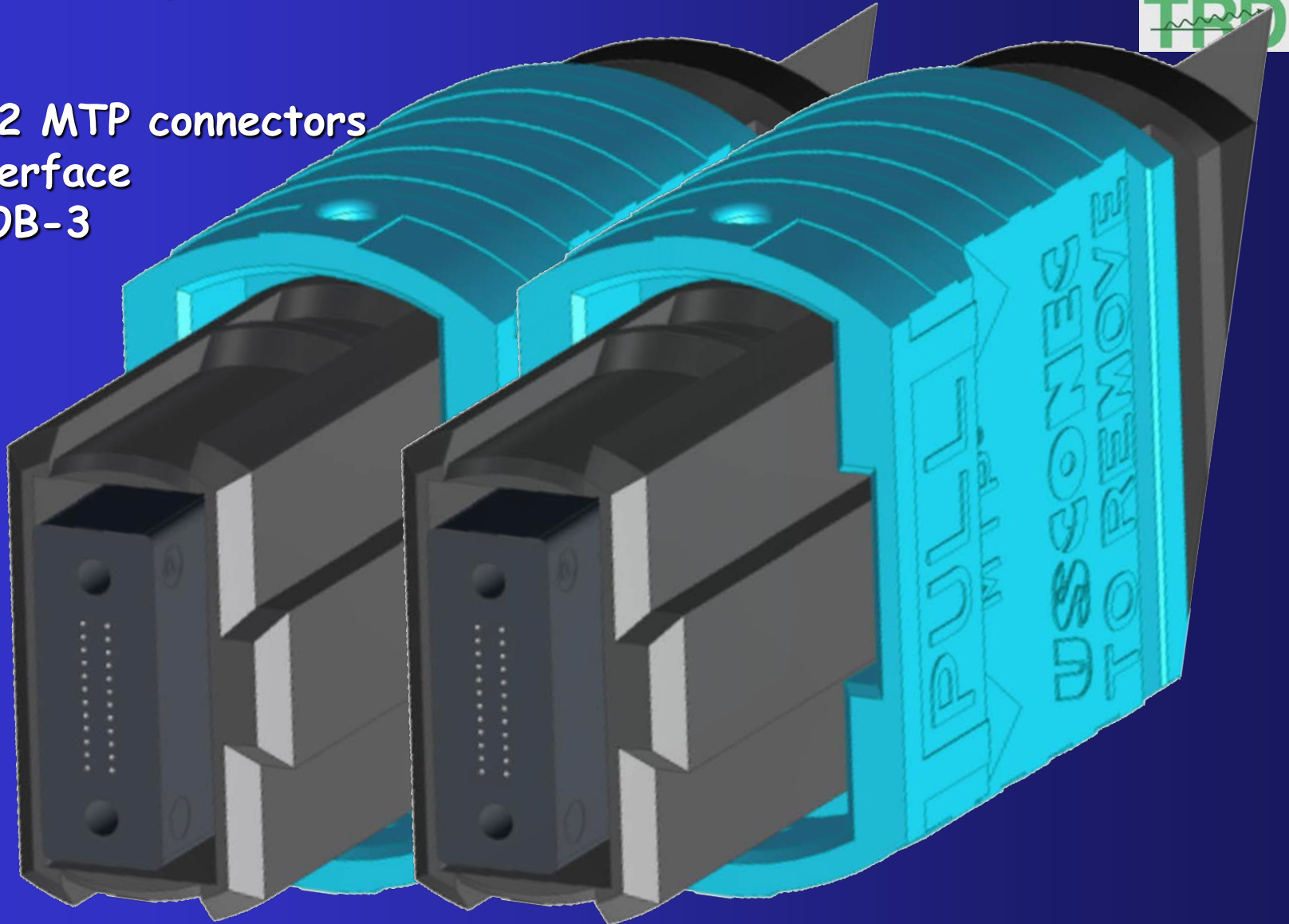
MTP connector

A 24-fold
MTP connector
holds 2 rows of
12 fibers. That is
currently the highest
available channel count
for a MTP connector.

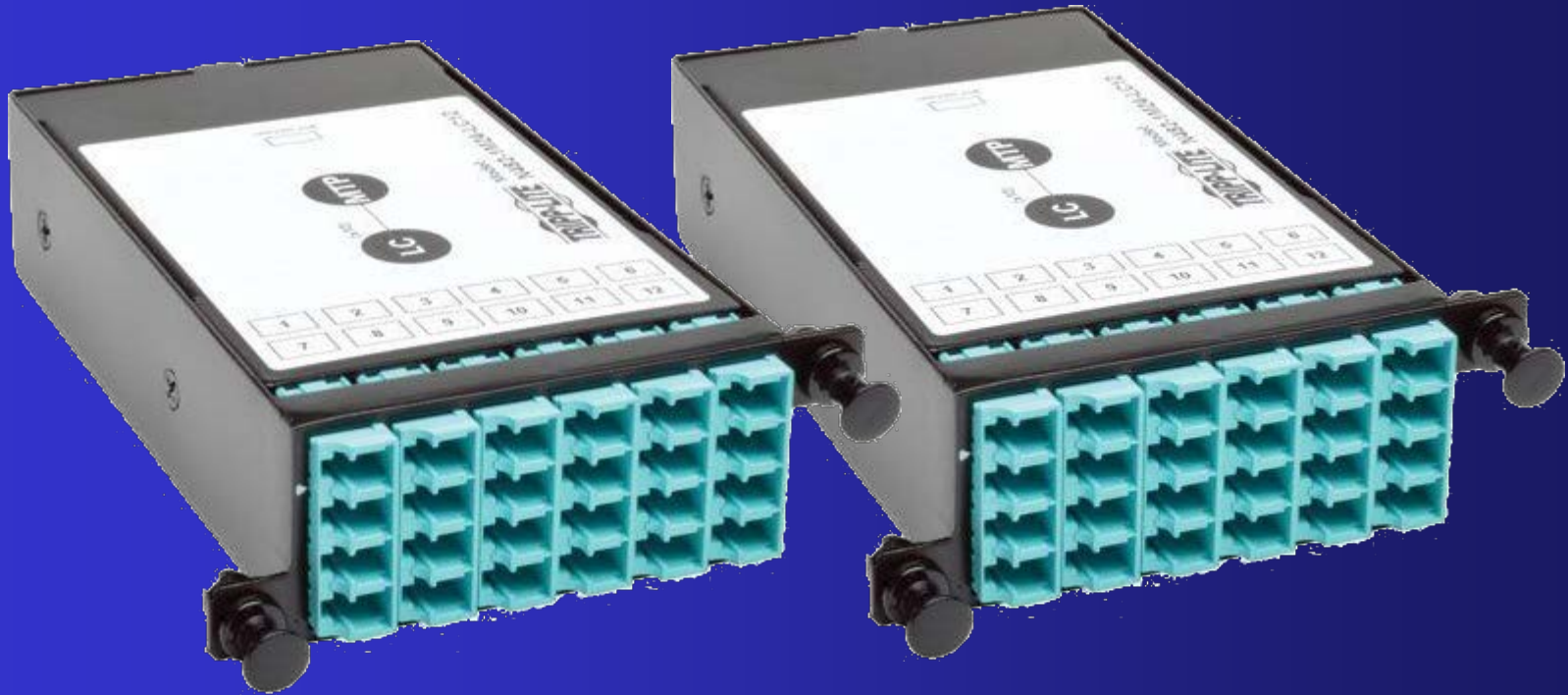


2x 24-fold MTP connectors

These 2 MTP connectors
can interface
12x ROB-3



48x LC - 2x MTP Patchboxes



Patch boxes with 12x LC quad connectors can serve as DAQ interface for the TRD. They interface the LC-LC patch fibers from several modules to the 24-fold MTP fibers to the DPB.

Grouping of ROBs on the PP



ROB-3 01	●	●	●	●
ROB-3 02	●	●	●	●
ROB-3 03	●	●	●	●
ROB-3 04	●	●	●	●
ROB-3 05	●	●	●	●
ROB-3 06	●	●	●	●
ROB-3 07	●	●	●	●
ROB-3 08	●	●	●	●
ROB-3 09	●	●	●	●
ROB-3 10	●	●	●	●
ROB-3 11	●	●	●	●
ROB-3 12	●	●	●	●

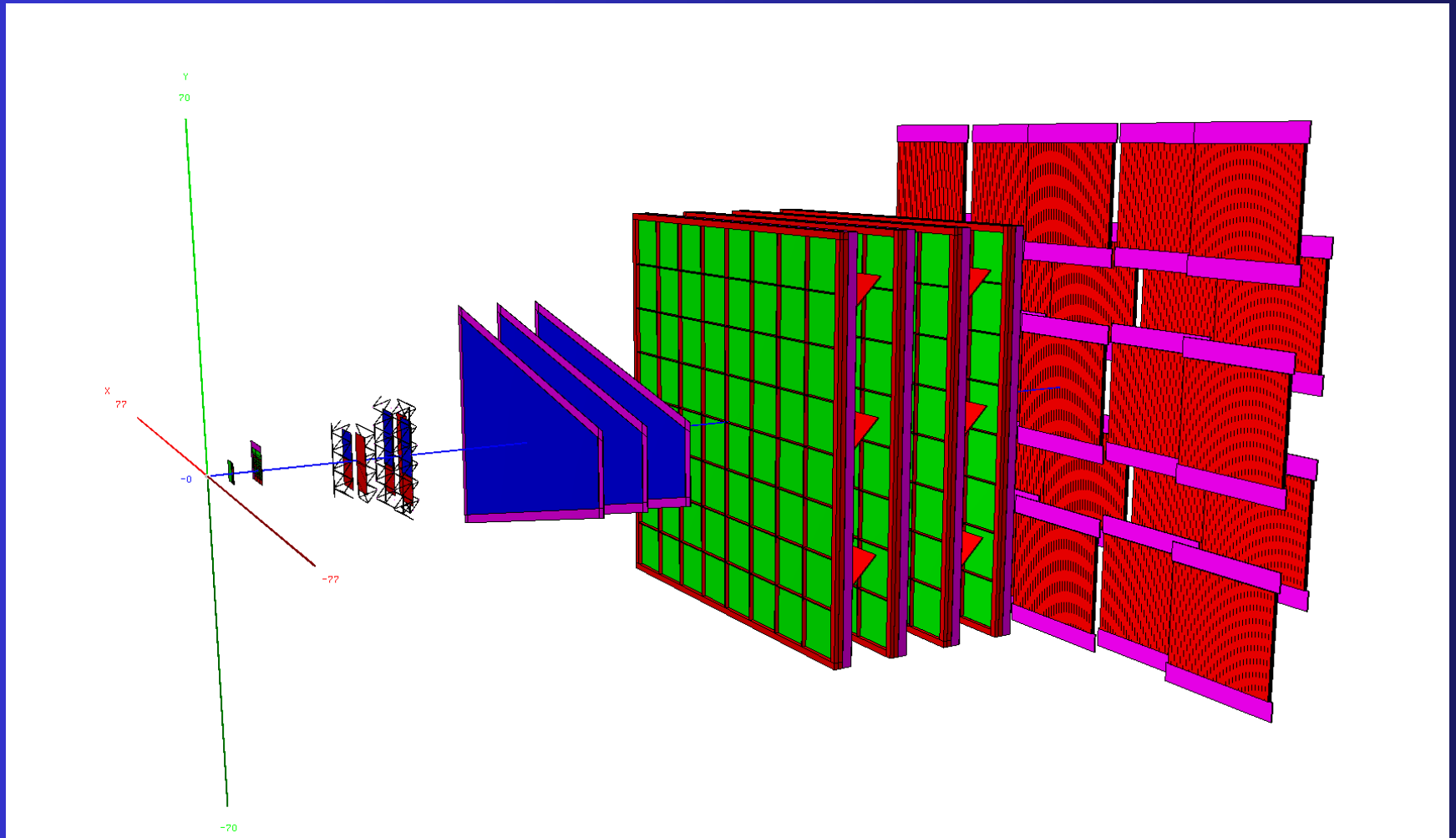
ROB-5 01	●	●	●	●
ROB-5 02		●	●	/●
ROB-5 03	●	●	●	●
ROB-5 04	●	●	/●	●
ROB-5 05		●	●	●/
ROB-5 06	●	●	●	●
ROB-5 07		●	●	/●
ROB-5 08	●	●	●	●
ROB-5 09	●	●	/●	●
ROB-5 10		●	●	●/
ROB-5 11	●	●	●	●
ROB-5 12		●	●	

ROB-7 01	●	●	●	●
ROB-7 02		●	●	●
ROB-7 03	●	●	/●	●
ROB-7 04		●	●	●
ROB-7 05	●	●	●	/●
ROB-7 06		●	●	●
ROB-7 07		●	●	●/
ROB-7 08	●	●	●	●
ROB-7 09		●	●	●
ROB-7 10	●	●	/●	●
ROB-7 11		●	●	●
ROB-7 12		●	●	

97% uplink efficiency for ROB-5 and ROB-7 topology.

miniCBM

miniCBM@SIS18



97% uplink efficiency for ROB-5 and ROB-7 topology.

mCBM DAQ chain



Build mCBM at GSI/SIS18 for a full system integration and commissioning test with high-rate A-A collisions 2018-21

Set-up with full size detector modules and read-out chain
Test and optimization of:

- performance of the detectors under experiment conditions
- free streaming data transport to FLES
- online reconstruction
- data analysis (offline)

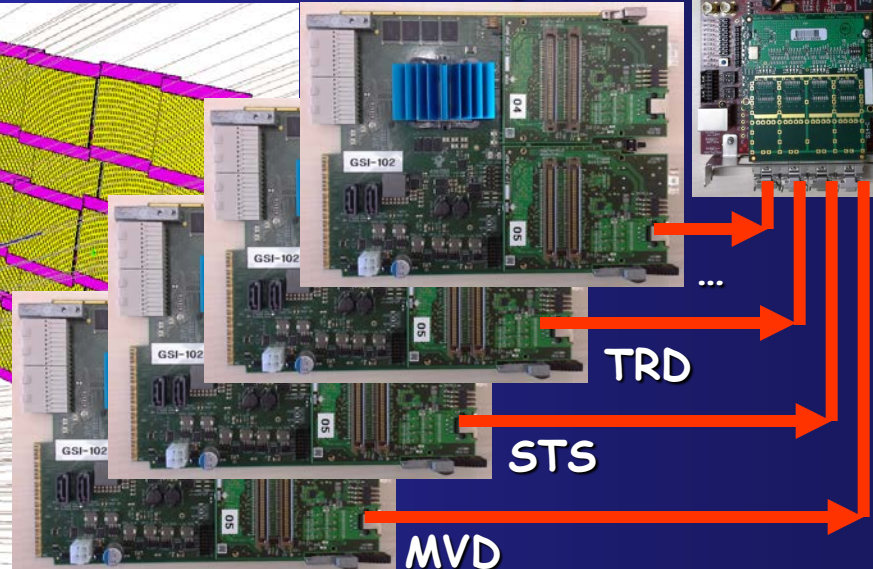
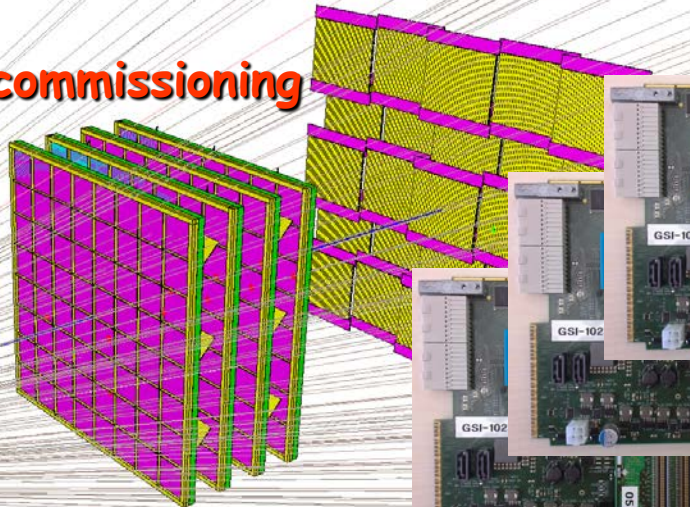


DPBs



Goals:

- Reduction of CBM commissioning time at SIS100
- Enforcement of CBM DAQ and SW development!



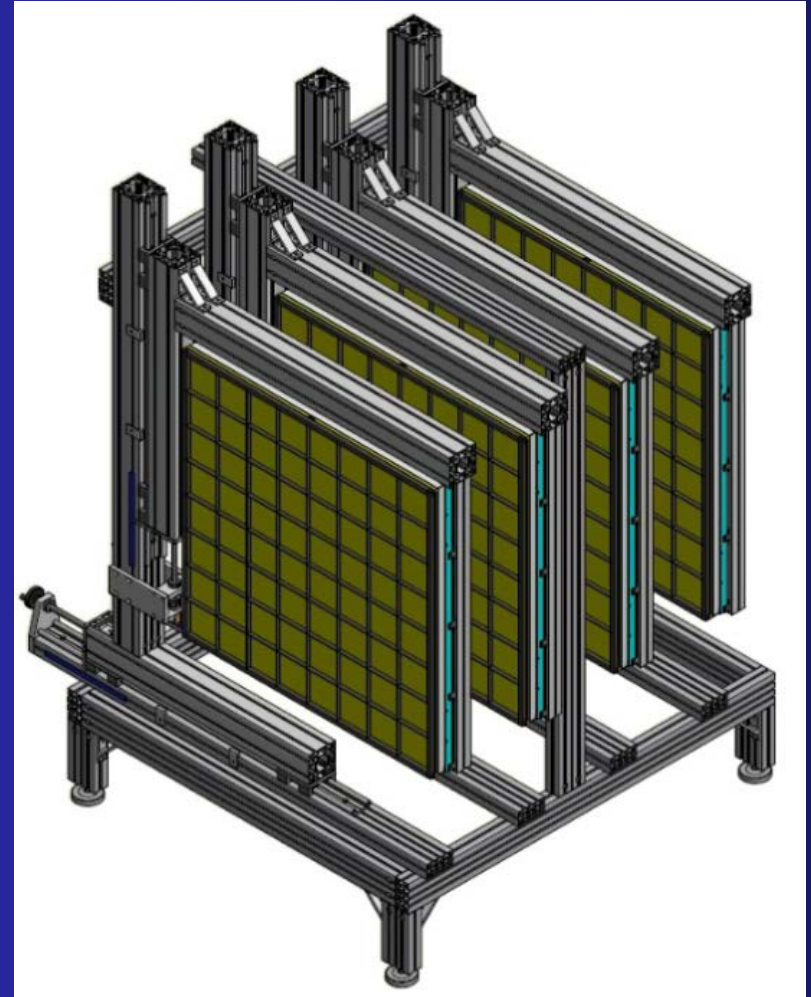
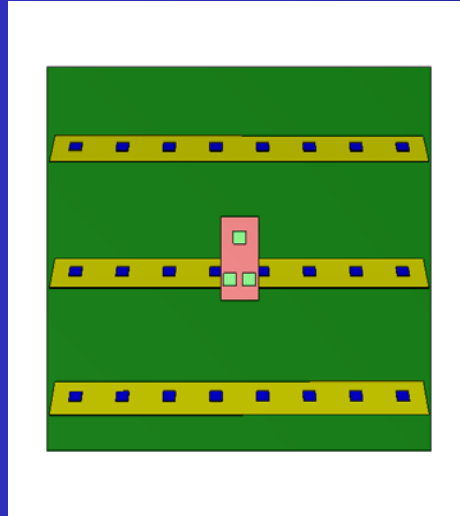
TRD contribution to mCBM



*Needed by
end of 2017*

Configuration:

- 4x TRD module type 8
- detectors are available now, need FEE
- each module equipped with 24x SPADIC v2.0 (96 in total)



Same DAQ requirements as STS.

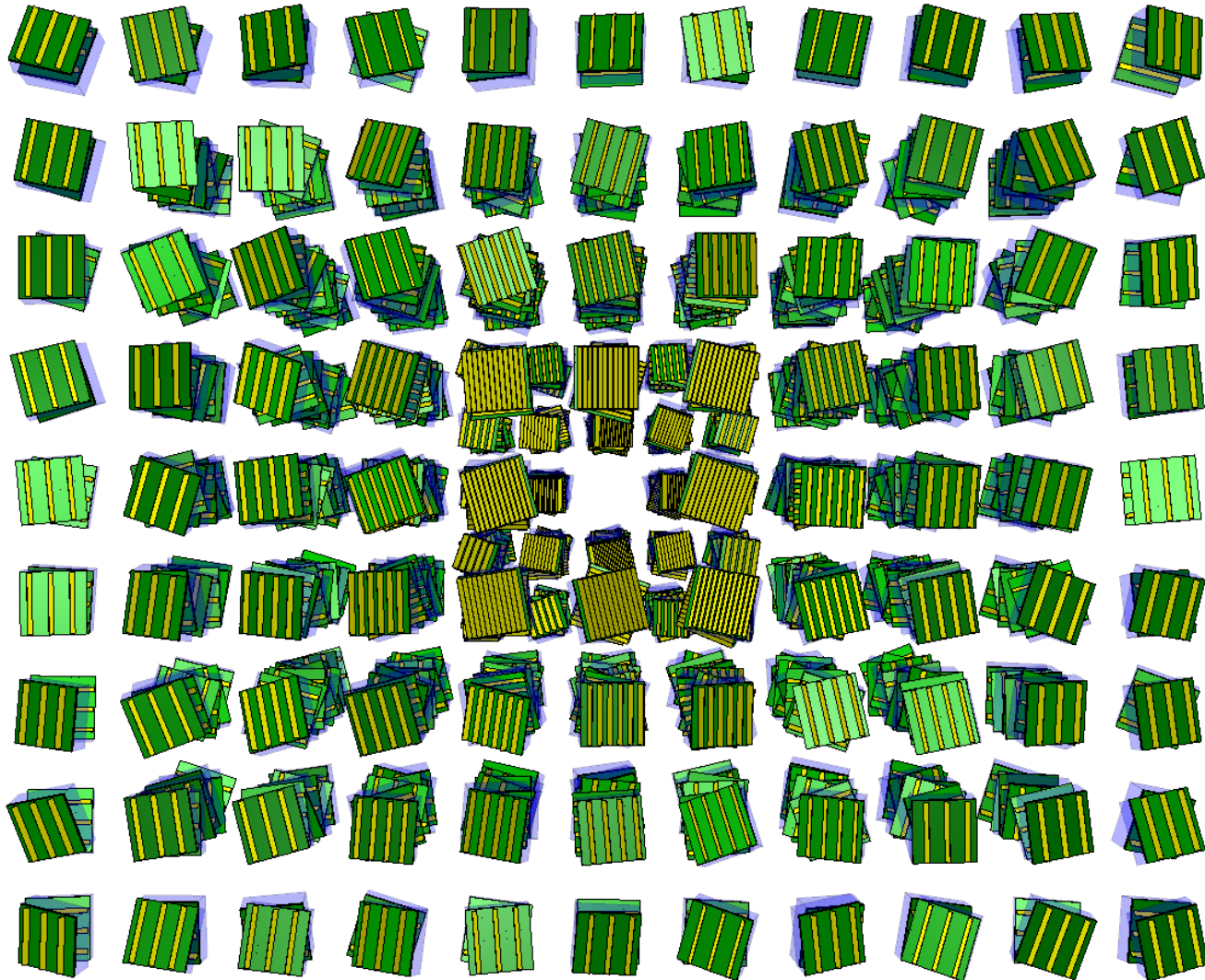
*Can simply leave TRD equipment
at GSI upon return from
SPS Xe-beamtest in Nov 2017.*

Summary

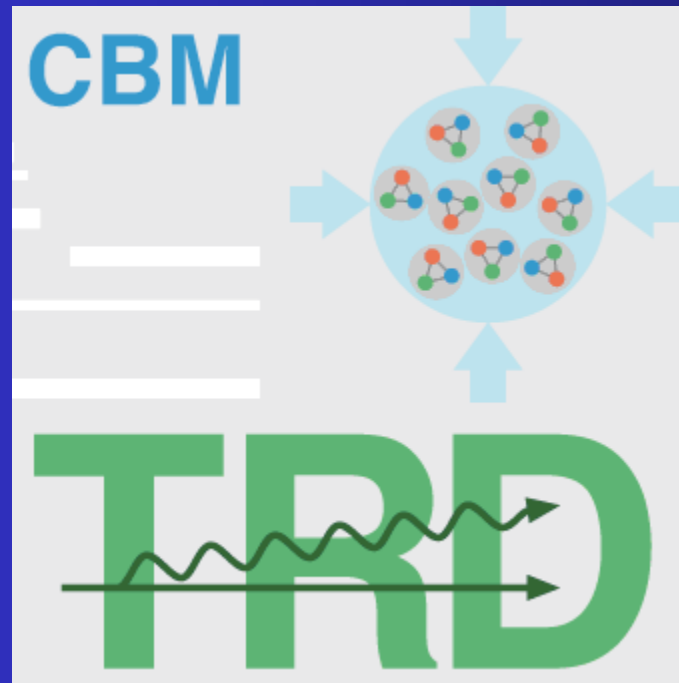


- we have an industrial PCB manufacturer for the production of large size TRD pad planes
- the pad plane layout of the TRD was optimised to a minimum number of 6 module types
- the connection of FEBs to ROB needs to be finalised
- there is a concept for the optical network from the detector to the DPB stage
- GBTX uplinks need to be used efficiently to save cost in the DPB stage
- TRD will be part of the miniCBM commissioning test setup at GSI

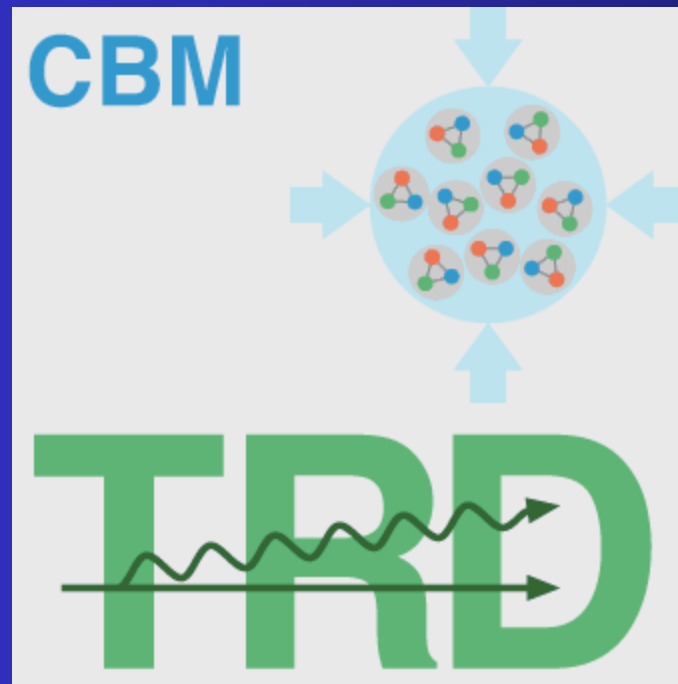
Thank you



Thank you



Thank you



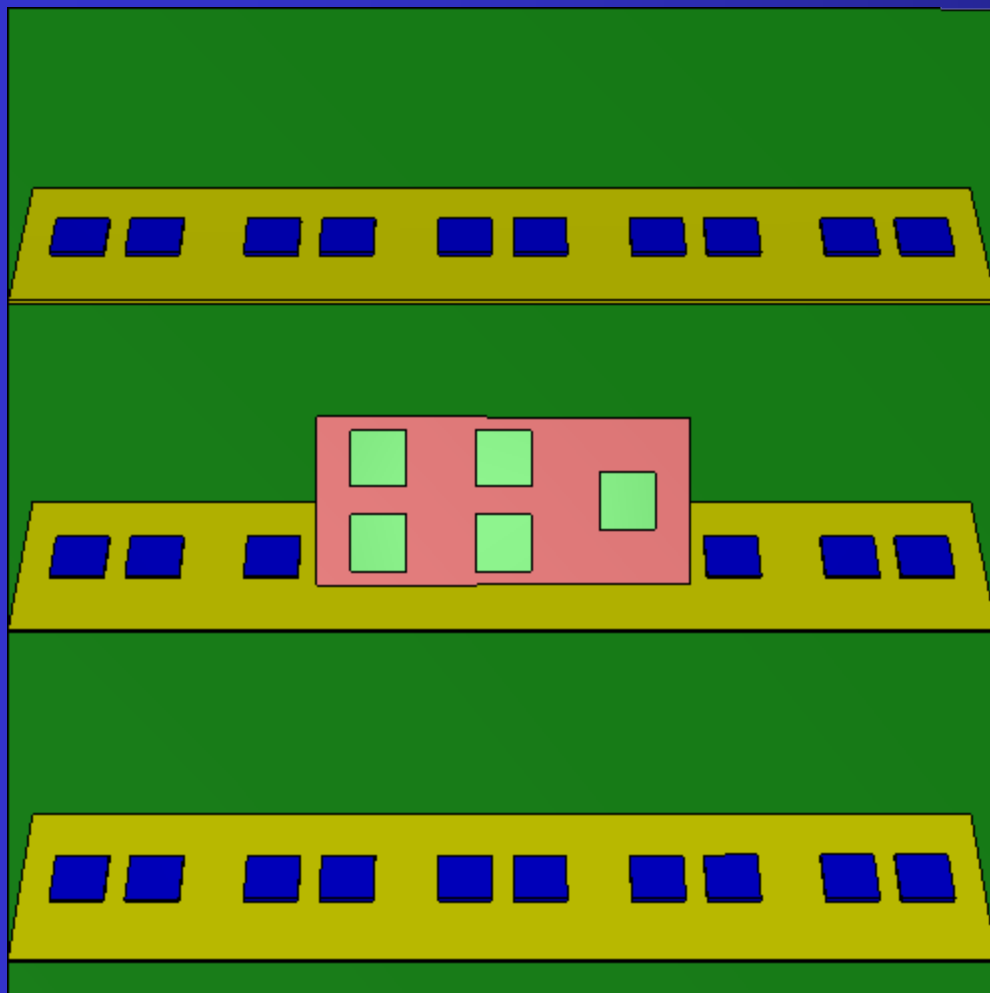
Backup

Material to show at the Collaboration Meeting

Reduction of ROB types

Data rate distribution

ROB-5 small module readout

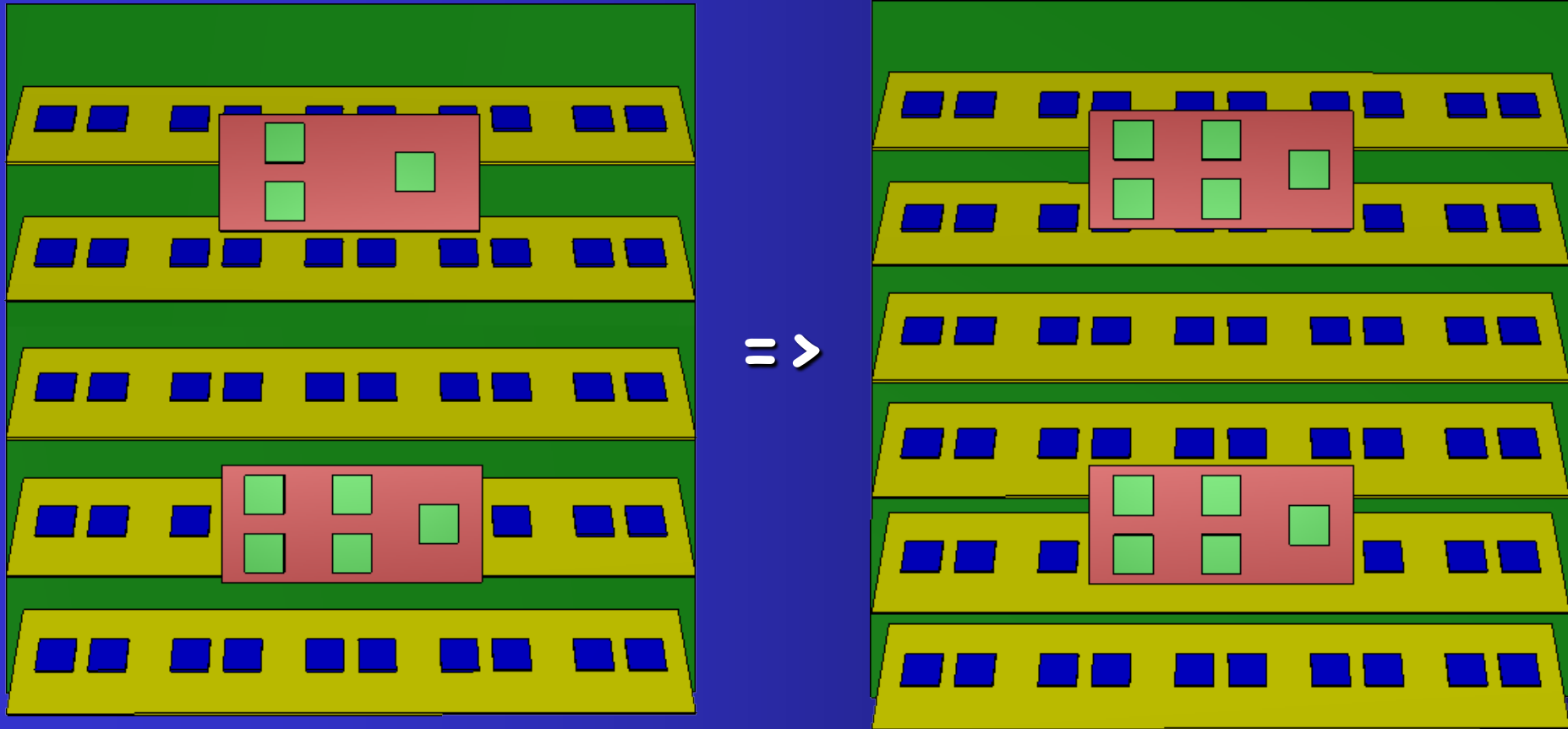


Use 3x FEB-5x2
and 1x ROB-5
as default element
of small TRD readout.

Identical FEB-ROB
interface
on all small modules.

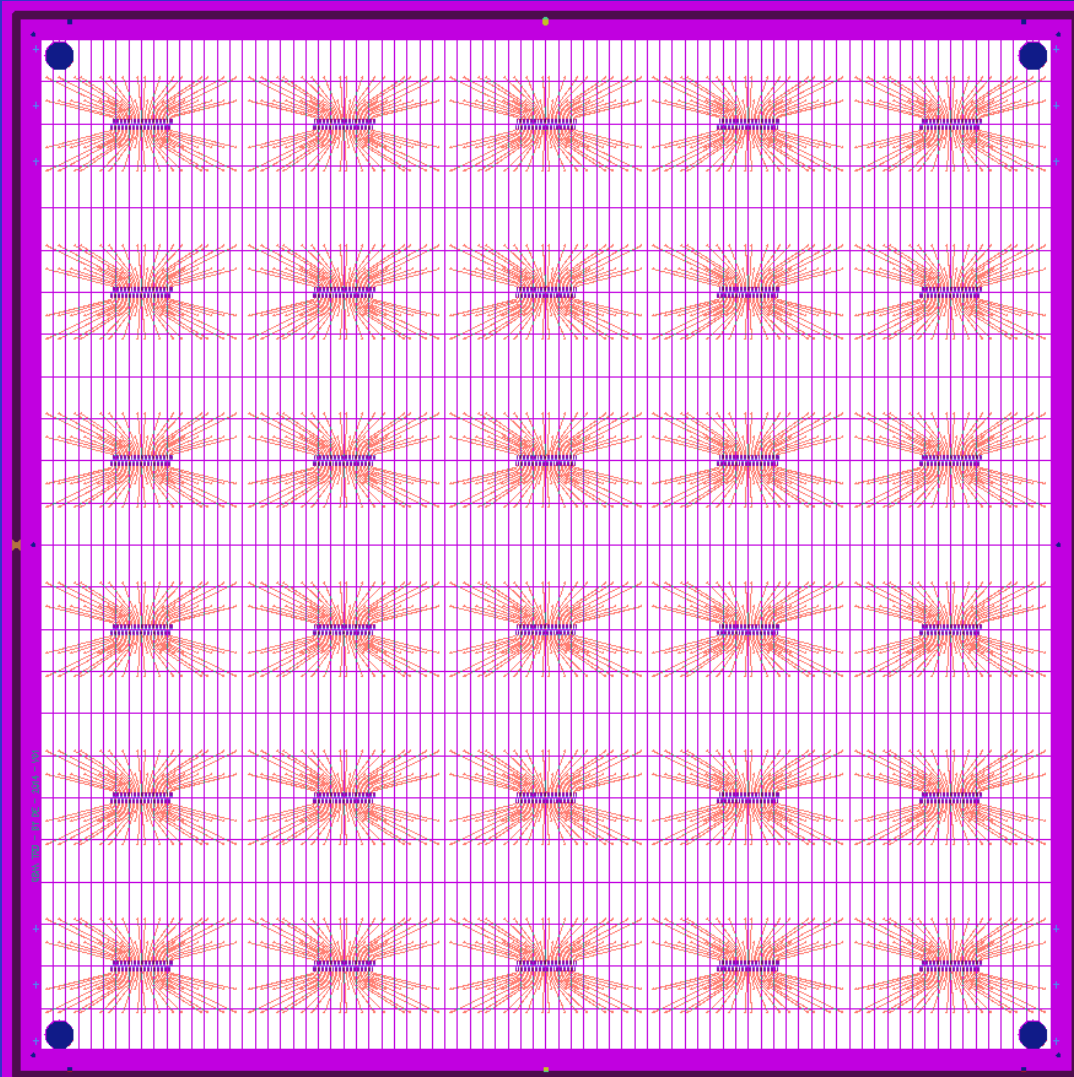
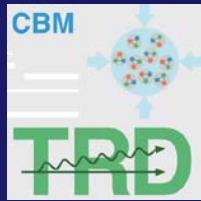
To get rid of
complicated ROB-7
on module type 1
and ROB-5 / ROB-3
mix on module type 2.

Type 2 v17a modification



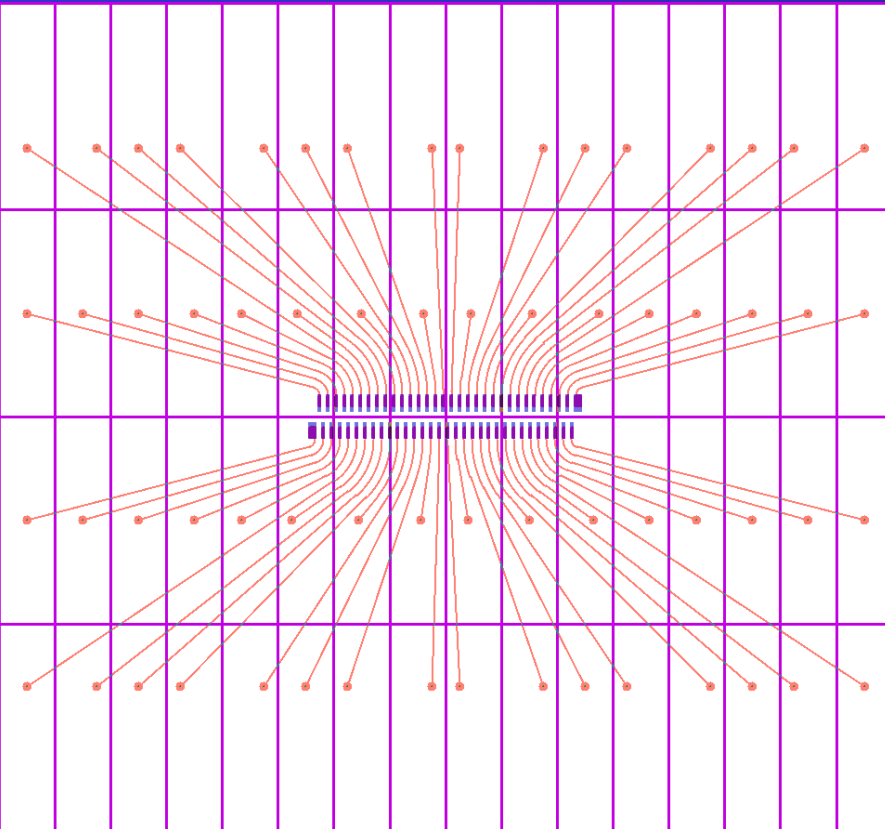
Switching ROB-3 with a ROB-5 gives the opportunity to add one additional FEB 5x2 for free. 89% -> 86% uplink efficiency.

Module type 2 v17a

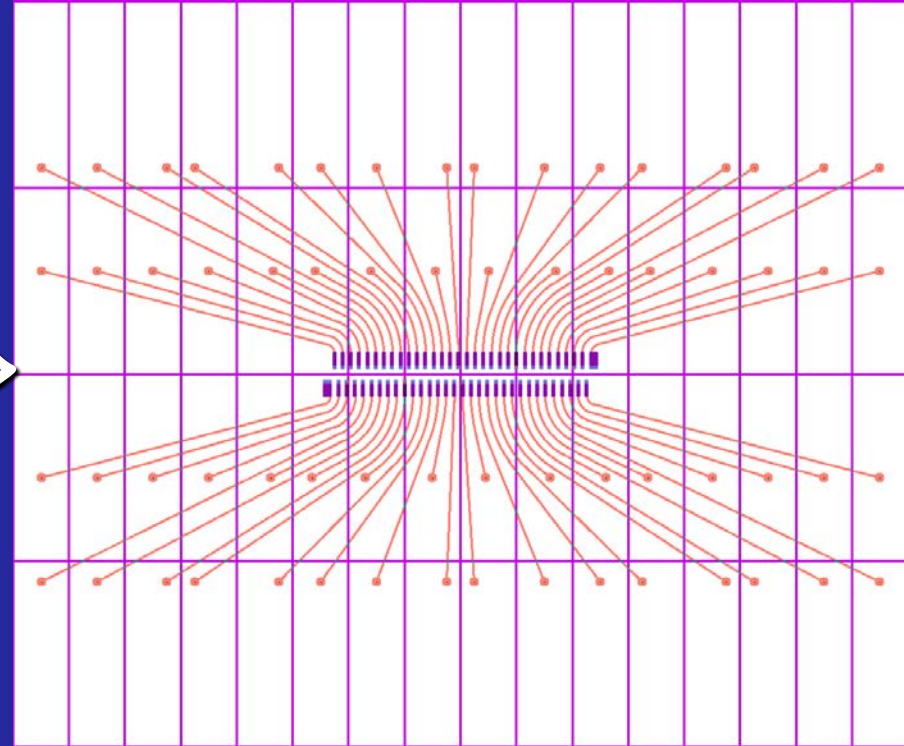


- 24 rows, 80 columns
- 1920 pads
- 1.52 cm² pad size
- 30x 64-pin connectors
- 5 connectors per row
- 4 rows per connector

Type 2 pad block v17a



=>



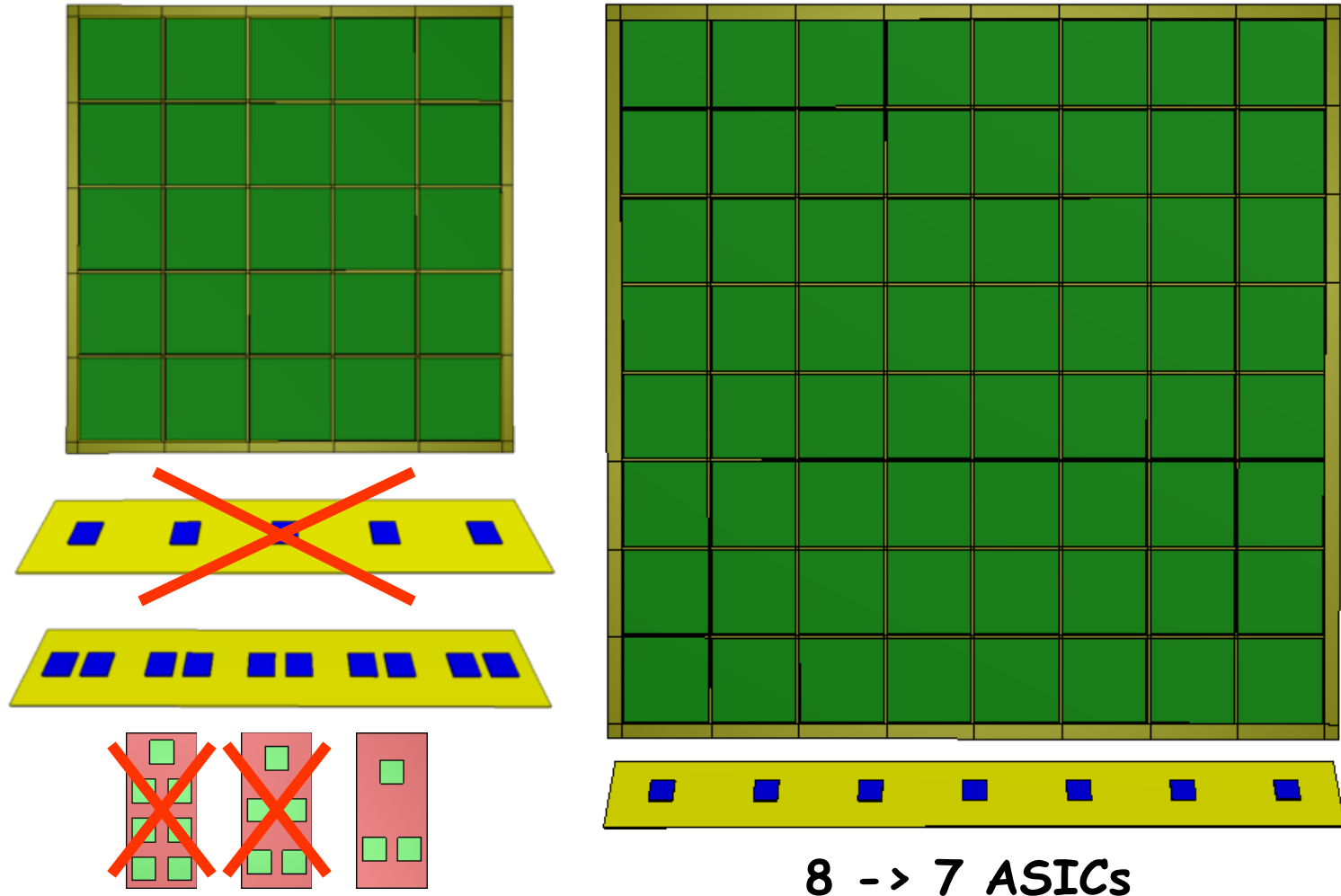
Pad length drops from $16 \times 2.75 \text{ cm} + 4 \times 2.50 \text{ cm}$ to $24 \times 2.25 \text{ cm}$.

TRD v17b

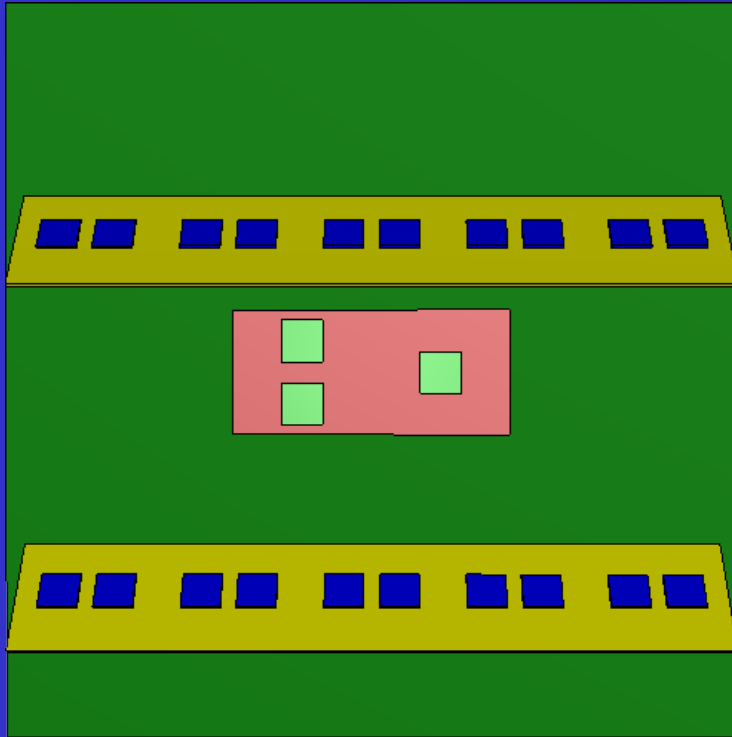
-

Optimise readout efficiency

TRD v17b components



Small module readout

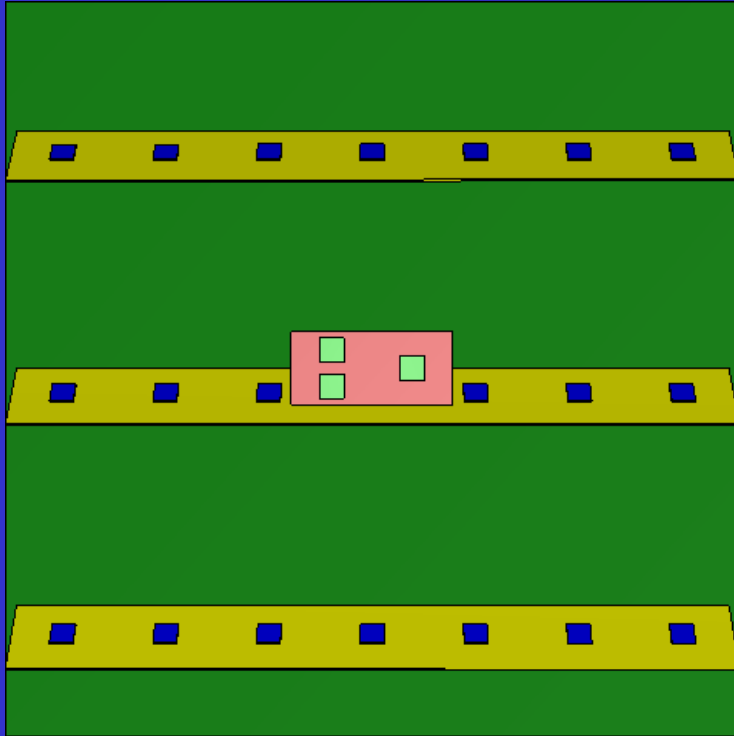
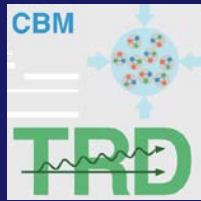


update

Pitch

super
9 FEBs x 4 rows

Large module readout



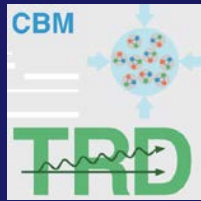
update

Pitch

super
9 FEBs x 4 rows

Geometry summary

Geometry summary

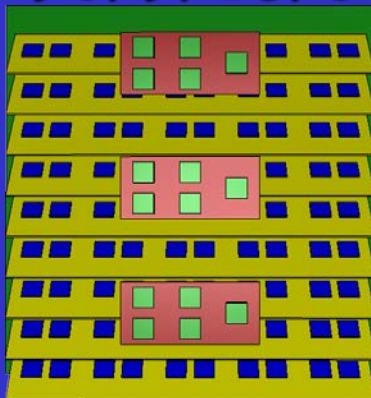


	geometry - module types	FEB types	ROB types	uplink efficiency
TDR v16b	6	3	3	
v17a	6	2	2	update
v17b	6	2	1	

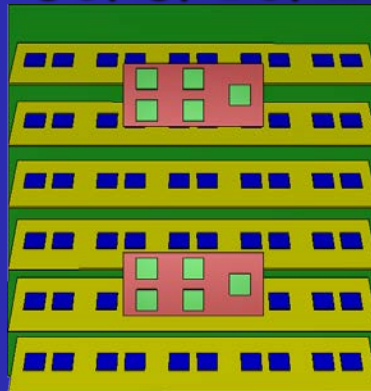
TRD geometry v17a -3



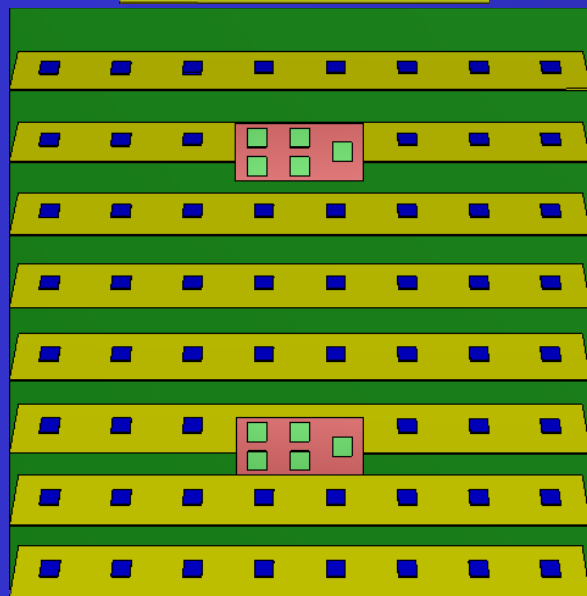
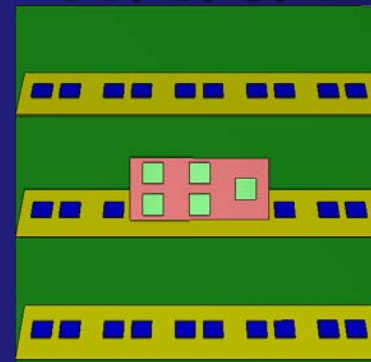
90/9/15/3



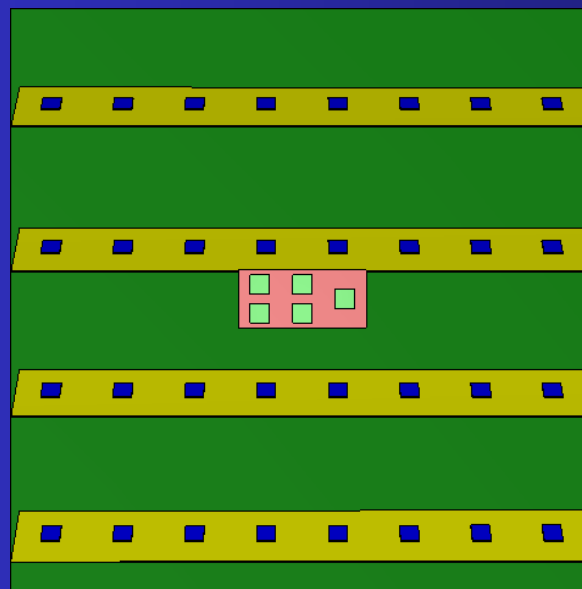
60/6/10/2



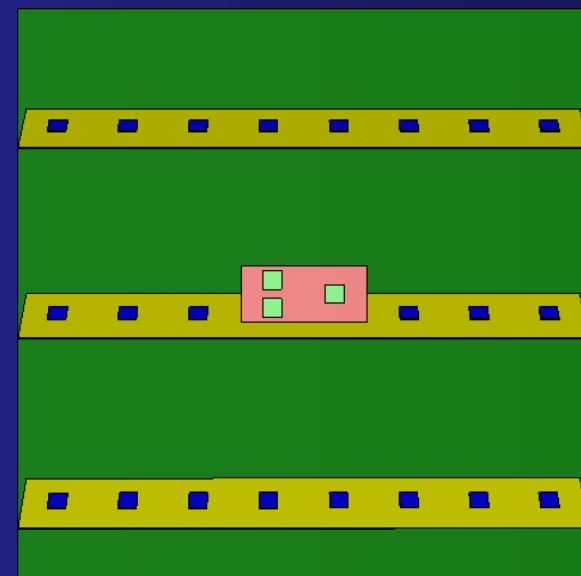
30/3/5/1



64/8/10/2



32/4/5/1

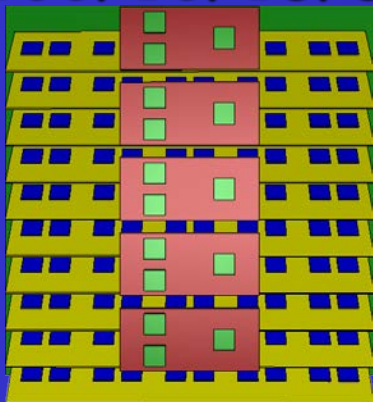


24/3/3/1

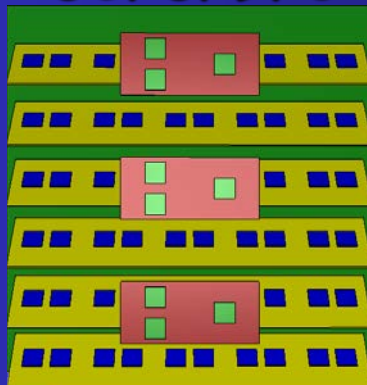
TRD geometry v17b



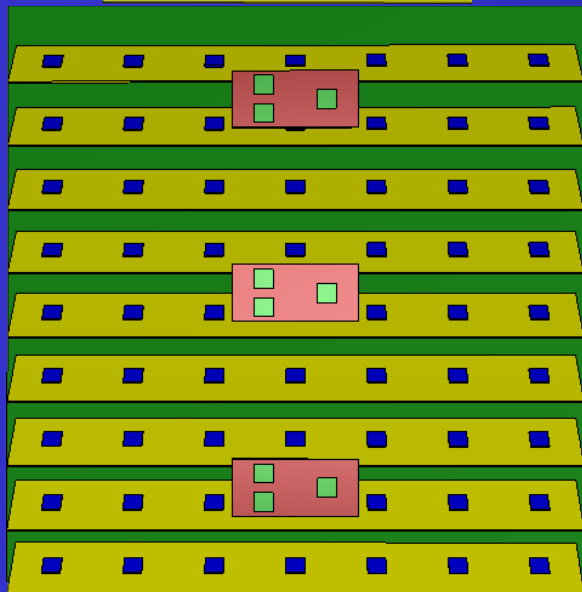
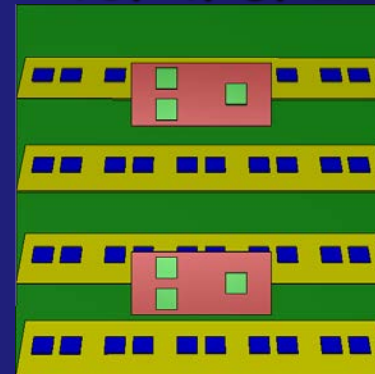
100/10/15/5



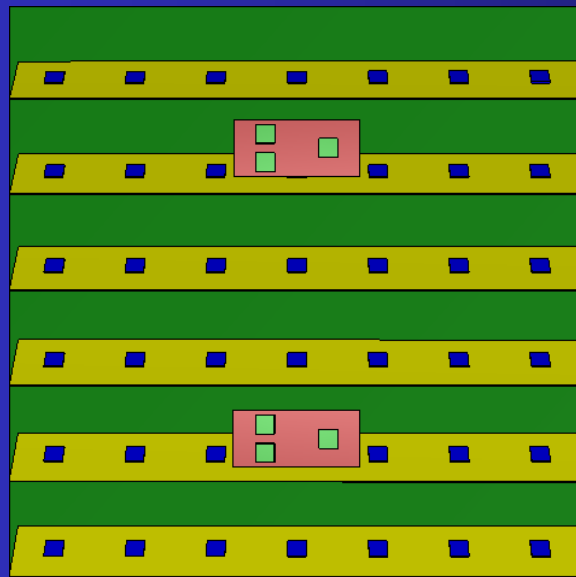
60/6/9/3



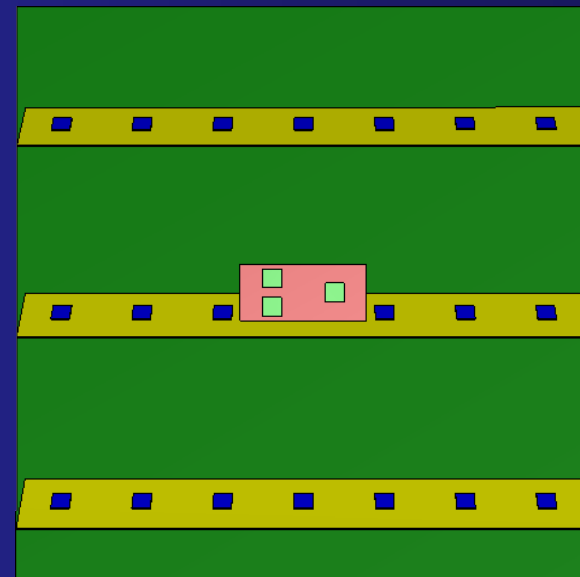
40/4/6/2



63/9/9/3



42/6/6/2

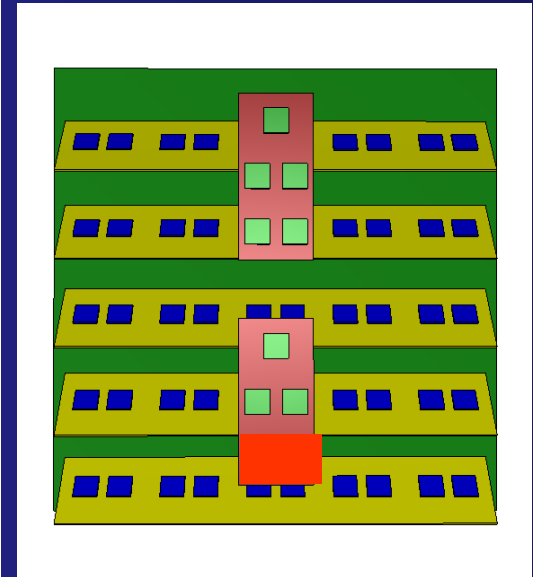
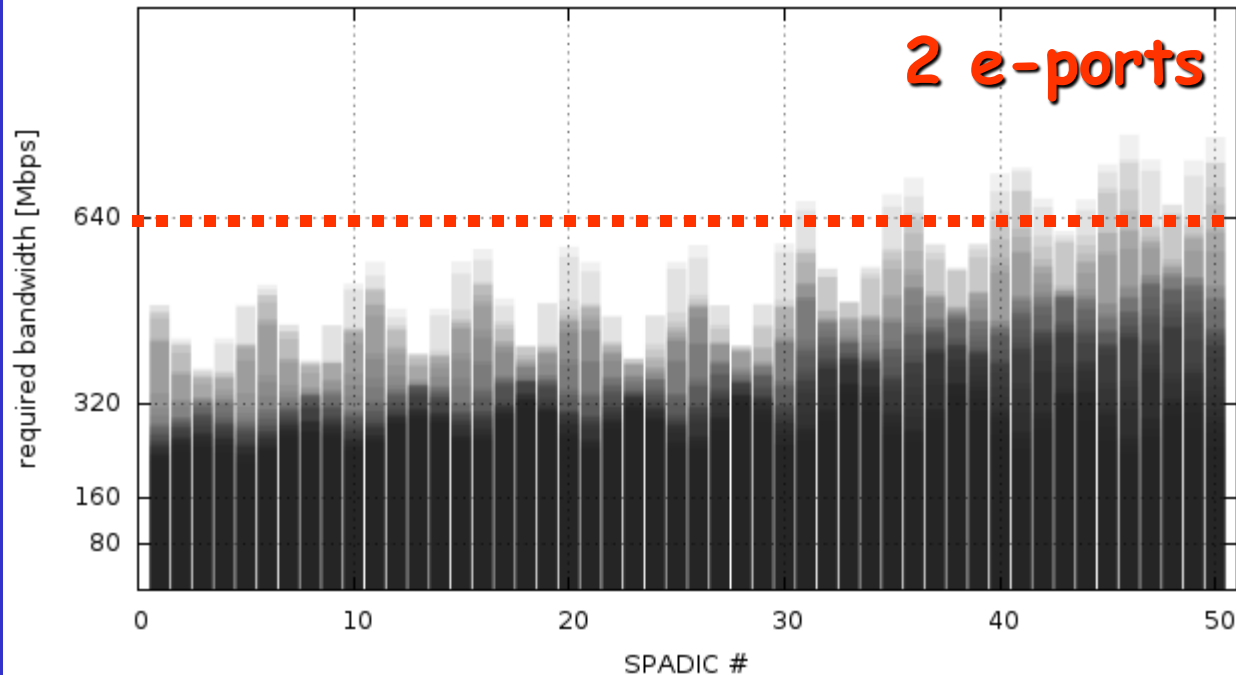


21/3/3/1

Module type 2 data rate

Michael Krieger

S2 (32)

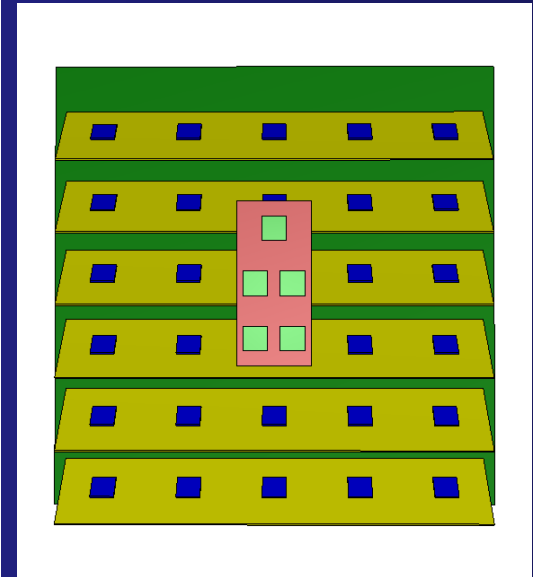
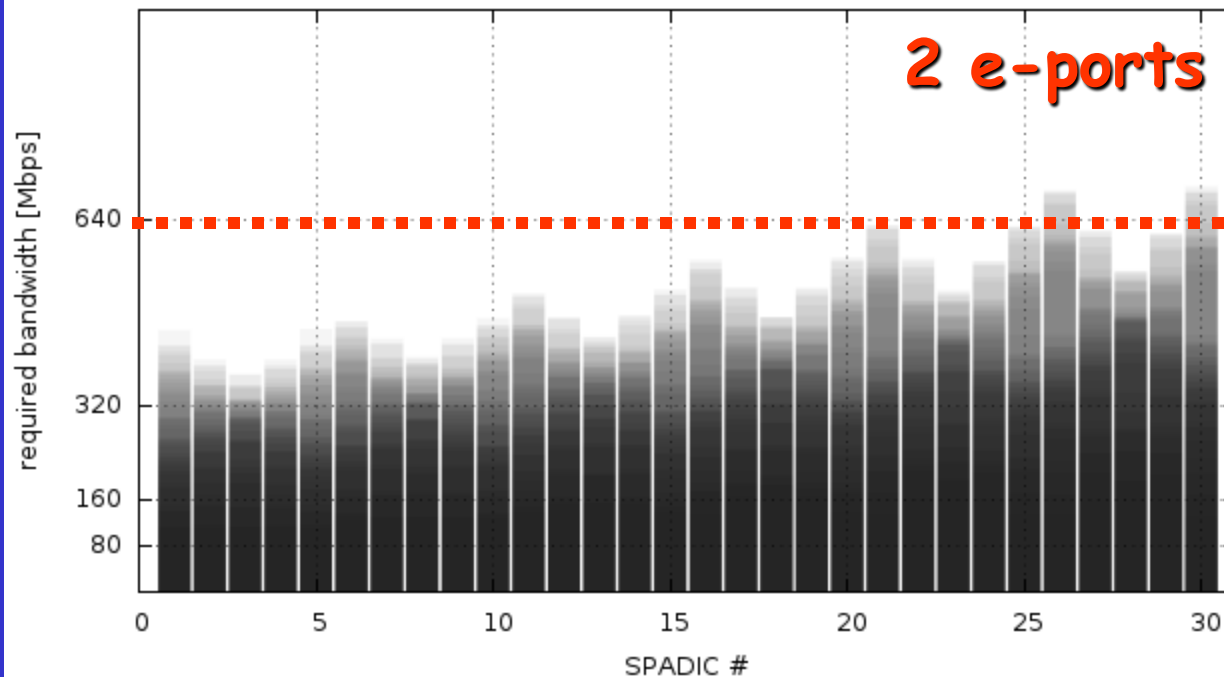


50 Spadics a 2 e-ports = 100 e-ports usage
 2x GBTx ROB 5 = 2x 5x 14 = 140 e-ports or 57%
 GBTx ROB 3+5 = (3 + 5)x 14 = 112 e-ports 85%

Module type 3 data rate

Michael Krieger

S3 (48)

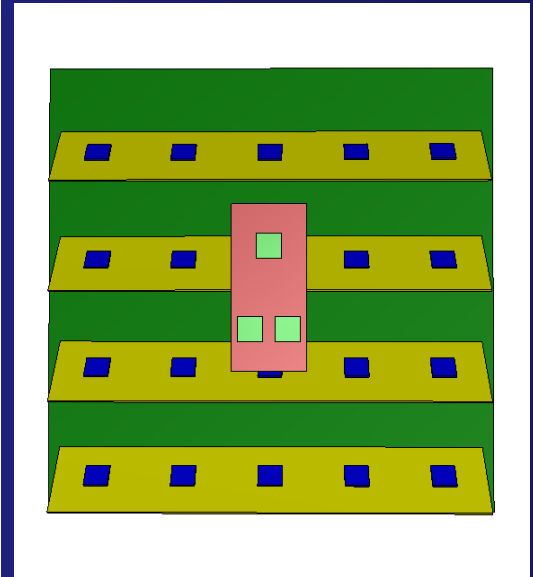
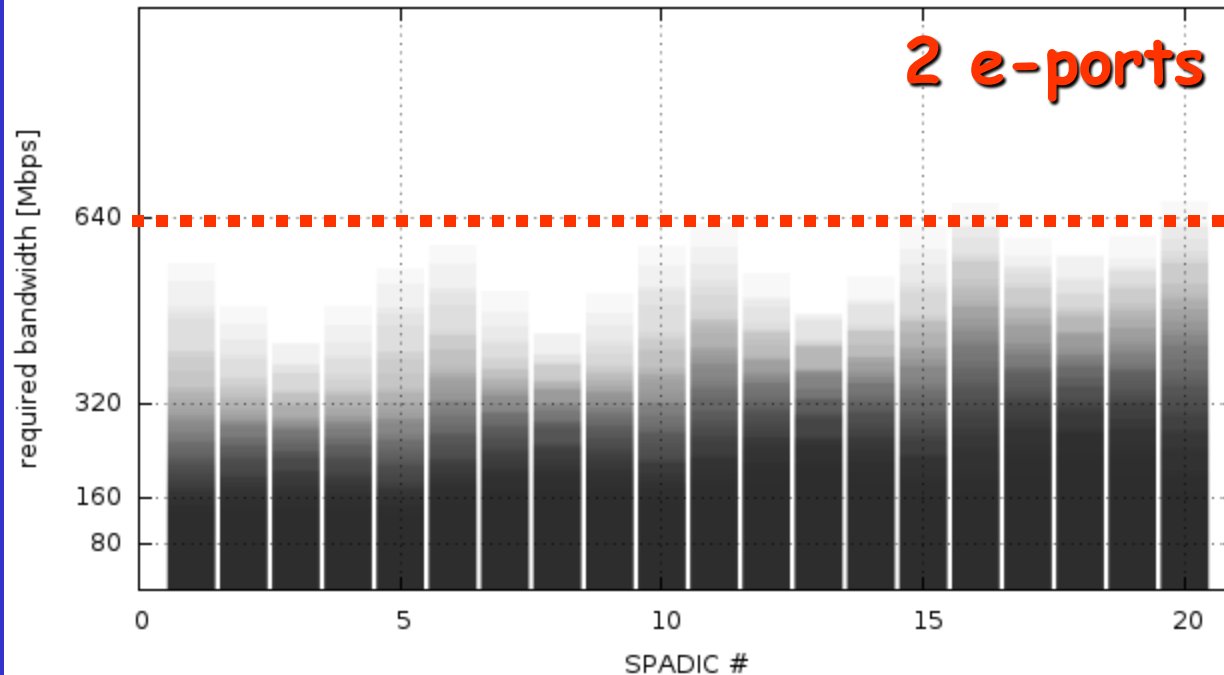


30 Spadics a 2 e-ports = 60 e-ports usage
 1x GBTx ROB 5 = 1x 5x 14 = 70 e-ports 86%

Module type 4 data rate

Michael Krieger

S4 (64)



20 Spadics a 2 e-ports = 40 e-ports

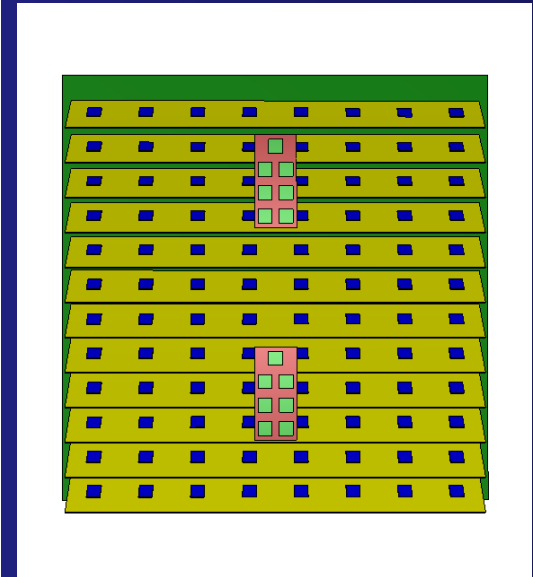
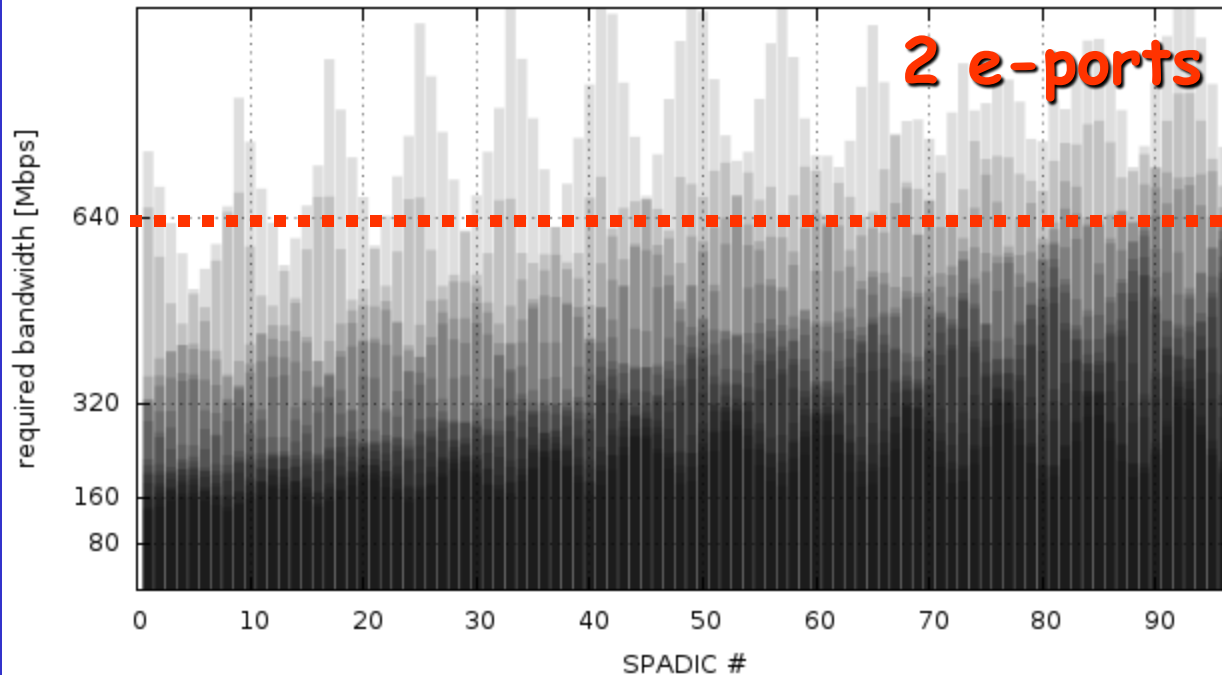
1x GBTx ROB 3 = 1x 3x 14 = 42 e-ports

usage
95%

Module type 5 data rate

Michael Krieger

L5 (16)

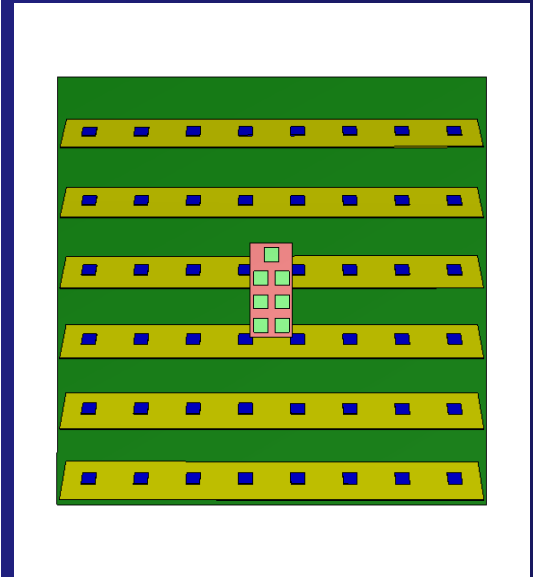
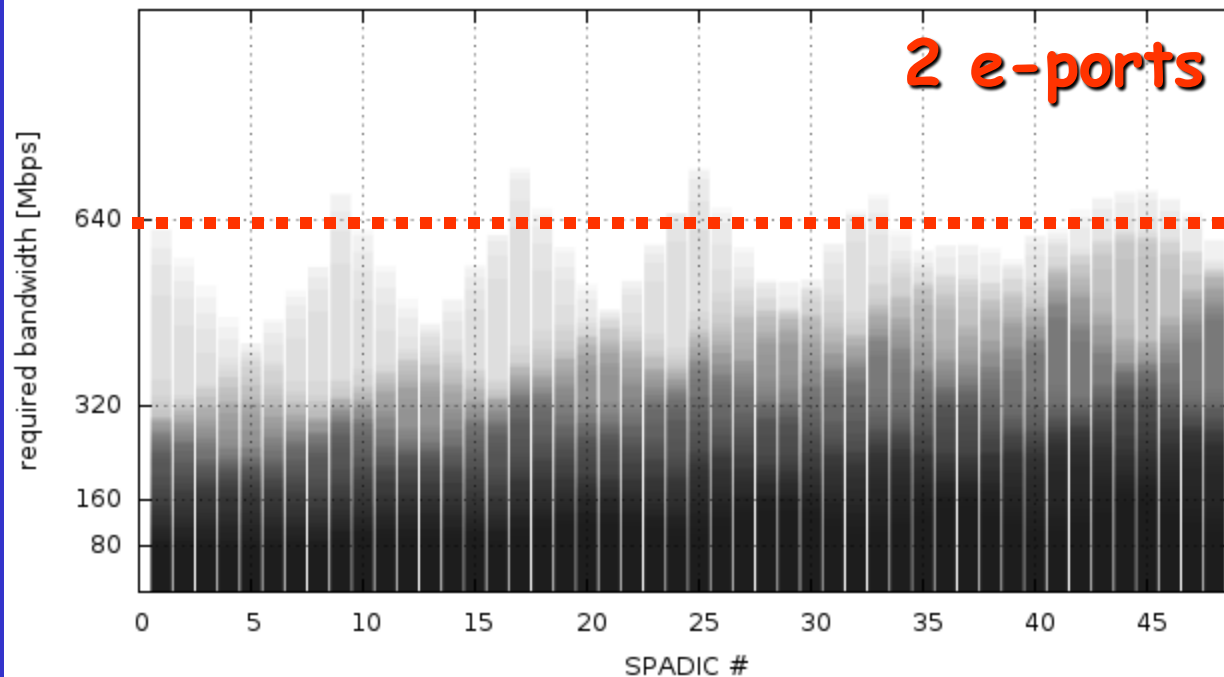


96 Spadics a 2 e-ports = 192 e-ports usage
2x GBTx ROB 7 = 2x 7x 14 = 196 e-ports 98%

Module type 6 data rate

Michael Krieger

L6 (80)

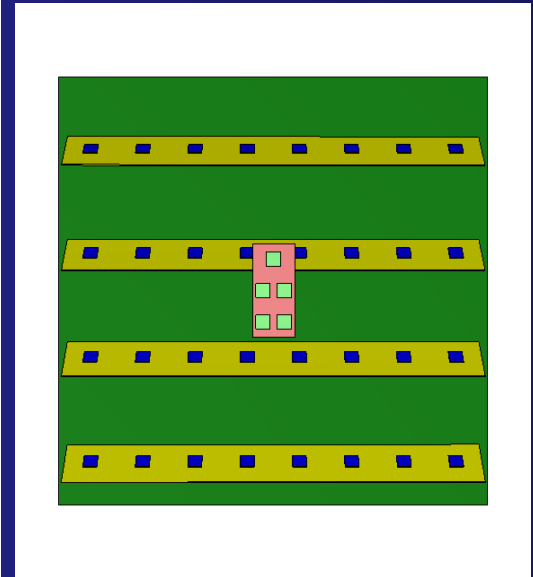
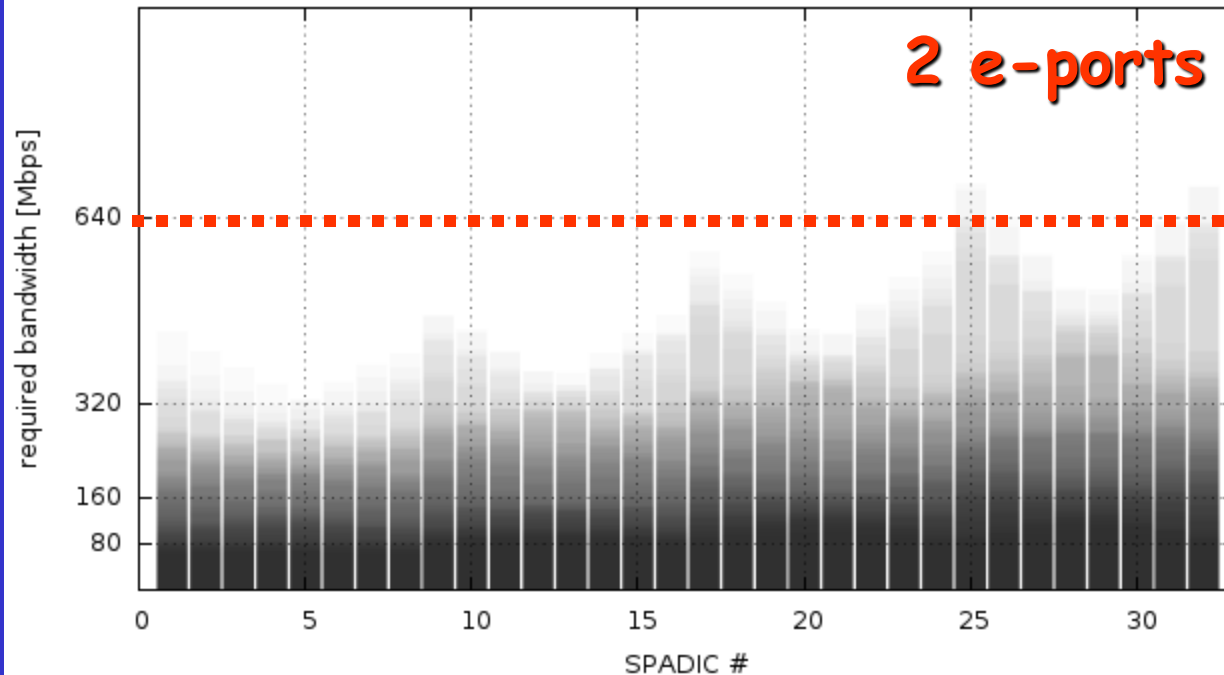


48 Spadics a 2 e-ports = 96 e-ports usage
 1x GBTx ROB 7 = 1x 7x 14 = 98 e-ports 98%

Module type 7 data rate

Michael Krieger

L7 (88)

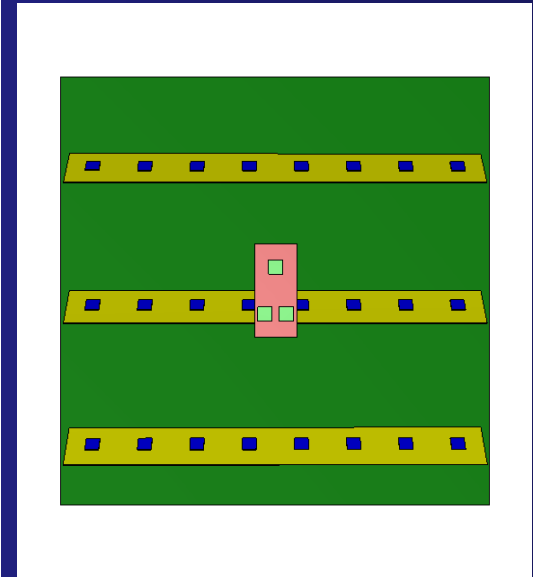
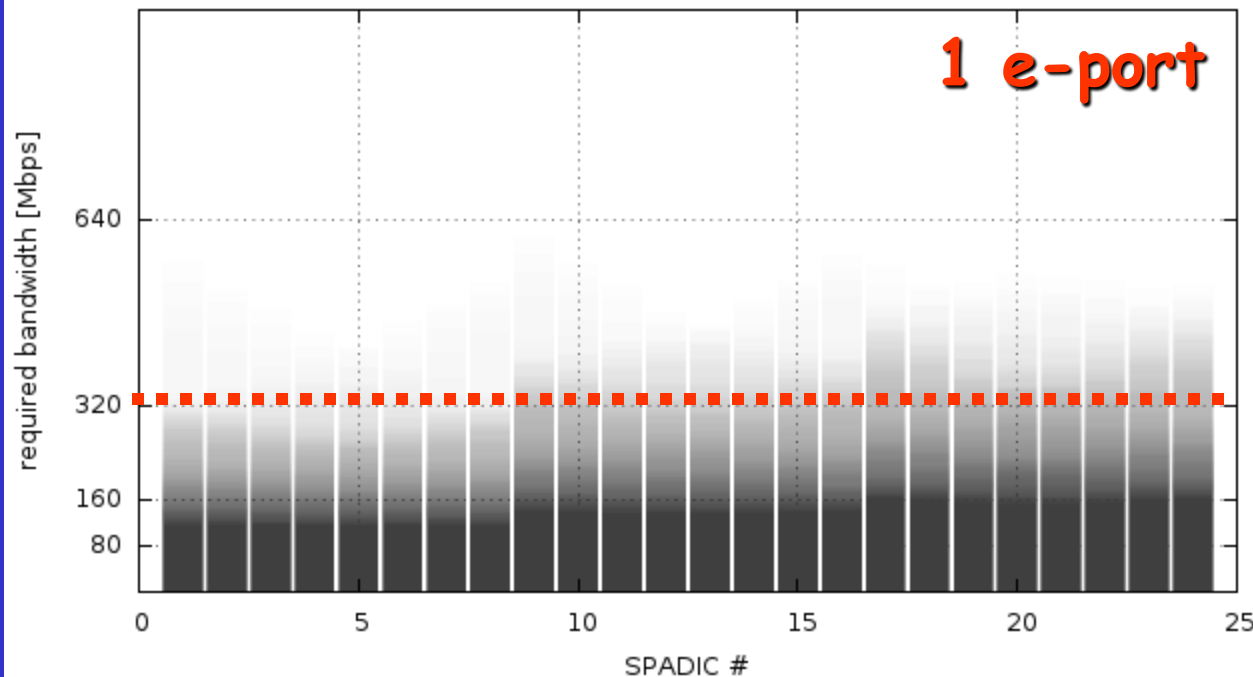


32 Spadics a 2 e-ports = 64 e-ports usage
 1x GBTx ROB 5 = 1x 5x 14 = 70 e-ports 91%

Module type 8 data rate

Michael Krieger

L8 (332)



24 Spadics a 1 e-port = 24 e-ports usage
 1x GBTx ROB 3 = 1x 3x 14 = 42 e-ports or 57%
 2x GBTx ROB 1 = 2x 1x 14 = 28 e-ports 85%
 almost the same price for both options